

Virtex-4 FPGA Configuration User Guide

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Revision History

The following table shows the revision history for this document.

	Version	Revision
08/02/04	1.0	Initial Xilinx release. Printed Handbook version.
09/10/04	1.1	Chapters 11, 12, and 13 in the printed handbook are now Chapters 1, 2, and 3 in this guide. Chapter 14 in the printed handbook is now Chapter 6 in this guide. There are now eight chapters in this guide.
08/08/05	1.2	System Monitor functions are not supported in Virtex-4 devices, removed references. General typographical edits for correctness and clarity. Edited Table 1-1 , Table 1-4 , Figure 1-11 , Table 2-4 , and Figure 2-11 to add information on Slave SelectMAP32 mode. Removed the Virtex-4 bitstream length tables in favor of the exact numbers reported in the ISE BitGen tool. Edited Table 1-3 and removed the Power-Up Timing table to consolidate data in the <i>Virtex-4 FPGA Data Sheet</i> . Edited Figure 1-11 . Removed the Dynamic Reconfiguration Timing table to consolidate data in the <i>Virtex-4 FPGA Data Sheet</i> .
08/16/05	1.3	Due to a documentation error, all configuration I/O notations have been changed from LVTTTL to LVCMOS.

	Version	Revision
01/19/06	1.4	<p>Completed grammatical and style edits for clarity and compliance to Xilinx documentation standards.</p> <p>Added preface, not included in previous versions. Corrected Table 1-1, page 13 (Note 2). Added "HSWPEN has a weak pull-up prior to and during configuration" to Table 1-2, page 14. Clarified first paragraph of "Clear Configuration Memory (Step 2, Initialization)," page 16. Clarified title of Table 1-10, page 22 (status register), to differentiate from Figure 1-10 (signal sequencing). Added descriptions for GWE, GTS, EOS, DCI_MATCH, and DCM_LOCK to Table 1-10, page 22. Added "ICAP is not supported with an encrypted bitstream in the LX, SX, and FX12 devices" as last paragraph in "Loading the Encryption Key," page 24 and as last line in first paragraph in "Bitstream Encryption and Internal Configuration Access Port (ICAP)," page 25. Added third paragraph to "Loading Encrypted Bitstreams," page 24. Clarified SelectMAP Data Pin Description in Table 2-4, page 39. Added port width to "SelectMAP Reconfiguration," page 51. Added first paragraph to Chapter 4, "Frame ECC Logic," page 75. Updated the BitGen option to DONE_CYCLE:KEEP in Chapter 5, "User Access Register," page 77. Added "Frame Address Register (FAR)," page 92. Corrected Configuration Data in Table 8-2, page 103 (step 4 and step 6). Changed DESYCH to DESYNC (throughout).</p>
01/12/07	1.5	<p>Updated notes relevant to Figure 2-5. Updated Table 2-4, Table 3-3, and the "Instruction Register" section. Added the "ICAP - Internal Configuration Access Port" section. Updated the "Control Register (CTL)" section, Table 7-7, and Figure 8-2.</p>
06/21/07	1.6	<p>Updated "Introduction," Table 1-2, "Master Serial Configuration," "SelectMAP Data Loading," Chapter 5, "User Access Register," "Changing the Multiply and Divide Values," "Dynamic Phase Shifting Through the DRP in Direct Mode," Table 7-1, CBC address value in Table 7-5, "Configuration Memory Read Procedure (SelectMAP)," and Table 8-2. Added "Packet Types" section.</p>
07/30/07	1.7	<p>Added TAP controller state definitions in the "TAP Controller" section and a NOOP note to Table 8-1.</p>
08/08/07	1.8	<p>Replaced instructions for setting a direct phase shift value in the "Dynamic Phase Shifting Through the DRP in Direct Mode" section.</p>
10/01/07	1.9	<p>Title: Updated corporate disclaimer.</p> <p>Chapter 2: Updated notes relevant to Figure 2-3 and updated Figure 2-19.</p> <p>Chapter 3: Updated "TAP Controller" section.</p> <p>Chapter 8: Updated Table 8-5.</p>
04/08/08	1.10	<p>Chapter 1: Updated Table 1-6 and "Loading Encrypted Bitstreams" section.</p> <p>Chapter 3: Updated "Identification Register" section, including Table 3-4 and Table 3-5.</p>
06/09/09	1.11	<p>Chapter 1:</p> <ul style="list-style-type: none"> Interchanged phase events 5 and 6 in Table 1-9. <p>Chapter 2:</p> <ul style="list-style-type: none"> Added cross reference to the Virtex-4 FPGA Data Sheet. Changed default oscillator frequency to 4 MHz in Note 3 following Figure 2-4. Updated "Single Device SelectMAP Configuration" section. <p>Chapter 8:</p> <ul style="list-style-type: none"> Updated description of .rba and .rbb files in "Verifying Readback Data" section.

	Version	Revision
06/02/17	1.12	Chapter 8: <ul style="list-style-type: none">• Added note after first paragraph to clarify that configuration memory readback is not supported for flight applications in Virtex-4QV devices.

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About This Guide

This document describes the Virtex®-4 Configuration. Complete and up-to-date documentation of the Virtex-4 family of FPGAs is available on the Xilinx web site at <http://www.xilinx.com/products/virtex4/index.htm>.

Guide Contents

- [Chapter 1, “Configuration Overview”](#)
- [Chapter 2, “Configuration Interfaces”](#)
- [Chapter 3, “Boundary-Scan and JTAG Configuration”](#)
- [Chapter 4, “Frame ECC Logic”](#)
- [Chapter 5, “User Access Register”](#)
- [Chapter 6, “Reconfiguration Techniques”](#)
- [Chapter 7, “Configuration Details”](#)
- [Chapter 8, “Readback and Configuration Verification”](#)

Additional Documentation

The following documents are also available for download at <http://www.xilinx.com/products/virtex4/index.htm>.

- [Virtex-4 Family Overview](#)
The features and product selection of the Virtex-4 family are outlined in this overview.
- [Virtex-4 FPGA Data Sheet: DC and Switching Characteristics](#)
This data sheet contains the DC and Switching Characteristic specifications for the Virtex-4 family.
- [Virtex-4 FPGA User Guide](#)
Chapters in this guide cover the following topics:
 - Clocking Resources
 - Digital Clock Manager (DCM)
 - Phase-Matched Clock Dividers (PMCD)
 - Block RAM and FIFO memory
 - Configurable Logic Blocks (CLBs)
 - SelectIO™ Resources

- SelectIO Logic Resources
- Advanced SelectIO Logic Resources
- [XtremeDSP™ Design Considerations](#)
This guide describes the XtremeDSP slice and includes reference designs for using DSP48 math functions and various FIR filters.
- [Virtex-4 FPGA PCB Designers Guide](#)
This designer's guide provides information on the design of PCBs for Virtex-4 devices. It considers all aspects of the PCB from the system level down to the minute details. This guide focuses on strategies for making design decisions at the PCB and interface level.
- [Virtex-4 FPGA Packaging and Pinout Specification](#)
This specification includes the tables for device/package combinations and maximum I/Os, pin definitions, pinout tables, pinout diagrams, mechanical drawings, and thermal specifications.
- [Virtex-4 RocketIO™ Multi-Gigabit Transceiver User Guide](#)
This guide describes the RocketIO Multi-Gigabit Transceivers available in the Virtex-4-FX family.
- [Virtex-4 FPGA Embedded Tri-Mode Ethernet MAC User Guide](#)
This guide describes the Tri-Mode Ethernet Media Access Controller available in the Virtex-4 FX family.
- [PowerPC® 405 Processor Block Reference Guide](#)
This guide is updated to include the PowerPC 405 processor block available in the Virtex-4 FX family.

Additional Resources

To search the database of silicon and software questions and answers, or to create a technical support case in WebCase, see the Xilinx website at:
<http://www.xilinx.com/support>.

Typographical Conventions

This document uses the following typographical conventions. An example illustrates each convention.

Convention	Meaning or Use	Example
<i>Italic font</i>	References to other documents	See the Virtex-4 <i>Configuration Guide</i> for more information.
	Emphasis in text	The address (F) is asserted <i>after</i> clock event 2.

Online Document

The following conventions are used in this document:

Convention	Meaning or Use	Example
Blue text	Cross-reference link to a location in the current document	See the section “ Additional Resources ” for details. Refer to “ Title Formats ” in Chapter 1 for details.
Red text	Cross-reference link to a location in another document	See the <i>Virtex-4 User Guide</i> .
Blue, underlined text	Hyperlink to a website (URL)	Go to http://www.xilinx.com for the latest speed files.

Configuration Overview

Introduction

Virtex®-4 devices are configured by loading application-specific configuration data—the bitstream—into internal memory. Because Xilinx® FPGA configuration memory is volatile, it must be configured each time it is powered-up. The bitstream is loaded into the device through special configuration pins. These configuration pins serve as the interface for a number of different configuration modes:

- Master-serial configuration mode
- Slave-serial configuration mode
- Master SelectMAP (parallel) configuration mode
- Slave SelectMAP (parallel) configuration mode

In addition, the bitstream can be loaded through the JTAG interface:

- JTAG/Boundary-Scan configuration mode

The configuration modes are explained in detail in [Chapter 2](#). The configuration mode is selected by setting the appropriate level on the dedicated MODE input pins. [Table 1-1](#) lists the Virtex-4 configuration modes.

Table 1-1: Virtex-4 Configuration Modes

Configuration Mode	M2	M1	M0	Data Width	CCLK Direction
Master Serial	0	0	0	1 bit	Output
Slave Serial	1	1	1	1 bit	Input
Master SelectMAP	0	1	1	8 bits	Output
Slave SelectMAP8	1	1	0	8 bits	Input
Slave SelectMAP32 ⁽³⁾	0	0	1	32 bits	Input
JTAG/Boundary-Scan only ⁽¹⁾	1	0	1	1 bit	–

Notes:

1. JTAG configuration uses the JTAG TCK pin instead of the configuration clock (CCLK).
2. I/O pre-configuration pull-up resistors are disabled with the HSWAPEN pin.
3. In SelectMAP32 D0:D31 data bits are not swapped. D0 is the LSB. D31 is the MSB.
4. If the pins are left unconnected a weak pull-up resistor on the mode pins makes slave serial the default mode.

The terms *Master* and *Slave* refer to the direction of the configuration clock (CCLK):

- In Master configuration modes, the Virtex-4 device drives the configuration clock (CCLK) from an internal oscillator
- In Slave configuration modes, the configuration clock is an input.

The JTAG/Boundary-Scan configuration interface is always available, regardless of the MODE pin settings. The JTAG/Boundary-Scan configuration mode disables all other configuration modes. This prevents conflicts between configuration interfaces.

The JTAG interface is available after the mode pins are sampled. Activating PROGRAM_B disables JTAG until INIT is completed.

Certain pins are dedicated to configuration, while others are dual-purpose (Table 1-2). Dual-purpose pins serve both as configuration pins and as user I/O after configuration. Dedicated configuration pins retain their function after configuration.

Table 1-2: Virtex-4 Configuration Pins

Pin Name	Type ⁽¹⁾	Dedicated or Dual-Purpose ⁽²⁾	Description
M[2:0]	Input	Dedicated	Mode pins that determine configuration mode. Sampled on the rising edge of INIT_B.
CCLK	Input or Output	Dedicated	Configuration clock source for all configuration modes except JTAG.
D_IN	Input	Dedicated	Serial data input for serial configuration modes.
DOUT_BUSY	Output	Dedicated	In Serial configuration mode, pin acts as serial data output for daisy-chain configuration. In SelectMAP mode, pin acts as BUSY output.
DONE	Bidirectional, Open-Drain or Active	Dedicated	Active High signal indicating configuration is complete. 0 = FPGA not configured 1 = FPGA configured Refer to the "BitGen" section of the <i>Development System Reference Guide</i> for software settings.
INIT_B	Input or Output, Open-Drain	Dedicated	Before MODE pins are sampled, INIT_B is an input that can be held Low to delay configuration. After MODE pins are sampled, INIT_B is an open-drain active Low output indicating whether a CRC error occurred during configuration: 0 = CRC error 1 = No CRC error
PROGRAM_B	Input	Dedicated	Active Low asynchronous full-chip reset.
SelectMAP Data	Bidirectional	Dual-Purpose	Parallel data inputs for SelectMAP modes. For 8-bit SelectMAP: D0 = MSB D7 = LSB For 32-bit SelectMAP: D0 = LSB D31 = MSB

Table 1-2: Virtex-4 Configuration Pins (Continued)

Pin Name	Type ⁽¹⁾	Dedicated or Dual-Purpose ⁽²⁾	Description
HSWAPEN	Input	Dedicated	Active High input used to disable weak pre-configuration I/O pull-up resistors: 0 = weak pre-configuration I/O pull-up resistors enabled 1 = weak pre-configuration I/O pull-up resistors disabled HSWAPEN must be connected to either enable or disable the pull-up resistors. HSWAPEN has a weak pull-up prior to and during configuration. The weak pull-up does not always provide a reliable 1.

Notes:

1. The *Bidirectional* type describes a pin that is bidirectional under all conditions. If the pin is an input for some configuration modes or an output for others, it is listed as an *Input* or *Output* type.
2. Dual-purpose pins can become user I/O after configuration. See “PERSIST” in Chapter 7 for details.

Setup (Steps 1-3)

While each of the configuration interfaces is different, the basic steps for configuring a Virtex-4 device are the same for all modes. Figure 1-1 shows the Virtex-4 configuration process. Each step is described in detail in the following sections.

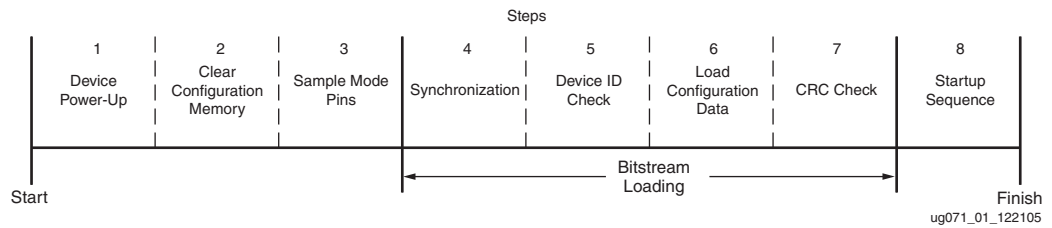


Figure 1-1: Virtex-4 Configuration Process

Device Power-Up (Step 1)

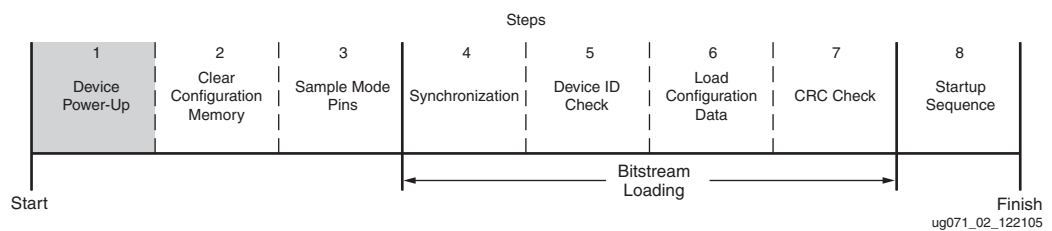


Figure 1-2: Device Power-Up (Step 1)

For configuration, Virtex-4 devices require power on the V_{CC_CONFIG} , V_{CCAUX} , and V_{CCINT} pins. There are no power-supply sequencing requirements.

All JTAG and serial configuration pins are located in a separate, dedicated bank with a dedicated V_{CC_CONFIG} (V_{CCO_0}) supply. The SelectMAP data pins are shared dual-purpose pins, and are located in Bank 2 (V_{CCO_2}). All dedicated input pins operate at V_{CC_CONFIG} LVCMOS level. All active dedicated output pins operate at the V_{CC_CONFIG} voltage level with the output standard set to LVCMOS_12F. In SelectMAP mode, V_{CCO_2} must be connected to the appropriate voltage to match the I/O standard of the configuration device.

For power-up, the V_{CCINT} power pins must be supplied with a 1.2V source. None of the I/O voltage supplies (V_{CCO}), except V_{CCO_0} (V_{CC_CONFIG}), need to be powered for Virtex-4 configuration in JTAG or serial modes. Table 1-3 shows the power supplies required for configuration; for recommended operating conditions, see Table 2 of the *Virtex-4 FPGA Data Sheet*. Table 41 of the *Virtex-4 FPGA Data Sheet* shows the configuration power-up timing parameters. Table 7-1 shows the number of frames per Virtex-4 device.

Table 1-3: Power Supplies Required for Configuration

Pin Name	Description
V_{CCINT}	Internal core voltage relative to GND.
$V_{BATT}^{(1)}$	Encryption Key battery supply.
V_{CC_CONFIG}	Configuration output supply voltage (also known as V_{CCO_0})
V_{CCAUX}	Auxiliary power input for configuration logic and other FPGA functions.

Notes:

- V_{BATT} is required only when using bitstream encryption.

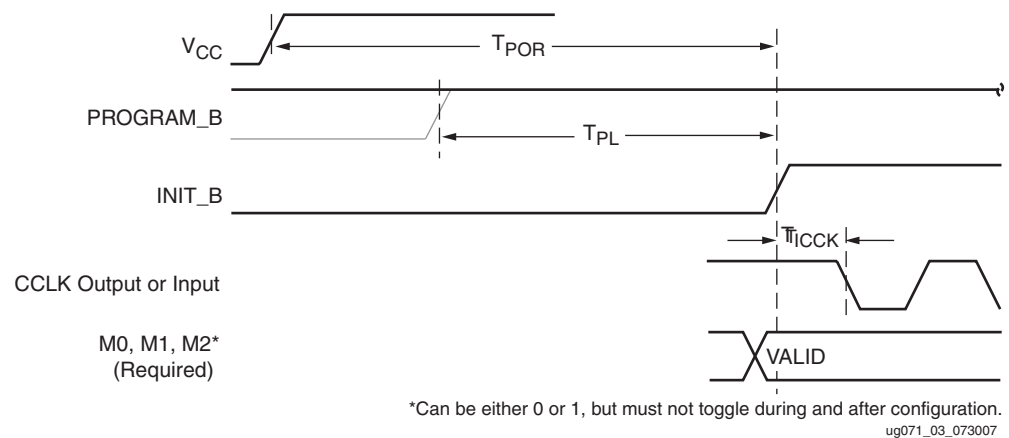


Figure 1-3: Device Power-Up Timing

V_{CCINT} should rise monotonically within the specified ramp rate. If this is not possible, delay configuration by holding the INIT_B pin or the PROGRAM_B pin Low (see “Delaying Configuration”) while the system power reaches V_{POR} .

The configuration logic power input (V_{CC_CONFIG}) and the auxiliary voltage input (V_{CCAUX}) are used as a logic input to the Power-On-Reset (POR) circuitry. If either of these voltage planes dips below the specified level, POR can trigger.

Clear Configuration Memory (Step 2, Initialization)

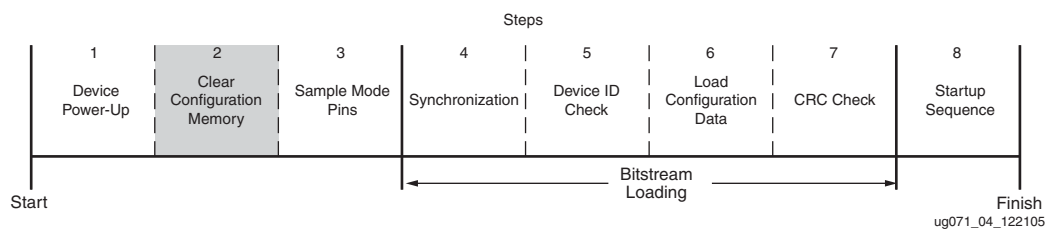


Figure 1-4: Initialization (Step 2)

Configuration memory is cleared sequentially any time the device is powered up, when the PROGRAM_B pin is pulsed Low, or when the JTAG JPROGRAM instruction is used. During this time, I/Os are placed in a high-Z state except for the dedicated Configuration and JTAG pins. INIT_B is held Low by the device during initialization, then released after T_{POR} (Figure 1-3.) If the INIT_B pin is held Low externally, the device waits at this point in the initialization process until the pin is released.

The minimum Low pulse time for PROGRAM_B is defined by the T_{PROGRAM} timing parameter. The PROGRAM_B pin can be held active (Low) for as long as necessary, and the device remains held in the reset state.

Sample Mode Pins (Step 3)

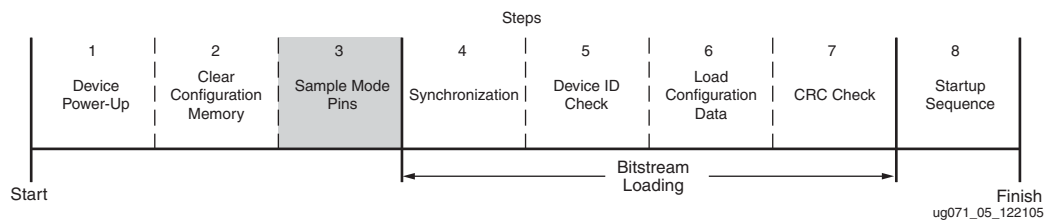


Figure 1-5: Sample Mode Pins (Step 3)

When the INIT_B pin transitions to High, the device samples the MODE pins and begins driving CCLK if in Master Serial or Master SelectMAP mode. At this point, the device begins sampling the configuration data input pins (D_{IN} pin for Serial Modes or the D0–D7 pins for SelectMAP modes on rising configuration clock signals).

Delaying Configuration

There are two ways to delay configuration for Virtex-4 devices:

- The first is to hold the INIT_B pin Low during initialization (Figure 1-3). This method only works if INIT_B is prevented from going High. After INIT_B goes High, configuration cannot be delayed by subsequently pulling INIT_B Low.
- The second is to hold the PROG pin Low, continuously clearing configuration memory (“Clear Configuration Memory (Step 2, Initialization),” page 16). The signals relating to initialization and delaying configuration (Table 1-4).

Table 1-4: Signals Relating to Initialization and Delaying Configuration

Signal Name	Type ⁽¹⁾	Access ⁽²⁾	Description
PROGRAM_B	Input	Externally accessible via the PROGRAM_B pin.	Global asynchronous chip reset. Can be held Low to delay configuration.
INIT_B	Input or Output	Externally accessible via the INIT_B pin.	Before the MODE pins are sampled, INIT_B is an input that can be held Low to delay configuration. After the MODE pins are sampled, INIT_B is an open-drain active Low output indicating whether a CRC error occurred during configuration: 0 = CRC error 1 = No CRC error
INIT_COMPLETE	Status	Internal signal, accessible through the Virtex-4 status register.	Indicates whether INIT_B signal has been internally released.
MODE_STATUS[2:0]	Status	Internal signals, accessible through the Virtex-4 status register.	Reflects the values sampled on the MODE pins when INIT_B is asserted High.

Notes:

1. The Status type symbolizes an internal status signal without a corresponding pin.
2. Information on the Virtex-4 status register is available in [Table 7-9](#). Information on accessing the JTAG capture sequence is available in [Table 8-4](#).

Bitstream Loading (Steps 4-7)

The bitstream loading process is similar for all configuration modes; the primary difference between modes is the interface to the configuration logic. Details on the different configuration interfaces are provided in [Chapter 2](#).

The most important steps in the bitstream loading process are, synchronization, device ID check, loading configuration data, and the CRC check. Each of these steps involves distinct parts of the configuration bitstream. The steps prior to synchronization and after the CRC check do not directly involve the configuration bitstream.

Synchronization (Step 4)

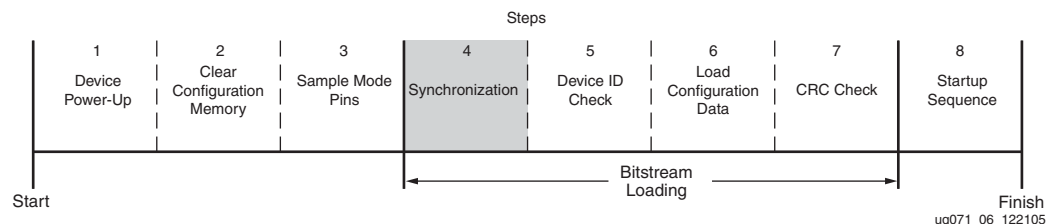


Figure 1-6: Synchronization (Step 4)

Before the configuration data frames can be loaded, a special 32-bit synchronization word (0xAA995566) must be sent to the configuration logic. The synchronization word alerts

the device to upcoming configuration data and aligns the configuration data with the internal configuration logic. Any data on the configuration input pins prior to synchronization is ignored.

Synchronization is transparent to most users because all configuration bitstreams (.bit files) generated by the Xilinx ISE® Bitstream Generator (BitGen) software include the synchronization word. Table 1-5 shows signals relating to synchronization.

Table 1-5: Signals Relating to Synchronization

Signal Name	Type	Access	Description
DALIGN	Status	Only available through the SelectMAP interface during an ABORT. (See “Configuration Abort Sequence Description,” page 49.)	Indicates whether device is synchronized.

Check Device ID (Step 5)

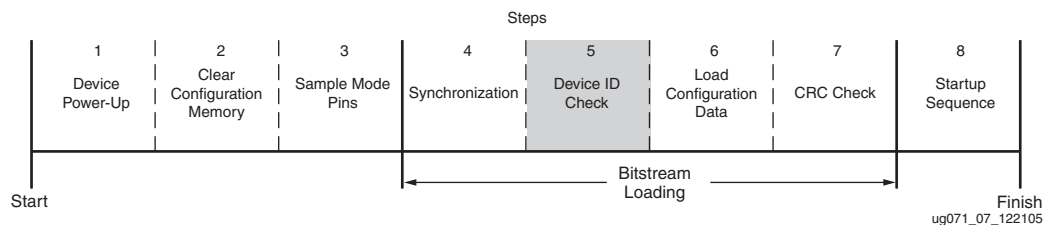


Figure 1-7: Check Device ID (Step 5)

Once the device is synchronized, a device ID check must pass before the configuration data frames can be loaded. This prevents an attempted configuration with a bitstream that is formatted for a different device.

For example, the device ID check should prevent an XC4VLX15 from being configured with an XC4VLX80 bitstream.

The device ID check is built into the bitstream, making this step transparent to most designers. Figure 1-7 shows the relative position of the device ID check, Table 1-6 shows the Virtex-4 device IDs, and Table 1-7 shows the signals relating to the device ID check. The device ID check is performed through commands in the bitstream to the configuration logic, not through the JTAG IDCODE register in this case.

Table 1-6: Virtex-4 Device ID Codes

Device	IDCODE	Device	IDCODE	Device	IDCODE
XC4VLX15	01658093			XC4VFX12	01E58093
XC4VLX25	0167C093	XC4VSX25	02068093	XC4VFX20	01E64093
XC4VLX40	016A4093	XC4VSX35	02088093	XC4VFX40	01E8C093 (1)
XC4VLX60	016B4093	XC4VSX55	020B0093	XC4VFX60	01EB4093
XC4VLX80	016D8093				
XC4VLX100	01700093			XC4VFX100	01EE4093
XC4VLX160	01718093			XC4VFX140	01F14093

Table 1-6: Virtex-4 Device ID Codes (Continued)

Device	IDCODE	Device	IDCODE	Device	IDCODE
XC4VLX200	01734093				

Notes:

- Does not reflect the actual device array size.

Table 1-7: Signals Relating to the Device ID Check

Signal Name	Type	Access ⁽¹⁾	Description
ID_Err	Status	Internal signal. Accessed only through the Virtex-4 status register.	Indicates a mismatch between the device ID specified in the bitstream and the actual device ID.

Notes:

- Information on the Virtex-4 status register is available in [Table 7-9](#). Information on accessing the JTAG capture sequence is available in [Table 8-4](#).

Load Configuration Data Frames (Step 6)

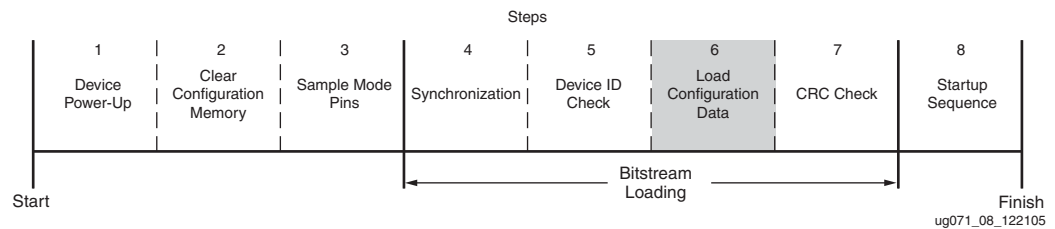


Figure 1-8: Load Configuration Data Frames (Step 6)

After the synchronization word is loaded and the device ID has been checked, the configuration data frames are loaded. This process is transparent to most users. For details, refer to [Chapter 7](#)

Cyclic Redundancy Check (Step 7)

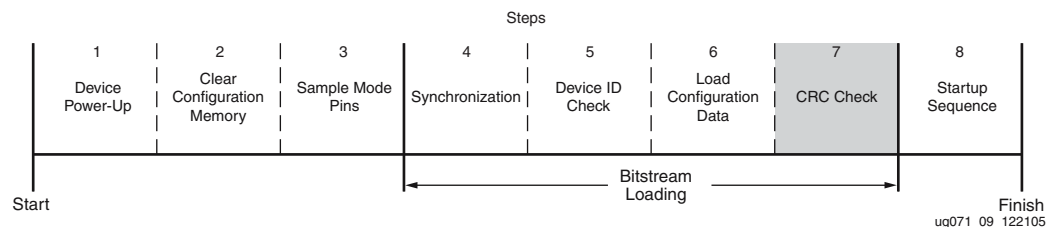


Figure 1-9: Cyclic Redundancy Check (Step 7)

As the configuration data frames are loaded, the device calculates a Cyclic Redundancy Check (CRC) value from the configuration data packets. After the configuration data frames are loaded, the configuration bitstream can issue a Check CRC instruction to the device, followed by an expected CRC value. If the CRC value calculated by the device does not match the expected CRC value in the bitstream, the device pulls INIT_B Low and aborts configuration. The CRC check is included in the configuration bitstream by default, although the designer can disable it if desired. (Refer to the *Development System Reference Guide*, BitGen section.) If the CRC check is disabled, there is a risk of loading incorrect

configuration data frames, causing incorrect design behavior, or even damaging the device.

If a CRC error occurs during configuration, the device must be resynchronized and reconfigured. In serial modes, the device can only be resynchronized by pulsing the PROGRAM_B pin and restarting the configuration process from the beginning. In SelectMAP modes, either the PROGRAM_B pin can be pulsed Low or an ABORT sequence can be initiated (see “SelectMAP Configuration Interface” in Chapter 2).

Virtex-4 devices use a 32-bit CRC check. The CRC check is designed to catch errors in transmitting the configuration bitstream. There is a scenario where errors in transmitting the configuration bitstream can be missed by the CRC check:

Certain clocking errors, such as double-clocking, can cause loss of synchronization between the 32-bit bitstream packets and the configuration logic. Once synchronization is lost, any subsequent commands are not understood, including the command to check the CRC. In this situation, configuration fails with DONE Low and INIT_B High.

Virtex-4 configuration uses a standard CRC32C checksum algorithm. The CRC32C polynomial is:

$$x^{32} + x^{28} + x^{27} + x^{26} + x^{25} + x^{23} + x^{22} + x^{20} + x^{19} + x^{18} + x^{14} + x^{13} + x^{11} + x^{10} + x^9 + x^8 + x^6 + 1$$

Startup (Step 8)

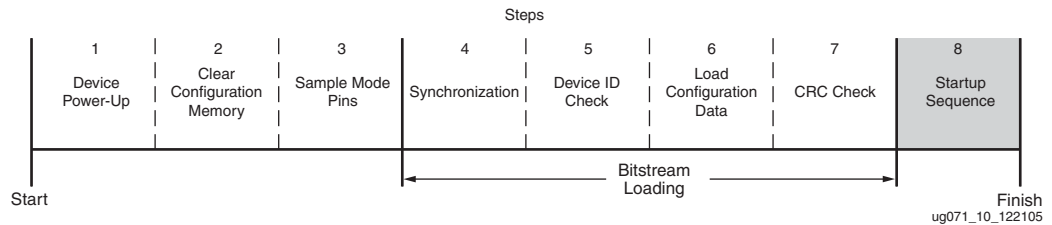


Figure 1-10: Start-Up Sequence (Step 8)

After the configuration frames are loaded, the bitstream instructs the device to enter the startup sequence. The startup sequence is controlled by an 8-phase (phases 0–7) sequential state machine. The startup sequencer performs the tasks outlined in Table 1-8.

Table 1-8: User-Selectable Cycle of Startup Events

Phase	Event
1–6	Wait for DCMs to Lock (optional)
1–6	Wait for DCI to Match (optional)
1–6	Assert GWE (Global Write Enable), allowing RAMs and flip-flops to change state
1–6	Negate GTS (Global 3-State), activating I/O
1–6	Release DONE pin
7	Assert EOS (End Of Startup)

The specific order of startup events (except for EOS assertion) is user-programmable through BitGen options (refer to the *Development System Reference Guide*). Table 1-8 shows the general sequence of events, although the specific phase for each of these startup events is user-programmable (EOS is always asserted in the last phase). Refer to Chapter 2,

“[Configuration Interfaces](#)” for important startup option guidelines. By default, startup events occur as shown in [Table 1-9](#).

Table 1-9: Default Sequence of Startup Events

Phase	Event
4	Release DONE pin
5	Negate GTS, activating I/O
6	Assert GWE, allowing RAMs and FFs to change state
7	Assert EOS

The start-up sequence can be forced to wait for the DCMs to lock or for DCI to match with the appropriate BitGen options. These options are typically set to prevent DONE, GTS, and GWE from being asserted (preventing device operation) before the DCMs have locked and/or DCI has matched.

The DONE signal is released by the start-up sequencer on the cycle indicated by the user, but the start-up sequencer does not proceed until the DONE pin actually sees a logic High. The DONE pin is an open-drain bidirectional signal by default. By releasing the DONE pin, the device simply stops driving a logic Low and the pin goes into a high-Z state. An external pull-up resistor is needed for the DONE pin to reach a logic High in this case. [Table 1-10](#) shows signals relating to the status register. [Figure 1-11](#) shows the signals relating to the start-up sequencer.

Table 1-10: Signals Relating to Status Register

Signal Name	Type	Access ⁽¹⁾	Description
DONE	Bidirectional ⁽²⁾	DONE pin or Virtex-4 Status Register	Indicates configuration is complete. Can be held Low externally to synchronize startup with other FPGAs.
Release_DONE	Status	Virtex-4 Status Register	Indicates whether device has released DONE pin. If pin is held Low externally, Release_DONE can differ from actual value on DONE pin.
GWE			Global Write Enable. When de asserted GWE disables CLB and IOB flips-flops as well as other synchronous elements on the FPGA.
GTS			Global Tri-State. When asserted, GTS disables all the I/O drivers except for configuration pins.
EOS			End of Startup. EOS indicates the absolute end of the configuration and startup process.
DCI_MATCH			DCI_MATCH indicates when all the Digitally Controlled Impedance (DCI) controllers have matched their internal resistor to the external reference resistor.
DCM_LOCK			DCM_LOCK indicates when all the Digital Clock Managers (DCMs) have locked. This signal is asserted by default. It is active if the LOCK_WAIT option is used on a DCM and the LockCycle option is used when the bitstream is generated.

Notes:

- Information on the Virtex-4 status register is available in [Table 7-9](#). Information on accessing the JTAG capture sequence is available in [Table 8-4](#).
- Open-drain output by default; optional driver enabled using BitGen `drivedone` option.

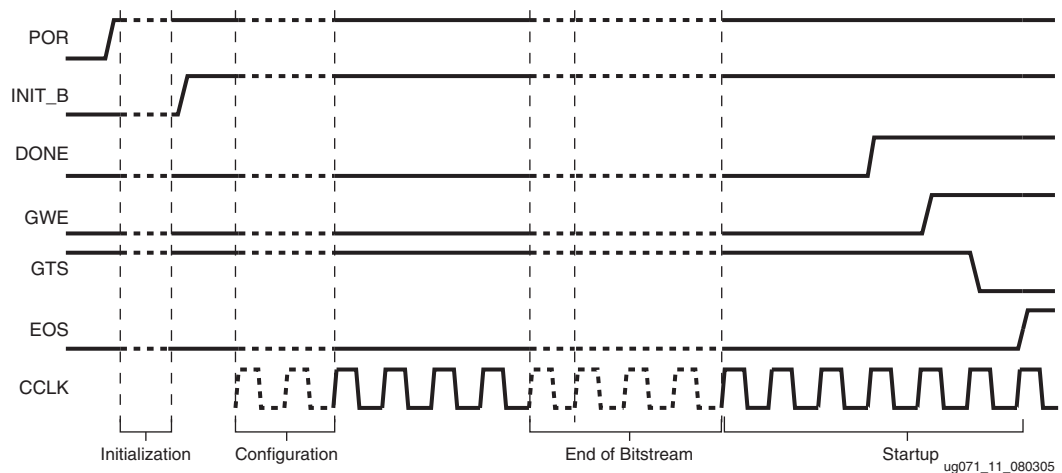


Figure 1-11: Configuration Signal Sequencing (Default Startup Settings)

Bitstream Encryption

Virtex-4 devices have on-chip AES (Advanced Encryption Standard) decryption logic to provide a high degree of design security. Without knowledge of the encryption key, potential pirates cannot analyze an externally intercepted bitstream to understand or clone the design. Encrypted Virtex-4 designs cannot be copied or reverse-engineered.

The Virtex-4 AES system consists of software-based bitstream encryption and on-chip bitstream decryption with dedicated memory for storing the encryption key. Using the Xilinx ISE software, the user generates the encryption key and the encrypted bitstream. During configuration, the Virtex-4 device performs the reverse operation, decrypting the incoming bitstream. The Virtex-4 AES encryption logic uses a 256-bit encryption key.

The on-chip AES decryption logic cannot be used for any purpose other than bitstream decryption; i.e., the AES decryption logic is not available to the user design and cannot be used to decrypt any data other than the configuration bitstream.

Virtex-4 devices store the encryption key internally in dedicated RAM, backed up by a small externally connected battery. The encryption key can only be programmed onto the device through the JTAG interface; once programmed, it is not possible to read the encryption key out of the device through JTAG or any other means.

ICAP is not supported with an encrypted bitstream in the LX, SX, and FX12 devices.

AES Overview

The Virtex-4 encryption system uses the Advanced Encryption Standard (AES) encryption algorithm. AES is an official standard supported by the National Institute of Standards and Technology (NIST) and the U.S. Department of Commerce (<http://csrc.nist.gov/publications/fips/fips197/fips-197.pdf>).

The Virtex-4 AES encryption system uses a 256-bit encryption key (the alternate key lengths of 128- and 192- bits described by NIST are not implemented) to encrypt or decrypt blocks of 128 bits of data at a time. According to NIST, there are 1.1×10^{77} possible key combinations for a 256-bit key.

Symmetric encryption algorithms such as AES use the same key for encryption and decryption. The security of the data is therefore dependent on the secrecy of the key.

Creating an Encrypted Bitstream

The Xilinx Bitstream Generator (BitGen, provided with the Xilinx ISE software) can generate encrypted as well as non-encrypted bitstreams. For AES bitstream encryption, the user specifies a 256-bit key as an input to BitGen. BitGen in turn generates an encrypted bitstream file (.bit) and an encryption key file (.nky).

For specific BitGen commands and syntax, refer to the *Development System Reference Guide*.

Loading the Encryption Key

The encryption key can only be programmed onto a Virtex-4 device through the JTAG interface. The iMPACT tool, provided with the Xilinx ISE software, can accept the .nky file as an input and program the device with the key through JTAG, using a supported Xilinx programming cable.

To program the key, the device enters a special *key-access mode* using the ISC_PROGRAM instruction, as detailed in the JTAG 1532 specification. In this mode, all FPGA memory, including the encryption key and configuration memory, is cleared. Once the key is programmed and the key-access mode is exited, it cannot be read out of the device by any means, and it cannot be reprogrammed without clearing the entire device. The key-access mode is transparent to most users.

Loading Encrypted Bitstreams

Once the device has been programmed with the correct encryption key, the device can be configured with an encrypted bitstream. After configuration with an encrypted bitstream, it is not possible to read the configuration memory through JTAG or SelectMAP readback, regardless of the BitGen security setting.

After loading the encryption key, a non-encrypted bitstream can be used to configure the device; in this case the key is ignored. After configuring with a non-encrypted bitstream, readback is possible (if allowed by the BitGen security setting). The encryption key still cannot be read out of the device, preventing the use of *Trojan Horse* bitstreams to defeat the Virtex-4 encryption scheme.

However, once an encrypted bitstream has been used to configure a device, the device cannot be reconfigured with a non-encrypted bitstream unless a full-chip reset is performed first by pulling the PROGRAM_B pin Low, cycling power, or issuing a JPROGRAM instruction. Additional encrypted reconfigurations can be performed.

The method of configuration is not affected by encryption. The configuration bitstream can be delivered in any mode (Serial, SelectMAP, or JTAG) from any configuration solution (PROM, System ACE™ tool, etc.). Configuration timing and signaling are unaffected by encryption.

The encrypted bitstream must configure the entire device, because partial reconfiguration through the external configuration interfaces is not permitted for encrypted bitstreams. After configuration, the device cannot be reconfigured without toggling the PROG pin, cycling power, or issuing the JTAG JSTART or JPROG instruction. Readback is available through the ICAP primitive (see [“Bitstream Encryption and Internal Configuration Access Port \(ICAP\)”](#)). None of these events resets the key if V_{BATT} or V_{CCAUX} is maintained.

A mismatch between the key in the encrypted bitstream and the key stored in the device causes configuration to fail with the INIT pin remaining High and the DONE pin remaining Low. A mismatch between the key and bitstream can result in a high current on V_{CCINT} .

Note:

1. Do **not** use or monitor BUSY when loading an encrypted bitstream.
2. SelectMAP-32 mode is not supported with encrypted bitstreams.

Bitstream Encryption and Internal Configuration Access Port (ICAP)

The Internal Configuration Access Port (ICAP) primitive provides the user logic with access to the Virtex-4 configuration interface. The ICAP interface is similar to the SelectMAP interface, although the restrictions on readback and reconfiguration for the SelectMAP interface do not apply to the ICAP interface after configuration. Users can perform readback and reconfiguration through the ICAP interface even if bitstream encryption is used. Unless the designer wires the ICAP interface to user I/O, this does not offer attackers a method for defeating the Virtex-4 AES encryption scheme. ICAP is not supported with an encrypted bitstream in the LX, SX, and FX12 devices.

Users concerned about the security of their design should **not**:

- Wire the ICAP interface to user I/O

-or-

- Not instantiate the ICAP primitive.

Like the other configuration interfaces, the ICAP interface does not provide access to the key register.

V_{BATT}

The encryption key memory cells are volatile and must receive continuous power to retain their contents. During normal operation, these memory cells are powered by the auxiliary voltage input (V_{CCAUX}), although a separate V_{BATT} power input is provided for retaining the key after V_{CCAUX} is removed. Because V_{BATT} draws very little current (on the order of nano amperes), a small watch battery is suitable for this supply. (To estimate the battery life, refer to V_{BATT} DC Characteristics in the *Virtex-4 FPGA Data Sheet* and the battery specifications.) At less than a 100 nA load, the endurance of the battery should be limited only by its shelf life.

V_{BATT} does not draw any current and can be removed while V_{CCAUX} is applied. V_{BATT} cannot be used for any purpose other than retaining the encryption keys when V_{CCAUX} is removed.

Configuration Interfaces

Virtex®-4 devices have three configuration interfaces. Each configuration interface corresponds to one or more configuration modes, shown in [Table 2-1](#). For detailed interface timing information, see the *Virtex-4 FPGA Data Sheet*.

Table 2-1: Configuration Interfaces and Corresponding Configuration Modes

Configuration Interface	Corresponding Configuration Mode(s)
Serial	Master Serial, Slave Serial
SelectMAP (8-bit or 32-bit)	Master SelectMAP, Slave SelectMAP
JTAG	JTAG

Serial Configuration Interface

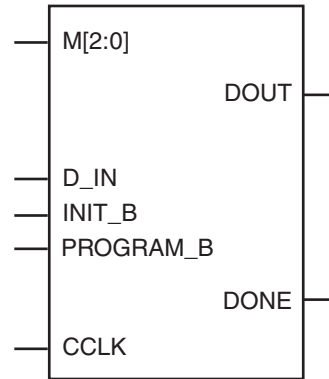
In serial configuration modes, the FPGA is configured by loading one configuration bit per CCLK cycle:

- In Master serial mode, CCLK is an output.
- In Slave serial mode, CCLK is an input.

[Figure 2-1](#) shows the basic Virtex-4 serial configuration interface.

There are four methods of configuring an FPGA in serial mode:

- Master serial configuration
- Slave serial configuration
- Serial daisy chain configuration
- Ganged serial configuration



ug071_14_073007

Figure 2-1: Virtex-4 Serial Configuration Interface

Table 2-2 describes the Serial Configuration Interface.

Table 2-2: Virtex-4 Serial Configuration Interface Pins

Pin Name	Type	Dedicated or Dual-Purpose	Description
M[2:0]	Input	Dedicated	Mode Pins – determine configuration mode.
CCLK	Input or Output	Dedicated	Configuration clock source for all configuration modes except JTAG.
D_IN	Input	Dedicated	Serial configuration data input, synchronous to rising CCLK edge.
DOUT_BUSY	Output	Dedicated	Serial data output for downstream daisy-chained devices.
DONE	Bidirectional, open-drain or active	Dedicated	Active High signal indicating configuration is complete: 0 = FPGA not configured 1 = FPGA configured Refer to the “BitGen” section of the <i>Development System Reference Guide</i> for software settings.
INIT_B	Input or Output, open-drain	Dedicated	Before the MODE pins are sampled, INIT_B is an input that can be held Low to delay configuration. After the MODE pins are sampled, INIT_B is an open-drain active Low output indicating whether a CRC error occurred during configuration: 0 = CRC error 1 = No CRC error
PROGRAM_B	Input	Dedicated	Active-Low asynchronous full-chip reset.

Clocking Serial Configuration Data

Figure 2-2 shows how configuration data are clocked into Virtex-4 devices in Slave serial and Master serial modes.

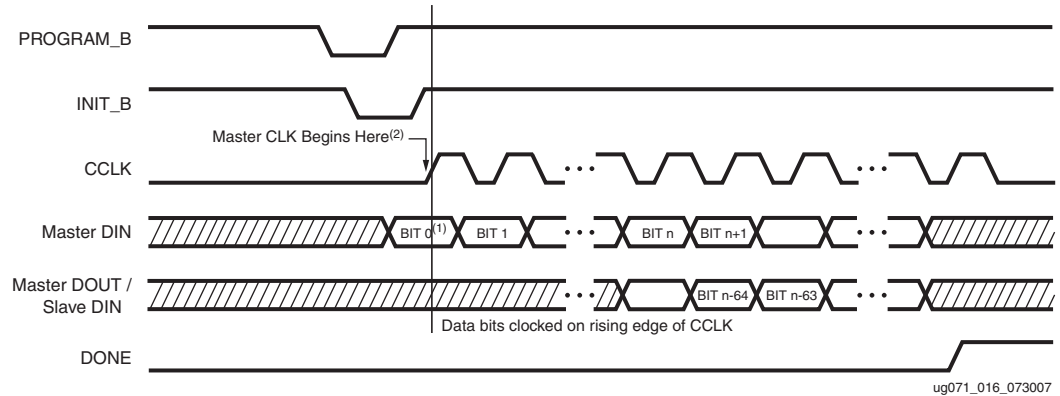


Figure 2-2: Serial Daisy Chain Configuration Clocking Sequence

Notes relevant to Figure 2-2:

1. In Figure 2-2, bit 0 represents the MSB of the first byte. For example, if the first byte is 0xAA (1010_1010), bit 0=1, bit 1=0, bit 2=1, etc.
2. For Master configuration mode, CCLK does not transition until after MODE pins are sampled, as indicated by the arrow.
3. CCLK can be free-running in Slave serial mode.

Master Serial Configuration

The Master serial mode is designed so that the FPGA can be configured from a Xilinx® serial configuration PROM, as shown in Figure 2-3.

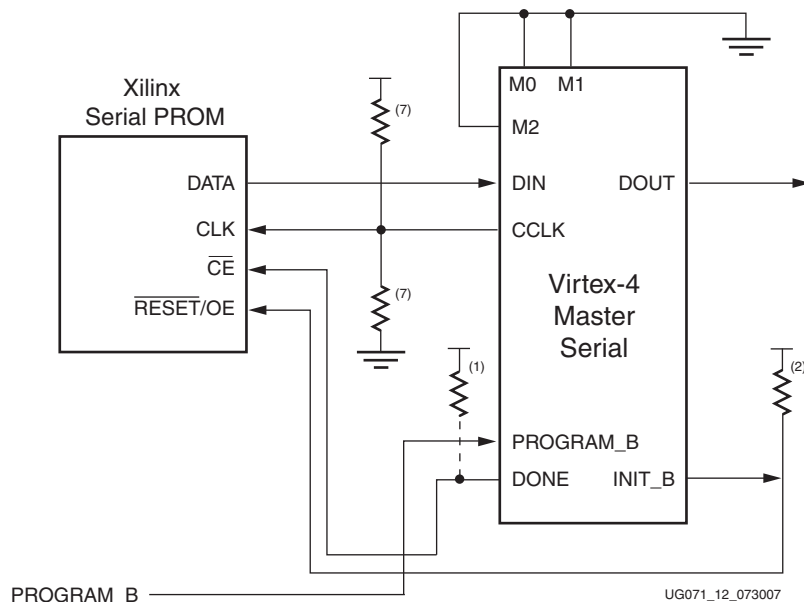


Figure 2-3: Master Serial Mode Configuration

Notes relevant to [Figure 2-3](#):

1. The DONE pin is by default an open-drain output requiring an external pull-up resistor. A 330 Ω pull-up resistor is recommended. The DONE pin has a programmable active driver. To enable it, enable the **DriveDONE** option in BitGen.
2. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.
3. The BitGen startup clock setting must be set for CCLK for serial configuration. The oscillator frequency can be selected in BitGen (default is 4 MHz). Selectable frequencies are 4, 5, 7, 8, 9, 10, 13, 15, 20, 26, 30, 34, 41, 45, 51, 55, and 60 MHz. Because the oscillator can vary by $\pm 50\%$, select a maximum frequency not to exceed the F_{MAX} of the configuration device.
4. The PROM in this diagram represents one or more Xilinx serial PROMs. Multiple serial PROMs can be cascaded to increase the overall configuration storage capacity.
5. The .bit file must be reformatted into a PROM file before it can be stored on the serial PROM. Refer to the “[Generating PROM Files](#)” section.
6. On XC17V00 PROMs, the reset polarity is programmable. \overline{RESET} should be set for active Low when using an XC17V00 device in this setup.
7. Connect pull-up resistors to V_{CC_CONFIG} (identical to V_{CC} Bank 0).
8. The CCLK net requires Thevenin parallel termination. See “[Board Layout for Configuration Clock \(CCLK\)](#),” page 34.
9. The CCLK pin is an output and an input.

Slave Serial Configuration

Slave serial configuration is typically used for devices in a serial daisy chain, or when configuring a single device from an external microprocessor or CPLD. Design considerations are similar to Master serial configuration except for the direction of CCLK. A single device in Slave serial mode cannot simply be connected to a PROM, because CCLK is an input on both devices.

Serial Daisy Chains

Multiple Virtex-4 devices can be configured from a single configuration source by arranging the devices in a serial daisy chain. In a serial daisy chain, devices receive their configuration data through their DIN pin, passing configuration data along to downstream devices through their DOUT pin. The device closest to the configuration data source is considered the most *upstream* device, while the device furthest from the configuration data source is considered the most *downstream* device.

In a serial daisy chain, the configuration clock is typically provided by the most upstream device in Master serial mode. All other devices are set for Slave serial mode. [Figure 2-4](#) illustrates this configuration.

Alternatively, if a CPLD or microprocessor is used as a configuration controller, all devices can be set for Slave serial mode. (See “[Configuring a Serial Daisy Chain with a Microprocessor or CPLD](#),” page 32.)

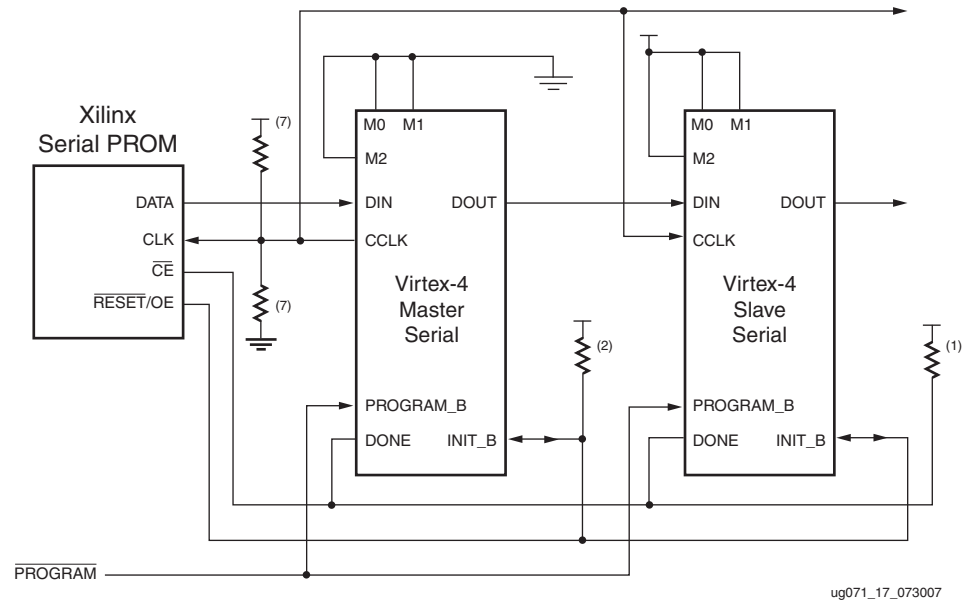


Figure 2-4: Master/Slave Serial Mode Daisy Chain Configuration

Notes relevant to [Figure 2-4](#):

1. The DONE pin is by default an open-drain output requiring an external pull-up resistor. A 330Ω pull-up resistor is recommended. For all devices except the last, the active driver on DONE must be disabled. For the last device in the chain, the active driver on DONE can be enabled. See [“Guidelines and Design Considerations for Serial Daisy Chains.”](#)
2. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.
3. The BitGen startup clock setting must be set for CCLK for serial configuration. The oscillator frequency can be selected in BitGen (default is 4 MHz). Selectable frequencies are 4, 5, 7, 8, 9, 10, 13, 15, 20, 26, 30, 34, 41, 45, 51, 55, and 60 MHz. Because the oscillator can vary by ± 50%, select a maximum frequency not to exceed the F_{MAX} of the configuration device.
4. The PROM in this diagram represents one or more Xilinx serial PROMs. Multiple serial PROMs can be cascaded to increase the overall configuration storage capacity.
5. The .bit file must be reformatted into a PROM file before it can be stored on the serial PROM. Separate bitstream files cannot be concatenated together to form a daisy-chain bitstream. Refer to the [“Generating PROM Files”](#) section.
6. On XC17V00 PROMs, the reset polarity is programmable. \overline{RESET} should be set for active Low when using an XC17V00 device in this setup.
7. The CCLK net requires Thevenin parallel termination. See [“Board Layout for Configuration Clock \(CCLK\),”](#) page 34.

The first device in a serial daisy chain is the first to be configured. No data is passed onto the DOUT pin until all the data frames, the start-up command, and CRC check have been loaded. CRC checks only include the data for the current device, not for any others in the chain. (See [“Cyclic Redundancy Check \(Step 7\)”](#) in Chapter 1.)

After the first device in the chain finishes configuration and passes its CRC check, it enters the Start-Up sequence. At the *Release DONE pin* phase in the Start-Up sequence, the device

places its DONE pin in a high-Z state while continuing to pass configuration data and commands to downstream devices. After all devices release their DONE pins, the common DONE signal is either pulled High externally or driven High by the last device in the chain. On the next rising CCLK edge, all devices move out of the *Release DONE pin* phase and complete their startup sequences.

It is important that all DONE pins in a Slave serial daisy chain be connected. Only the last device in the serial daisy chain should have the DONE driver enabled. Enabling the DONE driver on upstream devices causes contention on the DONE signal.

Configuring a Serial Daisy Chain with a Microprocessor or CPLD

If a microprocessor or CPLD is driving configuration instead of a Xilinx serial PROM, all devices in the serial daisy chain can be set for Slave serial configuration mode, or the lead FPGA can be set for Master serial, as shown in [Figure 2-5](#).

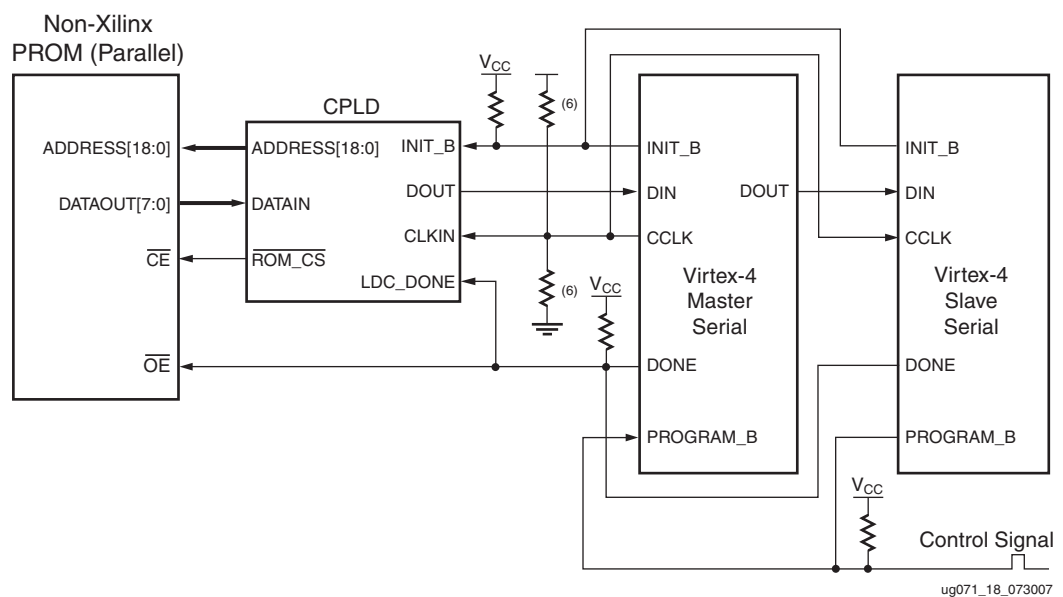


Figure 2-5: Serial Daisy Chain Configuration from Parallel EPROM and CPLD

Notes relevant to [Figure 2-5](#):

1. This schematic shows one of many possible implementations.
2. The DONE pin is by default an open-drain output requiring an external pull-up resistor. A 330Ω pull-up resistor is recommended. For all devices except the first, the active driver on DONE must be disabled. For the first device in the chain, the active driver on DONE can be enabled. See [“Guidelines and Design Considerations for Serial Daisy Chains.”](#)
3. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.
4. The BitGen startup clock setting must be set for CCLK for serial configuration.
5. The .bit file must be reformatted into a PROM file before it can be stored on the PROM. Refer to the [“Generating PROM Files”](#) section.
6. The CCLK net requires Thevenin parallel termination. See [“Board Layout for Configuration Clock \(CCLK\),”](#) page 34.

Mixed Serial Daisy Chains

Virtex-4 devices can be daisy-chained with the Virtex, Spartan®-II, Virtex-E, Spartan-IIE, Virtex-II, Virtex-II Pro, and Spartan-3 families. There are three important design considerations when designing a mixed serial daisy chain:

- Many older devices cannot accept as fast a CCLK frequency as a Virtex-4 device can generate. Select a configuration CCLK speed supported by all devices in the chain.
- Newer devices should be grouped at the beginning of the serial daisy chain, with older devices located at the end of the chain.
- The number of configuration bits that a device can pass through its DOUT pin is limited. This limit varies for different families (Table 2-3). The sum of the bitstream lengths for all downstream devices must not exceed the number in this table for each family.

Table 2-3: Maximum Number of Configuration Bits, Various Device Families

Architecture	Maximum DOUT Bits
Virtex-4	$32 \times (2^{27} - 1) = 4,294,967,264$
Virtex-II Pro, Virtex-II	$32 \times (2^{27} - 1) = 4,294,967,264$
Spartan-3	$32 \times (2^{27} - 1) = 4,294,967,264$
Virtex, Virtex-E, Spartan-II, Spartan-IIE	$32 \times (2^{20} - 1) = 33,554,216$

Guidelines and Design Considerations for Serial Daisy Chains

There are a number of important considerations for serial daisy chains:

Startup Sequencing (GTS)

GTS should be released before DONE or during the same cycle as DONE to ensure the Virtex-4 device is operational when all DONE pins have been released.

Active DONE Driver

All devices except the first should disable the driver on the DONE pin (refer to the BitGen section of the *Development System Reference Guide* for software settings):

- DriveDone enabled (first device)
- DriveDone disabled (all devices except the first)

Alternatively, the driver can be disabled for all DONE pins and an external pull-up resistor added to pull the signal High after all devices have released it.

Connect All DONE Pins

It is important to connect the DONE pins for all devices in a serial daisy chain. Failing to connect the DONE pins can cause configuration to fail. For debugging purposes, it is often helpful to have a way of disconnecting individual DONE pins from the common DONE signal, so that devices can be individually configured through the serial or JTAG interface.

DONE Pin Rise Time

After all DONE pins are released, the DONE pin should rise from logic 0 to logic 1 in one CCLK cycle. If there are several devices in the serial daisy chain or other loads on the DONE signal (such as LEDs or microprocessor inputs), external pull-up resistors can be

required. If additional time is required for the DONE signal to rise, the BitGen `donepipe` option can be set for all devices in the serial daisy chain. (Refer to the BitGen section of the *Development System Reference Guide* for software settings.)

Board Layout for Configuration Clock (CCLK)

The Virtex-4 output standard for all configuration I/Os, including CCLK, is **different** from previous Xilinx FPGAs. To improve performance, the Virtex-4 configuration I/Os use the LVCMOS fast slew rate standard of 12 mA. This change results in faster edge rates to support higher configuration frequencies. This requires more attention to PCB trace routing and termination for proper signal integrity.

These basic guidelines must be followed:

- Route the CCLK net as a 50Ω controlled impedance transmission line.
- Always route the CCLK net without any branching, do *not* use a *star* topology (Figure 2-9).
- Stubs, if necessary, must be shorter than 8 mm (0.3 inches).
- Terminate the end of the CCLK transmission line with a parallel termination of 100Ω to V_{CCO} , and 100Ω to GND (the Thevenin equivalent of $V_{CCO}/2$, and assuming a trace characteristic impedance of 50Ω).

Xilinx recommends simulating the CCLK distribution with an IBIS simulator (such as HyperLynx) to check for glitches on each CLK input, including the CCLK of the master FPGA.

Figure 2-6 through Figure 2-8 show the recommended topologies for CCLK distribution.

Figure 2-6 shows the basic point-to-point topology for one CCLK driver (FPGA master) and one CCLK receiver (PROM or FPGA slave).

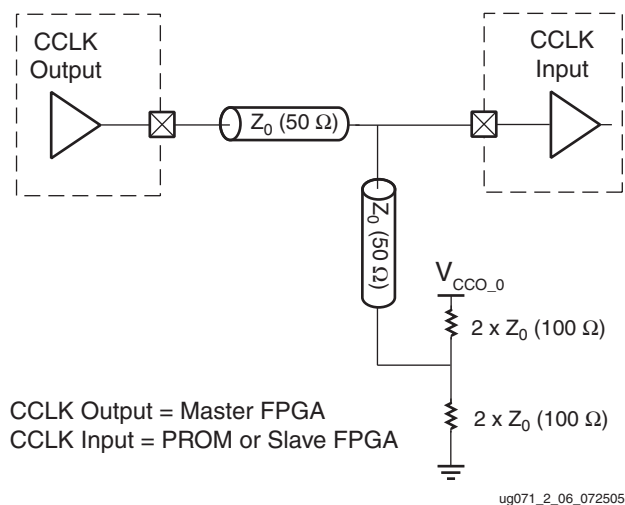


Figure 2-6: Point-to-Point: One CCLK Output, One CCLK Input

Figure 2-7 shows the basic multi-drop *flyby* topology for one CCLK driver and two CCLK receivers. The stub at CCLK input 1 has a length constraint.

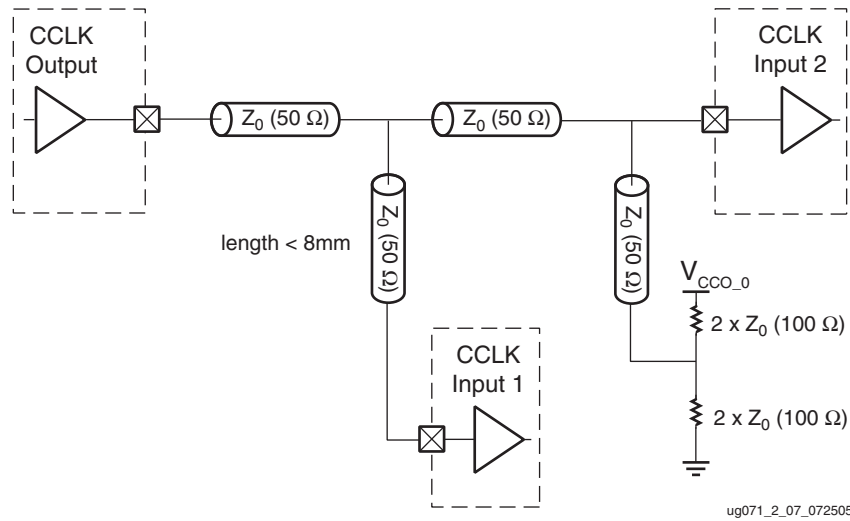


Figure 2-7: Multi-Drop: One CCLK Output, Two CCLK Inputs

Figure 2-8 shows the multi-drop *flyby* topology for one CCLK driver and more than two CCLK receivers (four in this example). All CCLK inputs except input 4 have length constraints.

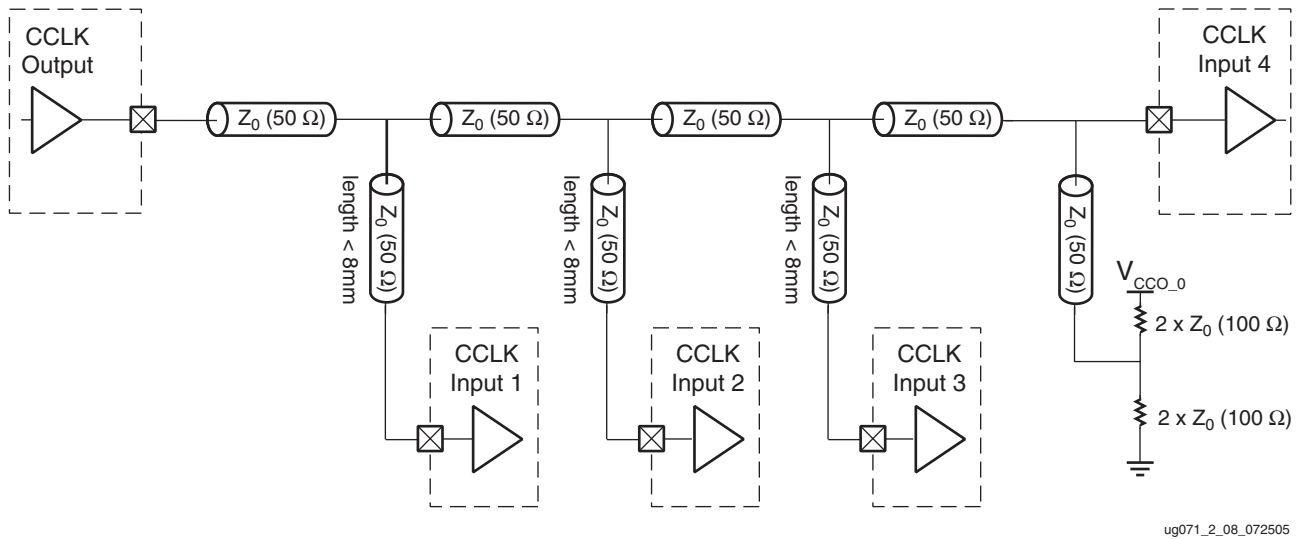
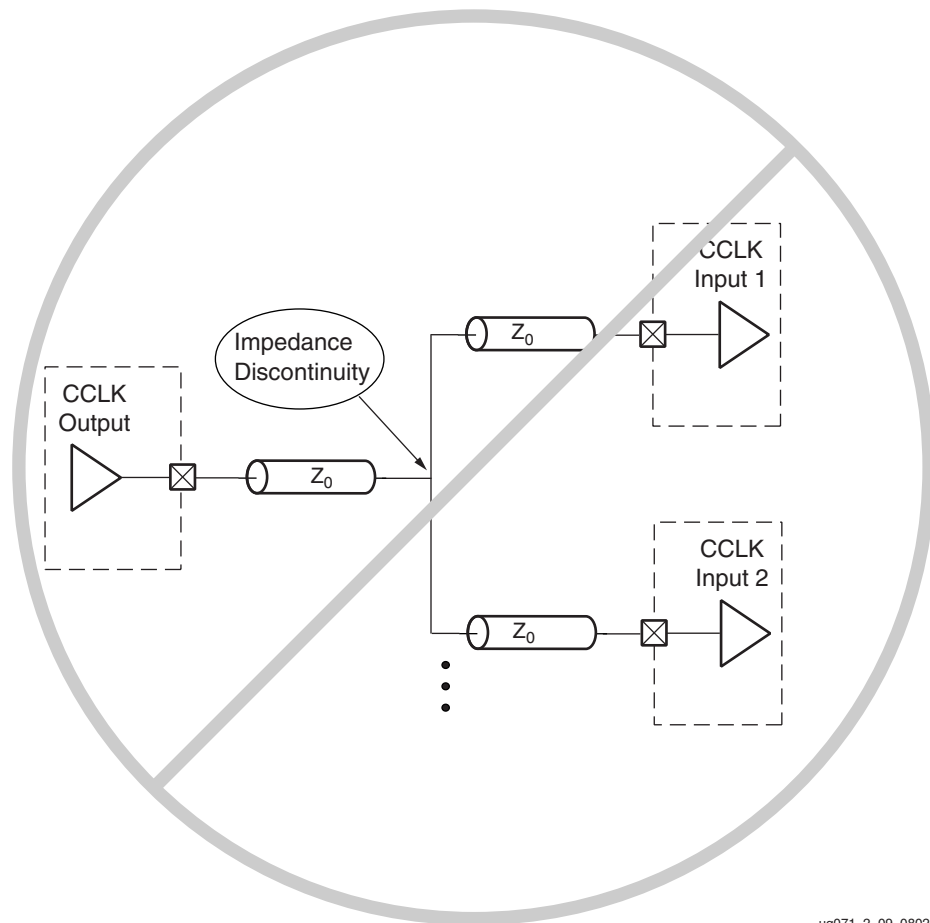


Figure 2-8: Multi-Drop: One CCLK Output, More Than Two CCLK Inputs

Figure 2-9 shows a *star* topology where the transmission line branches to the multiple CCLK inputs. The branch point creates a significant impedance discontinuity. This arrangement is **Not Recommended**.



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**Figure 2-9: Not Recommended
Star Topology: One CCLK Output, Two CCLK Inputs**

Daisy-Chaining Virtex-4 with Earlier FPGA Generations

A serial daisy chain can include earlier generations of Xilinx FPGAs (Virtex-II, Virtex, Spartan-II, 4000, etc.). In general, newer devices should appear upstream of older devices. For example, a daisy chain consisting of a Virtex-4, a Virtex-II, a Virtex, and a 4000E device should be arranged with the Virtex-4 device first in the chain, the Virtex-II device second, the Virtex device third, and the 4000E device last.

BitGen Options for Mixed Daisy Chains

All Virtex-based device families have similar BitGen options. The guidelines provided for Virtex-4 BitGen options should be applied to all Virtex-based devices in a serial daisy chain.

If 4000-series devices are included in the daisy chain, it is important to set the BitGen **SyncToDONE** option for the startup settings.

Maximum CCLK Rate Varies Between Xilinx Device Families

Older Xilinx device families require slower CCLK rates than Virtex-4 devices. For mixed serial daisy chains, ensure the Master device does not toggle CCLK faster than the slowest device can tolerate.

PROM File Considerations

The PROM file for a serial daisy chain is larger than the sum of all bitstreams due to additional configuration instructions. See [“Generating PROM Files.”](#)

Ganged Serial Configuration

More than one device can be configured simultaneously from the same bitstream using a *ganged* serial configuration setup (Figure 2-10). In this arrangement, the serial configuration pins are tied together such that each device sees the same signal transitions. One device is typically set for Master serial mode (to drive CCLK) while the others are set for Slave serial mode. For ganged serial configuration, all devices must be identical. Configuration can be driven from a configuration PROM or from an external configuration controller.

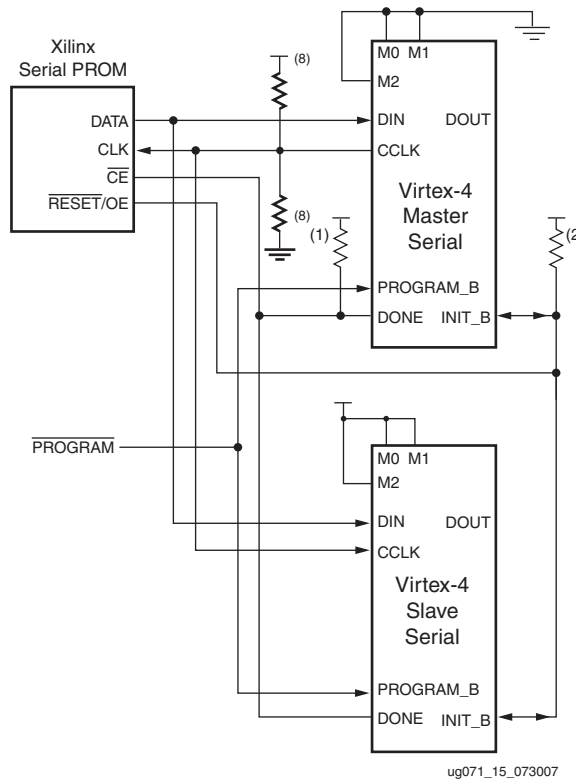


Figure 2-10: Ganged Serial Configuration

Notes relevant to Figure 2-10:

1. For ganged serial configuration, the optional DONE driver must be disabled for all devices if one device is set for Master mode, because each device might not start up on exactly the same CCLK cycle. An external pull-up resistor is required in this case.
2. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.

3. The BitGen startup clock setting must be set for CCLK for serial configuration.
4. The PROM in this diagram represents one or more Xilinx serial PROMs. Multiple serial PROMs can be cascaded to increase the overall configuration storage capacity.
5. The `.bit` file must be reformatted into a PROM file before it can be stored on the serial PROM. Refer to the “[Generating PROM Files](#)” section.
6. On XC17V00 devices, the reset polarity is programmable. $\overline{\text{RESET}}$ should be set for active Low when using an XC17V00 device in this setup.
7. For ganged serial configuration, all devices must be identical (same IDCODE) and must be configured with the same bitstream.
8. The CCLK net requires Thevenin parallel termination. See “[Board Layout for Configuration Clock \(CCLK\)](#),” page 34.

There are a number of important considerations for ganged serial configuration:

Startup Sequencing (GTS)

GTS should be released before DONE or during the same cycle as DONE to ensure all devices are operational when all DONE pins have been released.

Disable the Active DONE Driver On for All Devices

For ganged serial configuration, the active DONE driver must be disabled for all devices if the DONE pins are tied together, because there can be variations in the startup sequencing of each device. A pull-up resistor is therefore required on the common DONE signal.

`-g DriveDone:no` (BitGen option, all devices)

Connect All DONE Pins if Using a Master Device

It is important to connect the DONE pins for all devices in ganged serial configuration if one FPGA is used as the Master device. Failing to connect the DONE pins can cause configuration to fail for individual devices in this case. If all devices are set for Slave serial mode, the DONE pins can be disconnected (if the external CCLK source continues toggling until all DONE pins go High).

For debugging purposes, it is often helpful to have a way of disconnecting individual DONE pins from the common DONE signal.

DONE Pin Rise Time

After all DONE pins are released, the DONE pin should rise from logic 0 to logic 1 in one CCLK cycle. If additional time is required for the DONE signal to rise, the BitGen `donepipe` option can be set for all devices in the serial daisy chain.

Configuration Clock (CCLK) as Clock Signal for Board Layout

The CCLK signal is an LVCMOS fast 12 mA driver (LVCMOS_P12.) Signal integrity issues on the CCLK signal can cause configuration to fail. (Typical failure mode: DONE Low, INIT_B High.) Therefore, careful attention to signal integrity, including signal integrity simulation with IBIS, is recommended.

Signal Fanout

Special care must be taken in assuring good signal integrity when using ganged serial configuration. Signal integrity simulation is recommended.

PROM Files for Ganged Serial Configuration

PROM files for ganged serial configuration are identical to the PROM files used to configure single devices. There are no special PROM file considerations.

SelectMAP Configuration Interface

The SelectMAP configuration interface (Figure 2-11) provides an 8-bit bidirectional data-bus interface to the Virtex-4 configuration logic that can be used for both configuration and readback. (For details, refer to Chapter 8)

CCLK is an output in Master SelectMAP mode; in Slave SelectMAP, CCLK is an input. One or more Virtex-4 devices can be configured through the SelectMAP bus.

There are four methods of configuring an FPGA in SelectMAP mode:

- Single device Master SelectMAP
- Single device Slave SelectMAP
- Multiple device SelectMAP bus
- Multiple device ganged SelectMAP

Table 2-4 describes the SelectMAP configuration interface.

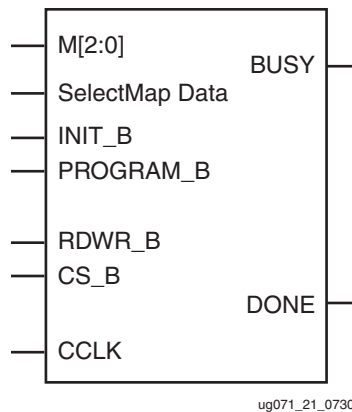


Figure 2-11: Virtex-4 SelectMAP Configuration Interface

Table 2-4: Virtex-4 SelectMAP Configuration Interface Pins

Pin Name	Type	Dedicated or Dual-Purpose	Description
M[2:0]	Input	Dedicated	MODE pins - determines configuration mode
CCLK	Input and Output	Dedicated	Configuration clock source for all configuration modes except JTAG
SelectMAP Data	Three-State Bidirectional	Dual Purpose	Byte-wide (SelectMAP 8 bit) configuration and readback data bus, clocked on rising edge of CCLK. D0 is the most-significant bit (MSB), D7 the least-significant bit (LSB). In SelectMAP 32 bit, configuring the data order is straight D0 = LSB and D31 = MSB. ⁽¹⁾

Table 2-4: Virtex-4 SelectMAP Configuration Interface Pins (Continued)

Pin Name	Type	Dedicated or Dual-Purpose	Description
DOUT_BUSY	Three-State Output	Dedicated	Indicates that the device is not ready to send readback data. For Virtex-4 devices, the BUSY signal is only needed for readback; it is not needed for configuration (see “ SelectMAP Data Loading ”).
DONE	Bidirectional, Open-Drain or active	Dedicated	Active High signal indicating configuration is complete: 0 = FPGA not configured 1 = FPGA configured
INIT_B	Input or Output, Open-Drain	Dedicated	Before MODE pins are sampled, INIT_B is an input that can be held Low to delay configuration. After MODE pins are sampled, INIT_B is an open-drain active Low output indicating whether a CRC error occurred during configuration: 0 = CRC error 1 = No CRC error
PROGRAM_B	Input	Dedicated	Active-Low asynchronous full-chip reset
CS_B	Input	Dedicated	Active-Low chip select to enable the SelectMAP data bus (see “ SelectMAP Data Loading ”): 0 = SelectMAP data bus enabled 1 = SelectMAP data bus disabled ⁽²⁾
RDWR_B	Input	Dedicated	Determines the direction of the SelectMAP data bus (see “ SelectMAP Data Loading ”): 0 = inputs 1 = outputs RDWR_B input can only be changed while CS_B is deasserted, otherwise an ABORT occurs (see “ SelectMAP ABORT ”) ⁽²⁾ .

Notes:

1. If SelectMAP32 is used and the bitstream is compressed by the **-g compress** in BitGen then the CONFIG_MODE constraint must be used. the values for the CONFIG_MODE constraint are either S_SelectMAP32 or S_SelectMAP32+READBACK. S_SelectMAP32+READBACK preserves the S_SelectMAP32 data pins for readback (also known as **persist**).
2. If the SelectMAP interface is not used, the CS_B and RDWR_B pins can be left unconnected. Weak pullups pull these pins High, and their state is ignored.

Single Device SelectMAP Configuration

The simplest way to configure a single device in SelectMAP mode is to connect it directly to a parallel configuration PROM as shown in Figure 2-12. In this arrangement, the device is set for Master SelectMAP mode, and the RDWR_B and CS_B pins are tied to Ground for continuous data loading (see “SelectMAP Data Loading”).

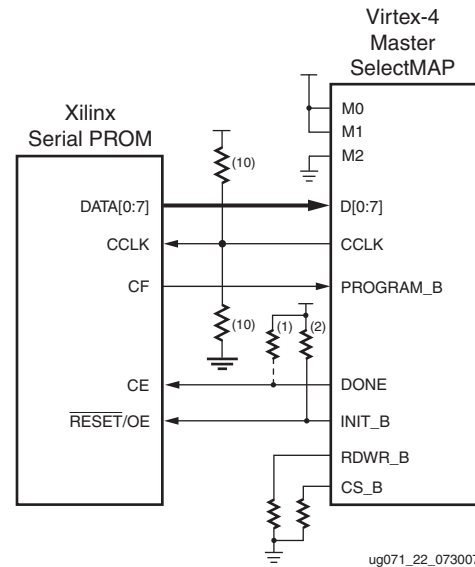


Figure 2-12: Single Device Master SelectMAP Configuration

Notes relevant to Figure 2-12:

1. The DONE pin is by default an open-drain output requiring an external pull-up resistor. A 330Ω pull-up resistor is recommended. In this arrangement, the active DONE driver can be enabled, eliminating the need for an external pull-up resistor.
2. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.
3. The BitGen startup clock setting must be set for CCLK for SelectMAP configuration.
4. The PROM in this diagram represents one or more Xilinx serial PROMs. Multiple serial PROMs can be cascaded to increase the overall configuration storage capacity.
5. The .bit file must be reformatted into a PROM file before it can be stored on the serial PROM. Refer to the “Generating PROM Files” section.
6. On XC17V00 devices, the reset polarity is programmable. $\overline{\text{RESET}}$ should be set for active Low when using an XC17V00 device in this setup.
7. The Xilinx PROM must be set for parallel mode. Note that this mode is not available for all devices.
8. When configuring a Virtex-4 device in SelectMAP mode from a Xilinx configuration PROM, the RDWR_B and CS_B signals can be tied Low (see “SelectMAP Data Loading”).
9. The BUSY signal does not need to be monitored for this setup and can be left unconnected (see “SelectMAP Data Loading”).
10. The CCLK net requires Thevenin parallel termination. See “Board Layout for Configuration Clock (CCLK),” page 34.
11. The CCLK pin is an output and an input.

For custom applications where a microprocessor or CPLD is used to configure a single Virtex-4 device, either Master or Slave SelectMAP mode can be used (Figure 2-13). See Xilinx [Application Note XAPP502](#) for information on configuring Virtex devices using a microprocessor). Refer to “SelectMAP Data Loading” for details on handling the CS_B, RDWR_B, and BUSY signals.

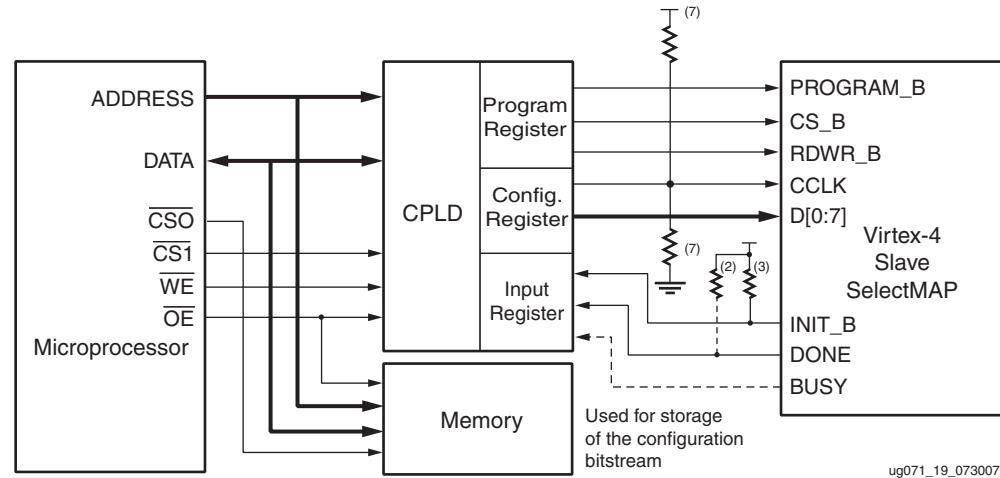


Figure 2-13: Single Slave Device SelectMAP Configuration from Microprocessor and CPLD

Notes relevant to Figure 2-13:

1. This schematic is from [Xilinx Application Note XAPP502](#). It is one of many possible implementations.
2. The DONE pin is by default an open-drain output requiring an external pull-up resistor. A 330Ω pull-up resistor is recommended. In this arrangement, the active DONE driver can be enabled, eliminating the need for an external pull-up resistor.
3. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.
4. The BitGen startup clock setting must be set for CCLK for SelectMAP configuration.
5. The BUSY signal can be left unconnected if readback is not needed.
6. The CS_B and RDWR_B signals can be tied to ground if only one FPGA is going to be configured and readback is not needed.
7. The CCLK net requires Thevenin parallel termination. See “Board Layout for Configuration Clock (CCLK),” page 34.

Multiple Device SelectMAP Configuration

Multiple Virtex-4 devices in Slave SelectMAP mode can be connected on a common SelectMAP bus (Figure 2-14). In a SelectMAP bus, the data pins (SelectMAP data, CCLK, RDWR_B, BUSY, PROGRAM_B, DONE, and INIT_B) share a common connection between all of the devices. To allow each device to be accessed individually, the CS_B (Chip Select) inputs must not be tied together. External control of the CS_B signal is required and is usually provided by a microprocessor or CPLD.

If Readback is going to be performed on the device after configuration, the RDWR_B and BUSY signals must be handled appropriately. (For details, refer to [Chapter 8](#))

Otherwise, RDWR_B can be tied Low and BUSY can be ignored. Unlike earlier Virtex devices, the BUSY signal never needs to be monitored when configuring Virtex-4 devices. Refer to “Bitstream Loading (Steps 4-7)” in Chapter 1 and to Chapter 8.

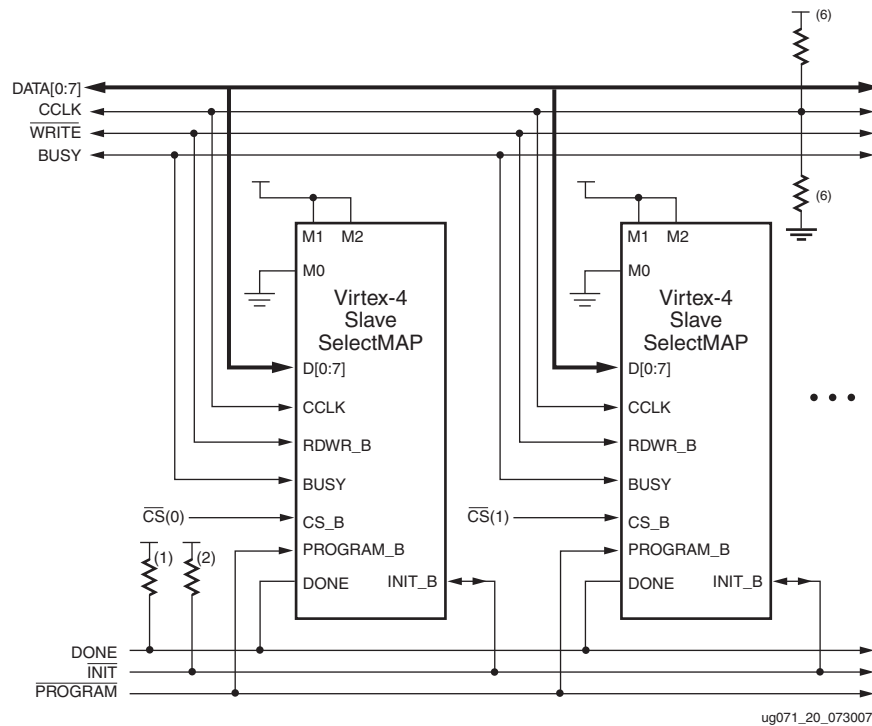


Figure 2-14: Multiple Slave Device Configuration on an 8-bit SelectMAP Bus

Notes relevant to Figure 2-14:

1. The DONE pin is by default an open-drain output requiring an external pull-up resistor. A 330Ω pull-up resistor is recommended. In this arrangement, the active DONE driver must be disabled.
2. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.
3. The BitGen startup clock setting must be set for CCLK for SelectMAP configuration.
4. The BUSY signals can be left unconnected if readback is not needed.
5. An external controller such as a microprocessor or CPLD is needed to control configuration.
6. The CCLK net requires Thevenin parallel termination. See “Board Layout for Configuration Clock (CCLK),” page 34.

Ganged SelectMAP

It is also possible to configure simultaneously multiple devices with the same configuration bitstream by using ganged SelectMAP configuration. In a ganged SelectMAP arrangement, the CS_B pins of two or more devices are connected together (or tied to ground), causing all devices to recognize data presented on the SelectMAP data pins.

All devices can be set for Slave SelectMAP mode if an external oscillator is available, or one device can be designated as the Master device, as illustrated in Figure 2-15.

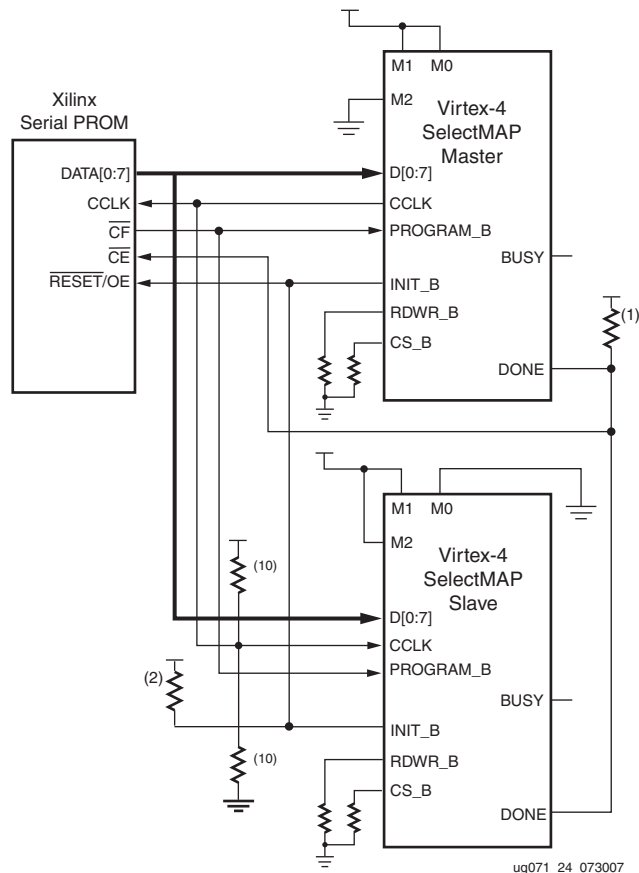


Figure 2-15: Ganged SelectMAP Configuration

Notes relevant to Figure 2-15:

1. The DONE pin is by default an open-drain output requiring an external pull-up resistor. A 330Ω pull-up resistor is recommended. In this arrangement, the active DONE driver must be disabled for both devices.
2. The INIT_B pin is a bidirectional, open-drain pin. An external pull-up resistor is required.
3. The BitGen startup clock setting must be set for CCLK for SelectMAP configuration.
4. The BUSY signal is not used for ganged SelectMAP configuration.
5. The PROM in this diagram represents one or more Xilinx Platform Flash PROMs. Multiple serial PROMs can be cascaded to increase the overall configurations storage capacity.

6. The .bit file must be reformatted into a PROM file before it can be stored on the serial PROM. Refer to the [“Generating PROM Files”](#) section.
7. On 17V00 devices, the reset polarity is programmable. Reset should be set for active Low when using a 17V00 device in this setup.
8. The Xilinx PROM must be set for parallel mode. This mode is **not** available for all devices.
9. When configuring a Virtex-4 device in SelectMAP mode from a Xilinx configuration PROM, the RDWR_B and CS_B signals can be tied Low (see [“SelectMAP Data Loading”](#)).
10. The CCLK net requires Thevenin parallel termination. See [“Board Layout for Configuration Clock \(CCLK\),”](#) page 34.

If one device is designated as the Master, the DONE pins of all devices must be connected and with the active DONE drivers disabled. An external pull-up resistor is required on the common DONE signal. Careful attention must be paid to signal integrity due to the increased fanout of the outputs from the PROM. Signal integrity simulation is recommended.

Readback is not possible if the CS_B signals are tied together, as all devices simultaneously attempt to drive the SelectMAP data signals.

SelectMAP Data Loading

The SelectMAP interface allows for either continuous or non-continuous data loading. Data loading is controlled by the CS_B, RDWR_B, CCLK, and BUSY signals.

CS_B

The Chip Select input (CS_B) enables the SelectMAP bus. When CS_B is High, the Virtex-4 device ignores the SelectMAP interface, neither registering any inputs nor driving any outputs. SelectMAP data and BUSY are placed in a high-Z state, and RDWR_B is ignored.

- ◆ If CS_B = 0, the device's SelectMAP interface is enabled.
- ◆ If CS_B = 1, the device's SelectMAP interface is disabled.

CS_B is used for arbitrating between two or more devices on a SelectMAP bus. The active device is selected by asserting its CS_B signal, while all other devices are deactivated by deasserting their CS_B signals. If used, the CS_B should be actively driven until the startup cycle completes, as signaled by the EOS.

If only one device is being configured through the SelectMAP, or if ganged SelectMAP configuration is used, the CS_B signal can be tied to ground, as illustrated in [Figure 2-12](#) and [Figure 2-15](#).

In Slave Serial mode, the CS_B pin can be left unconnected or can be pulled High in a noisy environment.

RDWR_B

RDWR_B is an input to the Virtex-4 device that controls whether the SelectMAP data pins are inputs or outputs:

- ◆ If RDWR_B = 0, the data pins are inputs (writing to the FPGA).
- ◆ If RDWR_B = 1, the data pins are outputs (reading from the FPGA).

For configuration, RDWR_B must be set for write control (RDWR_B = 0). For readback, RDWR_B must be set for read control (RDWR_B = 1) while CS_B is deasserted. (For details, refer to [Chapter 8](#))

Changing the value of RDWR_B while CS_B is asserted triggers an ABORT if the device gets a rising CCLK edge (see “[SelectMAP ABORT](#)”). If readback is not needed, RDWR_B can be tied to ground.

The RDWR_B signal is ignored while CS_B is deasserted. Read/write control of the data pins is asynchronous. The FPGA actively drives SelectMAP data without regard to CCLK if RDWR_B is set for read control (RDWR_B = 1, Readback) while CS_B is asserted.

CCLK

All activity on the SelectMAP data bus is synchronous to CCLK. When RDWR_B is set for write control (RDWR_B = 0, Configuration), the FPGA samples the SelectMAP data pins on rising CCLK edges. When RDWR_B is set for read control (RDWR_B = 1, Readback), the FPGA updates the SelectMAP data pins on rising CCLK edges.

In Slave SelectMAP mode, configuration can be paused by stopping CCLK (see “[Non-Continuous SelectMAP Data Loading](#)”).

BUSY

BUSY is an output from the FPGA indicating when the device is ready to drive readback data. Unlike earlier Virtex devices, Virtex-4 FPGAs never drive the BUSY signal during configuration, even at the maximum configuration frequency with an encrypted bitstream. The Virtex-4 device only drives BUSY during readback. (For details, refer to [Chapter 8](#))

- ◆ If BUSY = 0 during readback, the SelectMAP data pins are driving valid readback data.
- ◆ If BUSY = 1 during readback, the SelectMAP data pins are not driving valid readback data.

When CS_B is deasserted (CS_B = 1), the BUSY pin is placed in a high-Z state.

BUSY remains in a high-Z state until CS_B is asserted. If CS_B is asserted before power up (that is, if the pin is tied to ground), BUSY initially is in a high-Z state, then driven Low after POR finishes, usually a few milliseconds (T_{BUSY}), after V_{CCINT} reaches V_{POR} but before INIT_B goes High.

Unless readback is used, the BUSY pin can be left unconnected.

Continuous SelectMAP Data Loading

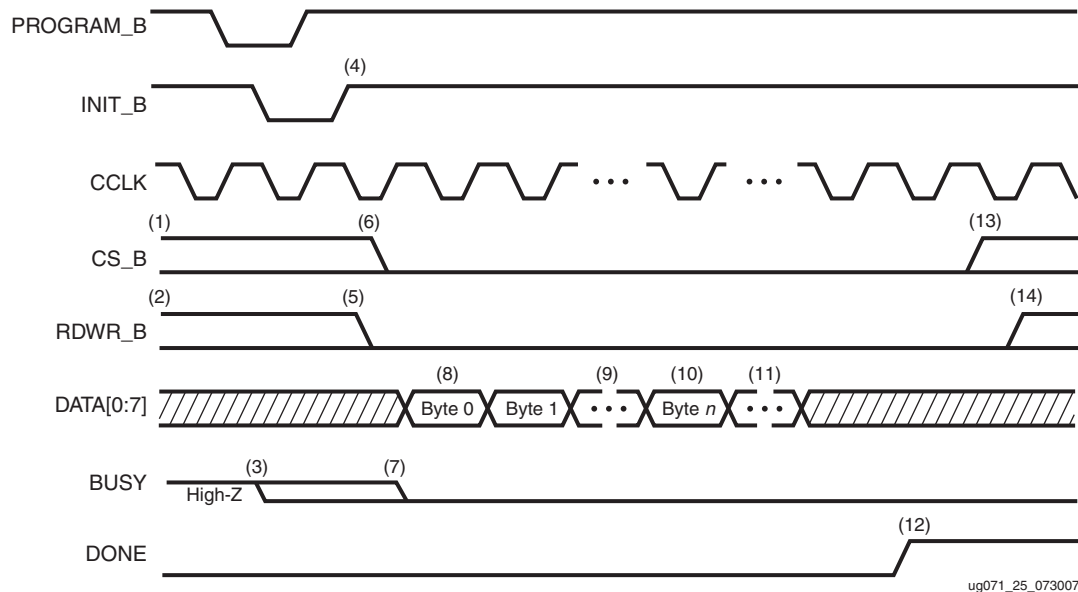
Continuous data loading is used in applications where the configuration controller can provide an uninterrupted stream of configuration data. After power-up, the configuration controller sets the RDWR_B signal for write control (RDWR_B = 0) and asserts the CS_B signal (CS_B = 0), causing the device to drive BUSY Low (this transition is asynchronous). RDWR_B must be driven Low before CS_B is asserted, otherwise an ABORT occurs (see “[SelectMAP ABORT](#)”).

On the next rising CCLK edge, the device begins sampling the SelectMAP data pins. Configuration begins after the synchronization word is clocked into the device.

After the configuration bitstream is loaded, the device enters the startup sequence. The device asserts its DONE signal (DONE=1) in the phase of the startup sequence that is specified by the bitstream (see “[Startup \(Step 8\)](#)” in [Chapter 1](#)). The configuration controller should continue sending CCLK pulses until after the startup sequence has

finished. (This can require several CCLK pulses after DONE goes High. See “Startup (Step 8)” in Chapter 1 for details).

After configuration, the CS_B and RDWR_B signals can be deasserted, or they can remain asserted. Because the SelectMAP port is inactive, toggling RDWR_B at this time does not cause an abort. Figure 2-16 summarizes the timing of SelectMAP configuration with continuous data loading.



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Figure 2-16: Continuous SelectMAP Data Loading

Notes relevant to Figure 2-16:

1. CS_B signal can be tied Low if there is only one device on the SelectMAP bus. If CS_B is not tied Low, it can be asserted at any time.
2. RDWR_B can be tied Low if readback is not needed. RDWR_B should not be toggled after CS_B has been asserted, because this triggers an ABORT. (See “SelectMAP ABORT”).
3. If CS_B is tied Low, BUSY is tristated and pulled up until INIT_B toggles High.
4. The MODE pins are sampled when INIT_B goes High.
5. RDWR_B should be asserted before CS_B to avoid causing an abort.
6. CS_B is asserted, enabling the SelectMAP interface.
7. BUSY remains in high-Z state until CS_B is asserted.
8. With 8-bit SelectMAP, the first byte is loaded on the first rising CCLK edge after CS_B is asserted.
9. The configuration bitstream is loaded one byte per rising CCLK edge.
10. After the last byte is loaded, the device enters the startup sequence.
11. The startup sequence lasts a minimum of eight CCLK cycles. See “Startup (Step 8)” in Chapter 1
12. The DONE pin goes High during the startup sequence. Additional CCLKs can be required to complete the startup sequence. (See “Startup (Step 8)” in Chapter 1).
13. After configuration has finished, the CS_B signal can be deasserted.
14. After the CS_B signal is deasserted, RDWR_B can be deasserted.

Non-Continuous SelectMAP Data Loading

Non-continuous data loading is used in applications where the configuration controller cannot provide an uninterrupted stream of configuration data—for example, if the controller pauses configuration while it fetches additional data.

Configuration can be paused in two ways: by deasserting the CS_B signal (Free-Running CCLK method, [Figure 2-17](#)) or by halting CCLK (Controlled CCLK method, [Figure 2-18](#)).

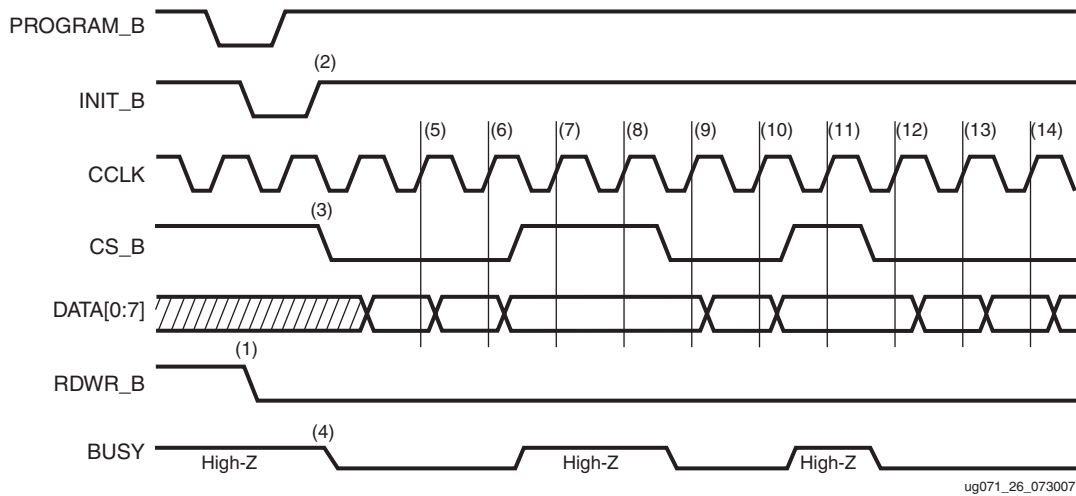


Figure 2-17: Non-Continuous SelectMAP Data Loading with Free-Running CCLK

Notes relevant to [Figure 2-17](#):

1. RDWR_B is driven Low by the user, setting the SelectMAP data pins as inputs for configuration. RDWR_B can be tied Low if readback is not needed. RDWR_B should not be toggled after CS_B has been asserted, as this triggers an ABORT. (See “[SelectMAP ABORT](#)”).
2. Device is ready for configuration after INIT_B toggles High.
3. The user asserts CS_B Low, enabling SelectMAP data bus. CS_B signal can be tied Low if there is only one device on the SelectMAP bus. If CS_B is not tied Low, it can be asserted at any time.
4. BUSY goes Low shortly after CS_B is asserted. If CS_B is tied Low, BUSY is driven Low before INIT_B toggles High.
5. Byte loaded on rising CCLK edge.
6. Byte loaded on rising CCLK edge.
7. The user deasserts CS_B; byte ignored.
8. The user deasserts CS_B; byte ignored.
9. Byte loaded on rising CCLK edge.
10. Byte loaded on rising CCLK edge.
11. The user deasserts CS_B; byte ignored.
12. Byte loaded on rising CCLK edge.
13. Byte loaded on rising CCLK edge.
14. Byte loaded on rising CCLK edge.

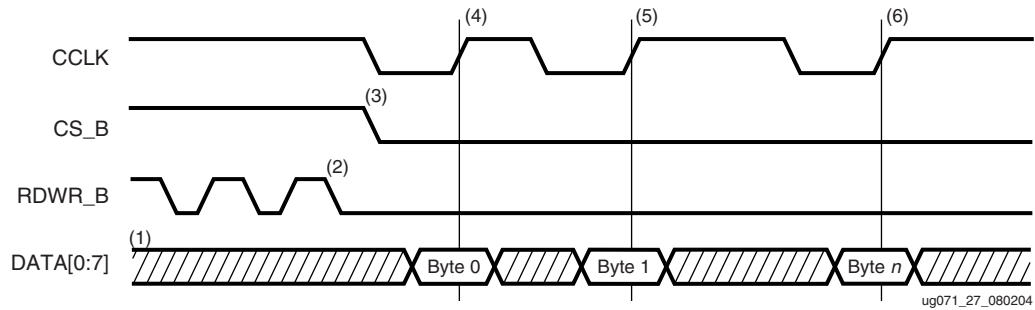


Figure 2-18: Non-Continuous SelectMAP Data Loading with Controlled CCLK

Notes relevant to [Figure 2-18](#):

1. SelectMAP data pins are in High-Z state while CS_B is deasserted.
2. RDWR_B has no effect on the device while CS_B is deasserted.
3. CS_B is asserted by the user. Device begins loading configuration data on rising CCLK edges.
4. Byte loaded on rising CCLK edge.
5. Byte loaded on rising CCLK edge.
6. Byte loaded on rising CCLK edge.

SelectMAP ABORT

An ABORT is an interruption in the SelectMAP configuration or readback sequence occurring when the state of RDWR_B changes while CS_B is asserted. During a configuration ABORT, an 8-bit status word is driven onto the SelectMAP data pins over the next four CCLK cycles. After the ABORT sequence finishes, the user can resynchronize the configuration logic and resume configuration. For applications that must de-assert RDWR_B between bytes, see Controlled CCLK method, [Figure 2-18](#).

Configuration Abort Sequence Description

An ABORT is signaled during configuration as follows:

1. The configuration sequence begins normally.
2. The user pulls the RDWR_B pin High while the device is selected (CS_B asserted Low).
3. BUSY goes High if CS_B remains asserted (Low). The FPGA drives the status word onto the data pins if RDWR_B remains set for read control (logic High).
4. The ABORT lasts for four clock cycles and Status is updated.

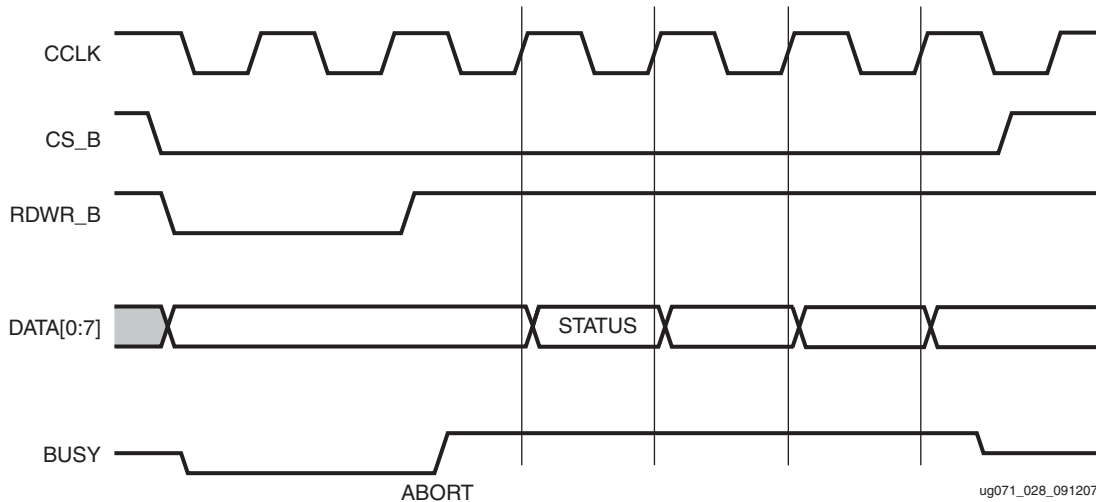


Figure 2-19: Configuration Abort Sequence

Readback Abort Sequence Description

An ABORT is signaled during readback as follows:

1. The readback sequence begins normally.
2. The user pulls the RDWR_B pin Low while the device is selected (CS_B asserted Low).
3. BUSY goes High if CS_B remains asserted (Low).
4. The ABORT ends when CS_B is deasserted.

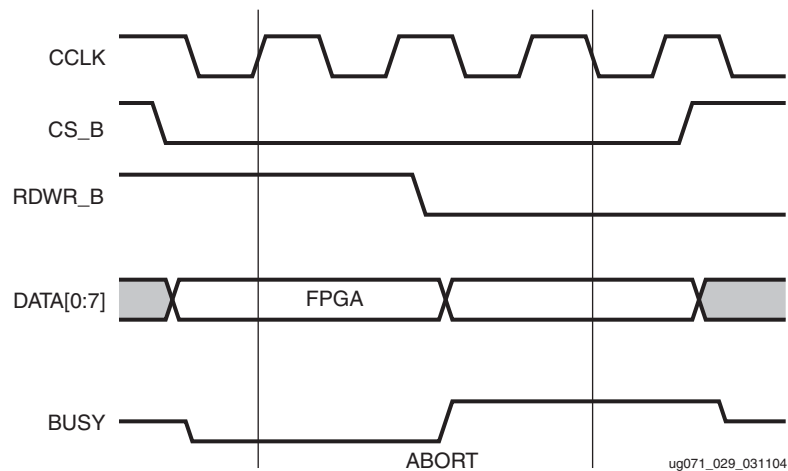


Figure 2-20: Readback Abort Sequence

ABORTs during readback are **not** followed by a status word, because the RDWR_B signal is set for write control (FPGA SelectMAP data pins are inputs).

ABORT Status Word

During the configuration ABORT sequence, the device drives a status word onto the SelectMAP data pins. The key for that status word is given in [Table 2-5](#).

Table 2-5: ABORT Status Word

Bit Number	Status Bit Name	Meaning
D7	CFGERR_B	Configuration error (active Low) 0 = A configuration error has occurred. 1 = No configuration error.
D6	DALIGN	Sync word received (active High) 0 = No sync word received. 1 = Sync word received by interface logic.
D5	RIP	Readback in progress (active High) 0 = No readback in progress. 1 = A readback is in progress.
D4	IN_ABORT_B	ABORT in progress (active Low) 0 = Abort is in progress. 1 = No abort in progress.
D3-D0	1111	

The ABORT sequence lasts four CCLK cycles. During those cycles, the status word changes to reflect data alignment and ABORT status. A typical sequence might be:

```
11011111 => DALIGN = 1,   IN_ABORT_B = 1
11001111 => DALIGN = 1,   IN_ABORT_B = 0
10001111 => DALIGN = 0,   IN_ABORT_B = 0
10011111 => DALIGN = 0,   IN_ABORT_B = 1
```

After the last cycle, the synchronization word can be reloaded to establish data alignment.

Resuming Configuration or Readback After an Abort

There are two ways to resume configuration or readback after an ABORT:

- The device can be resynchronized after the ABORT completes.
- The device can be reset by pulsing PROGRAM_B Low at any time.

To resynchronize the device, CS_B must be deasserted, then reasserted. The configuration synchronization word can then be sent. Configuration or readback can be resumed by sending the last configuration or readback packet that was in progress when the ABORT occurred. Alternatively, configuration or readback can be restarted from the beginning.

SelectMAP Reconfiguration

The term *reconfiguration* refers to reprogramming an FPGA after its DONE pin has gone High. Reconfiguration can be initiated by pulsing the PROGRAM_B pin (this method is identical to configuration), or by resynchronizing the device and sending configuration data. The latter method is only available in SelectMAP and JTAG configuration modes.

To reconfigure a device in SelectMAP mode without pulsing PROGRAM_B, the BitGen **persist** option must be set—otherwise, the SelectMAP data pins become user I/O after configuration. Reconfiguration must be enabled in BitGen. The SelectMAP port width is either 8 or 32 bits as selected by the mode pin settings.

Reconfiguration begins when the synchronization word is clocked into the SelectMAP port. The remainder of the operation is identical to configuration as described above.

SelectMAP Data Ordering

In many cases, SelectMAP configuration is driven by a user application residing on a microprocessor, CPLD, or in some cases another FPGA. In these applications, it is important to understand how the data ordering in the configuration data file corresponds to the data ordering expected by the FPGA.

In SelectMAP 8-bit mode, configuration data is loaded at one byte per CCLK, with the MSB of each byte presented to the D0 pin. This convention (D0 = MSB, D7 = LSB) **differs** from many other devices. This can be a source of confusion when designing custom configuration solutions. Table 2-6 shows how to load the hexadecimal value 0xABCD into the SelectMAP data bus.

Table 2-6: Bit Ordering for SelectMAP 8-bit Mode

CCLK Cycle	Hex Equivalent	D0	D1	D2	D3	D4	D5	D6	D7
1	0xAB	1	0	1	0	1	0	1	1
2	0xCD	1	1	0	0	1	1	0	1

Notes:

1. D[0:7] represent the SelectMAP 8-bit mode data pins.

Some applications can accommodate the non-conventional data ordering without difficulty. For other applications, it can be more convenient for the source configuration data file to be *byte-swapped*, meaning that the bits in each byte of the data stream are reversed. For these applications, the Xilinx PROM file generation software can generate byte-swapped PROM files (see “[Configuration Data Files](#)”).

In SelectMAP 32-bit mode, configuring the data order is straight D0 = LSB and D31 = MSB.

Configuration Data Files

Xilinx design tools can generate configuration data files in a number of different formats, as described in [Table 2-7](#). BitGen converts the post-PAR .ncd file into a configuration file, or bitstream. The bitstream contains commands to the FPGA configuration logic as well as configuration data. (For details on the bitstream format, refer to [Chapter 7](#))

PROMGen, the PROM file generator, converts one or more bitstream files into a PROM file. PROM files can be generated in a number of different file formats, and need not be used with a PROM. They can be stored anywhere and delivered by any means.

Table 2-7: Xilinx Configuration File Formats

File Extension	Byte Swapping ⁽¹⁾	Xilinx Software Tool ⁽²⁾	Description
.bit	Not byte-swapped	BitGen (generated by default)	Binary configuration data file containing header information that does not need to be downloaded to the FPGA. Used to program devices from iMPACT with a programming cable.
.rbt	Not byte-swapped	BitGen (generated if -b option is set)	ASCII equivalent of the .bit file containing a text header and ASCII 1s and 0s.
.bin	Not byte-swapped	BitGen (generated if -g binary:yes option is set)	Binary configuration data file with no header information. Similar to .bit file. Can be used for custom configuration solutions (microprocessors, etc.), or in some cases to program third-party PROMs.
.mcs .exo .tek	Byte-swapped	PROMGen or iMPACT	ASCII PROM file formats containing address and checksum information in addition to configuration data. Used mainly for device programmers and iMPACT.
.hex	Determined by user	PROMGen or iMPACT	ASCII PROM file format containing only configuration data. Used mainly in custom configuration solutions.

Notes:

1. Byte swapping is discussed in the [“Byte Swapping”](#) section.
2. For complete BitGen and PROMGen syntax, refer to the *Development System Reference Guide*.

Byte Swapping

The .mcs, .exo, and .tek PROM file formats are always byte-swapped. The .hex file format can be byte-swapped or not byte-swapped, depending on user options. The bitstream files (.bit, .rbt, .bin) are never byte-swapped.

The .hex file format contains only configuration data. The other PROM file formats include address and checksum information that should not be sent to the FPGA. The address and checksum information is used by some third-party device programmers, but is not programmed into the PROM.

Figure 2-17 shows how two bytes of data (0xABCD) are byte-swapped.

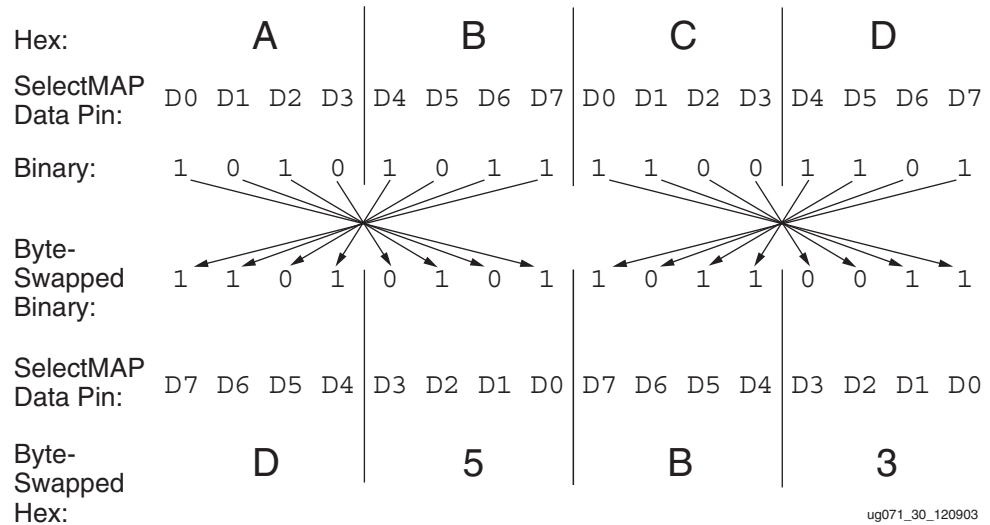


Figure 2-21: Byte Swapping Example

The MSB of each byte goes to the D0 pin regardless of the orientation of the data:

- In the byte-swapped version of the data, the bit that goes to D0 is the rightmost bit
- In the non-byte-swapped data, the bit that goes to D0 is the leftmost bit.

Whether or not data must be byte-swapped is entirely application-dependent, and is only applicable for SelectMAP configuration applications. Non-byte-swapped data should be used for Slave serial downloads.

Generating PROM Files

PROM files are generated from bitstream files with the PROMGen utility. Users can access PROMGen directly from the command line, or indirectly through the iMPACT File Generation Mode. For PROMGen syntax, refer to the *Development System Reference Guide*. For information on iMPACT, refer to the ISE® Software Documentation). PROM files serve to reformat bitstream files for PROM programming and combine bitstream files for serial daisy chains (see “PROM Files for Serial Daisy Chains”).

PROM Files for Serial Daisy Chains

Configuration data for serial daisy chains requires special formatting in that separate .bit files cannot simply be concatenated together to program the daisy chain. The special formatting is performed by PROMGen (or iMPACT) when generating a PROM file from multiple bitstreams. To generate the PROM file, specify multiple bitstreams using the PROMGen `-n` option or the iMPACT File Generation Wizard. Refer to software documentation for details.

PROMGen reformats the configuration bitstreams by nesting downstream configuration data into configuration packets for upstream devices. Attempting to program the chain by sending multiple bitstreams to the first device causes the first device to configure and then ignore the subsequent data.

PROM Files for SelectMAP Configuration

The `.mcs` file format is most commonly used to program Xilinx serial configuration PROMs that in turn programs a single FPGA in SelectMAP mode. For custom configuration solutions, the `.bin` and `.hex` files are the easiest PROM file formats to use due to their *raw* data format. In some cases, additional formatting is required; refer to [Xilinx Application Note XAPP502](#) for details.

If multiple configuration bitstreams for SelectMAP configuration resides on a single memory device, the bitstreams must not be combined into a serial daisy chain PROM file. Instead, the target memory device should be programmed with multiple `.bin` or `.hex` files. If a single PROM file with multiple, separate data streams is needed, one can be generated in iMPACT by targeting a *Parallel PROM*, then selecting the appropriate number of data streams. This can also be accomplished through the PROMGen command line. Refer to software documentation for details.

Boundary-Scan and JTAG Configuration

Introduction

Virtex®-4 devices support the new IEEE 1532 standard for In-System Configuration (ISC), based on the IEEE 1149.1 standard. The IEEE 1149.1 Test Access Port and Boundary-Scan Architecture is commonly referred to as JTAG. JTAG is an acronym for the Joint Test Action Group, the technical subcommittee initially responsible for developing the standard. This standard provides a means to ensure the integrity of individual components and the interconnections between them at the board level. With multi-layer PC boards becoming increasingly dense and more sophisticated surface mounting techniques in use, Boundary-Scan testing is becoming widely used as an important debugging standard.

Devices containing Boundary-Scan logic can send data out on I/O pins in order to test connections between devices at the board level. The circuitry can also be used to send signals internally to test the device-specific behavior. These tests are commonly used to detect opens and shorts at both the board and device level.

In addition to testing, Boundary-Scan offers the flexibility for a device to have its own set of user-defined instructions. The added common vendor-specific instructions, such as configure and verify, have increased the popularity of Boundary-Scan testing and functionality.

Boundary-Scan for Virtex-4 Devices Using IEEE Standard 1149.1

The Virtex-4 family is fully compliant with the IEEE Standard 1149.1 Test Access Port and Boundary-Scan Architecture. The architecture includes all mandatory elements defined in the IEEE 1149.1 Standard. These elements include the Test Access Port (TAP), the TAP controller, the instruction register, the instruction decoder, the Boundary-Scan register, and the bypass register. The Virtex-4 family also supports a 32-bit identification register and a configuration register in full compliance with the standard. Outlined in the following sections are the details of the JTAG architecture for Virtex-4 devices.

Test Access Port

The Virtex-4 TAP contains four mandatory dedicated pins as specified by the protocol given in [Table 3-1](#) and illustrated in [Figure 3-1](#), a typical JTAG architecture. Three input pins and one output pin control the 1149.1 Boundary-Scan TAP controller. Optional control pins, such as TRST (Test Reset) and enable pins might be found on devices from other manufacturers. It is important to be aware of these optional signals when interfacing Xilinx® devices with parts from different vendors, because they might need to be driven.

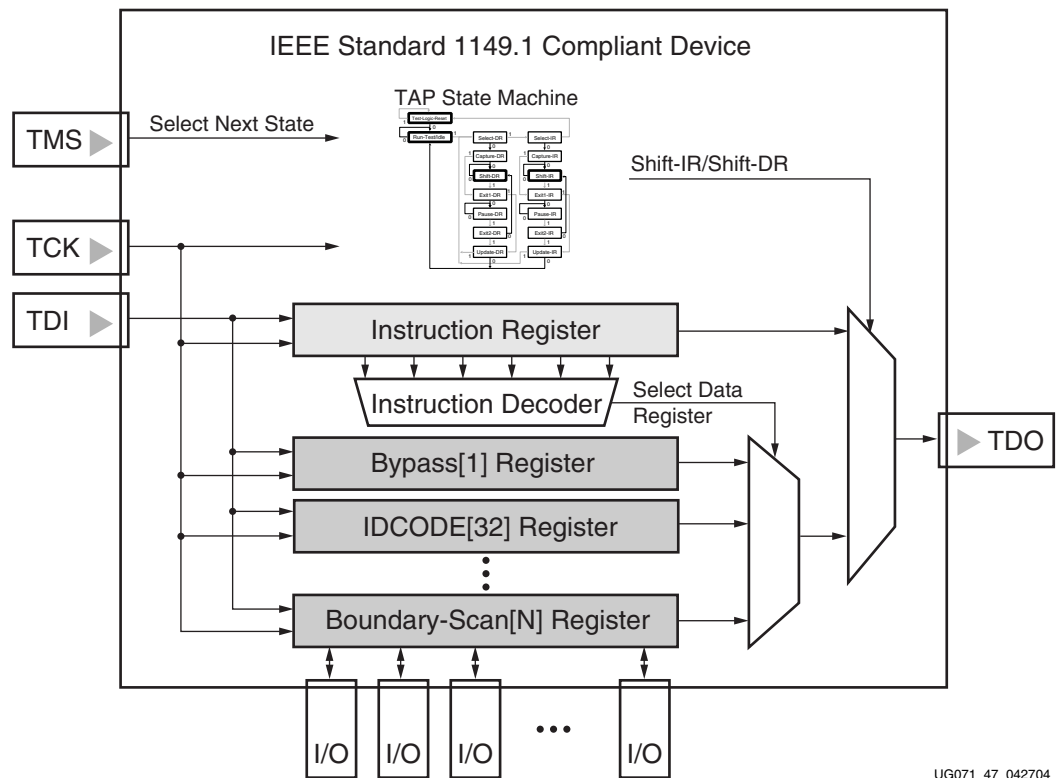
The TAP controller is a state machine (16-states) shown in [Figure 3-2](#). The four mandatory TAP pins are outlined below.

Table 3-1: Virtex-4 TAP Controller Pins

Pin	Description
TDI	Test Data In. This pin is the serial input to all JTAG instruction and data registers. The state of the TAP controller and the current instruction determine the register that is fed by the TDI pin for a specific operation. TDI has an internal resistive pull-up to provide a logic High to the system if the pin is not driven. TDI is applied into the JTAG registers on the rising edge of TCK.
TDO	Test Data Out. This pin is the serial output for all JTAG instruction and data registers. The state of the TAP controller and the current instruction determine the register (instruction or data) that feeds TDO for a specific operation. TDO changes state on the falling edge of TCK and is only active during the shifting of instructions or data through the device. TDO is an active driver output.
TMS	Test Mode Select. This pin determines the sequence of states through the TAP controller on the rising edge of TCK. TMS has an internal resistive pull-up to provide a logic High if the pin is not driven.
TCK	Test Clock. This pin is the JTAG Test Clock. TCK sequences the TAP controller and the JTAG registers in the Virtex-4 devices.

Notes:

- As specified by the IEEE Standard, the TMS and TDI pins both have internal pull-up resistors. These internal pull-up resistors of 50-150 k Ω are active, regardless of the mode selected.



UG071_47_042704

Figure 3-1: Typical JTAG Architecture

For JTAG configuration mode, JTAG inputs use the V_{CCO_CFG} supply.

TAP Controller

Figure 3-2 diagrams a 16-state finite state machine. The four TAP pins control how data is scanned into the various registers. The state of the TMS pin at the rising edge of TCK determines the sequence of state transitions. There are two main sequences, one for shifting data into the data register and the other for shifting an instruction into the instruction register.

A transition between the states only occurs on the rising edge of TCK, and each state has a different name. The two vertical columns with seven states each represent the Instruction Path and the Datapath. The data registers operate in the states whose names end with "DR," and the instruction register operates in the states whose names end in "IR." The states are otherwise identical.

The operation of each state is described below.

Test-Logic-Reset:

All test logic is disabled in this controller state, enabling the normal operation of the IC. The TAP controller state machine is designed so that regardless of the initial state of the controller, the Test-Logic-Reset state can be entered by holding TMS High and pulsing TCK five times. Consequently, the Test Reset (TRST) pin is optional.

Run-Test-Idle:

In this controller state, the test logic in the IC is active only if certain instructions are present. For example, if an instruction activates the self test, then it is executed when the controller enters this state. The test logic in the IC is idle otherwise.

Select-DR-Scan:

This controller state controls whether to enter the Datapath or the Select-IR-Scan state.

Select-IR-Scan:

This controller state controls whether or not to enter the Instruction Path. The controller can return to the Test-Logic-Reset state otherwise.

Capture-IR:

In this controller state, the shift register bank in the Instruction Register parallel loads a pattern of fixed values on the rising edge of TCK. The last two significant bits must always be 01.

Shift-IR:

In this controller state, the instruction register gets connected between TDI and TDO, and the captured pattern gets shifted on each rising edge of TCK. The instruction available on the TDI pin is also shifted in to the instruction register. If the Shift-IR state is entered after a Pause-IR state is used, then the first bit shifted is always 0. This does not occur if the Pause-IR state is not used prior to a Shift-IR state, which is not fully compliant with the JTAG 1149.1 specification.

Exit1-IR:

This controller state controls whether to enter the Pause-IR state or Update-IR state.

Pause-IR:

This state allows the shifting of the instruction register to be temporarily halted.

Exit2-DR:

This controller state controls whether to enter either the Shift-IR state or Update-IR state.

Update-IR:

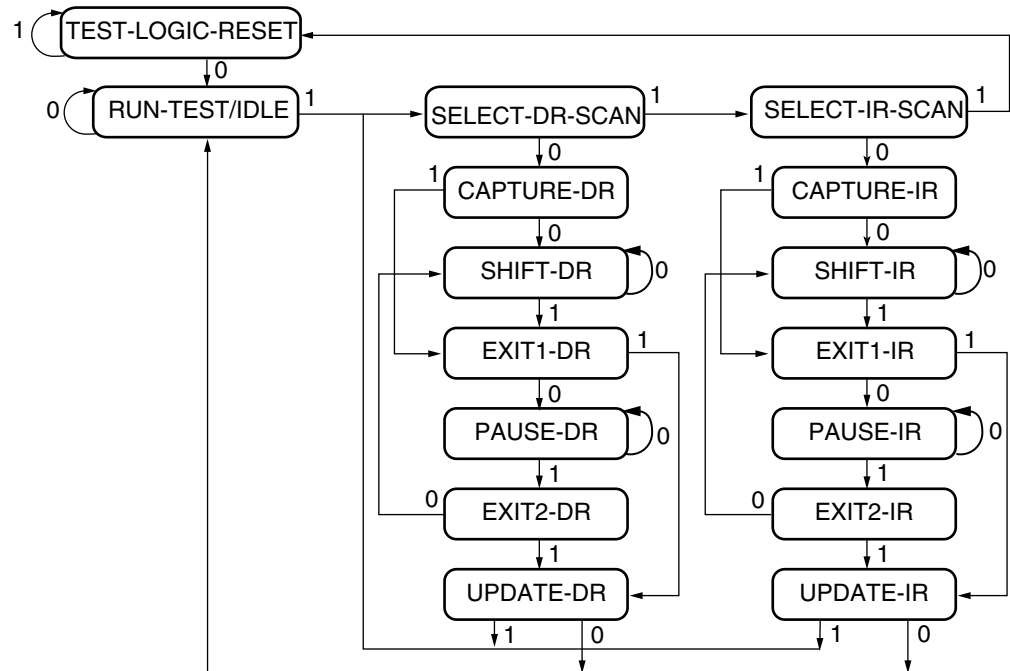
In this controller state, the instruction in the instruction register is latched to the latch bank of the Instruction Register on every falling edge of TCK. This instruction becomes the current instruction after it is latched.

Capture-DR:

In this controller state, the data is parallel-loaded into the data registers selected by the current instruction on the rising edge of TCK.

Shift-Dr, Exit1-DR, Pause-DR, Exit2-DR, and Update-DR:

These controller states are similar to the Shift-IR, Exit1-IR, Pause-IR, Exit2-IR, and Update-IR states in the Instruction path.



NOTE: The value shown adjacent to each state transition in this figure represents the signal present at TMS at the time of a rising edge at TCK.

ug071_34_121703

Figure 3-2: Boundary-Scan Tap Controller

Virtex-4 devices support the mandatory IEEE 1149.1 commands, as well as several Xilinx vendor-specific commands. The EXTEST, INTEST, SAMPLE/PRELOAD, BYPASS, IDCODE, USERCODE, and HIGHZ instructions are all included. The TAP also supports internal user-defined registers (USER1, USER2, USER3, and USER4) and configuration/readback of the device.

The Virtex-4 Boundary-Scan operations are independent of mode selection. The Boundary-Scan mode in Virtex-4 devices overrides other mode selections. For this reason, Boundary-Scan instructions using the Boundary-Scan register (SAMPLE/PRELOAD, INTEST, and EXTEST) must not be performed during configuration. All instructions except the user-defined instructions are available before a Virtex-4 device is configured. After configuration, all instructions are available.

JSTART and JSHUTDOWN are instructions specific to the Virtex-4 architecture and configuration flow.

For details on the standard Boundary-Scan instructions EXTEST, INTEST, and BYPASS, refer to the IEEE Standard.

Boundary-Scan Architecture

Virtex-4 device registers include all registers required by the IEEE 1149.1 Standard. In addition to the standard registers, the family contains optional registers for simplified testing and verification (Table 3-2).

Table 3-2: Virtex-4 JTAG Registers

Register Name	Register Length	Description
Boundary-Scan Register	3 bits per I/O	Controls and observes input, output, and output enable.
Instruction Register	10 bits	Holds current instruction OPCODE and captures internal device status.
Bypass Register	1 bit	Device bypass.
Identification Register	32 bits	Captures device ID.
JTAG Configuration Register	32 bits	Allows access to the configuration bus when using the CFG_IN or CFG_OUT instructions.
USERCODE Register	32 bits	Captures user-programmable code.
User-Defined Registers (USER1, USER2, USER3, and USER4)	Design-specific	Design-specific.

Boundary-Scan Register

The test primary data register is the Boundary-Scan register. Boundary-Scan operation is independent of individual IOB configurations. Each IOB, bonded or un-bonded, starts as bidirectional with 3-state control. Later, it can be configured to be an input, output, or 3-state only. Therefore, three data register bits are provided per IOB (Figure 3-3).

When conducting a data register (DR) operation, the DR captures data in a parallel fashion during the CAPTURE-DR state. The data is then shifted out and replaced by new data during the SHIFT-DR state. For each bit of the DR, an update latch is used to hold the input data stable during the next SHIFT-DR state. The data is then latched during the UPDATE-DR state when TCK is Low. The internal DR CLK follows TCK when the TAP controller is in the CAPTURE-DR state and SHIFT-DR state, however, it can toggle in other states.

The update latch is opened each time the TAP controller enters the UPDATE-DR state. Care is necessary when exercising an INTEST or EXTEST to ensure that the proper data has been latched before exercising the command. This is typically accomplished by using the SAMPLE/PRELOAD instruction.

Consider internal pull-up and pull-down resistors when developing test vectors for testing opens and shorts. The Boundary-Scan mode determines whether the IOB has a pull-up resistor. Figure 3-3 is a representation of Virtex-4 Boundary-Scan architecture.

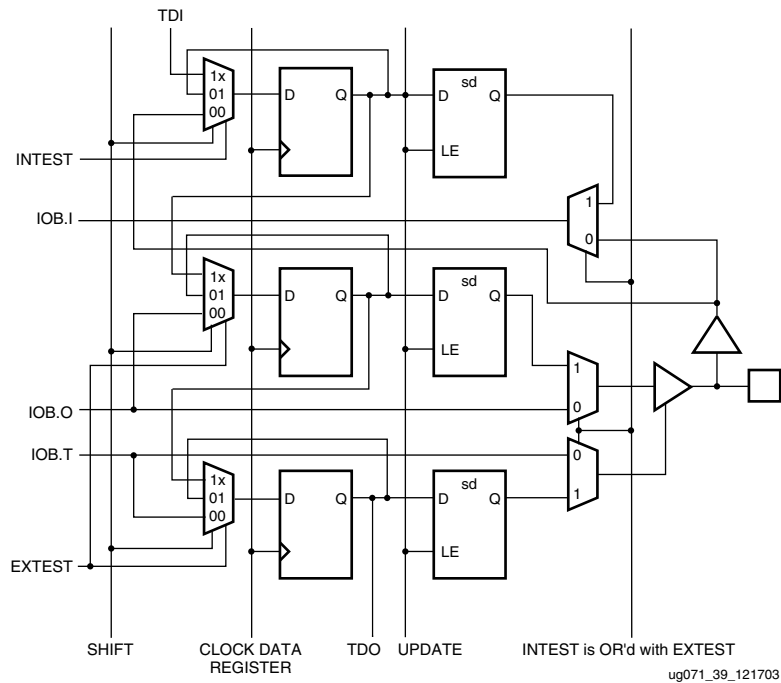


Figure 3-3: Virtex-4 Family Boundary-Scan Logic

Bit Sequence Boundary-Scan Register

The order of each non-TAP IOB is described in this section. The input is first, then the output, and finally the 3-state IOB control. The 3-state IOB control is closest to the TDO. The input-only pins contribute only the input bit to the Boundary-Scan I/O data register. The bit sequence of the device is obtainable from the *Boundary-Scan Description Language Files* (BSDL files) for the Virtex-4 family. (These files can be obtained from the Xilinx software download area.) The bit sequence always has the same bit order and the same number of bits, and is independent of the design.

Instruction Register

The Instruction Register (IR) for the Virtex-4 device is connected between TDI and TDO during an instruction scan sequence. In preparation for an instruction scan sequence, the instruction register is parallel-loaded with a fixed instruction capture pattern. This pattern is shifted out onto TDO (LSB first), while an instruction is shifted into the instruction register from TDI.

To determine the operation to be invoked, an OPCODE necessary for the Virtex-4 Boundary-Scan instruction set is loaded into the Instruction Register. The length of the IR is device size-specific. The IR is 10 bits wide for all Virtex-4 LX, SX, and single-processor FX devices. FX devices with two processors have a 14-bit IR. The bottom six bits of the instruction codes are the same for all device sizes to support the new IEEE Standard 1532 for In-System Configurable (ISC) devices. The additional IR bits for each instruction are 1s. [Table 3-3](#) lists the available instructions for Virtex-4 devices. [Figure 3-4](#) shows the instruction capture values loaded into the IR as part of an instruction scan sequence.

Table 3-3: Virtex-4 Boundary-Scan Instructions

Boundary-Scan Command	Binary Code (9:0)	Description
EXTEST	1111000000	Enables Boundary-Scan EXTEST operation
SAMPLE	1111000001	Enables Boundary-Scan SAMPLE operation
USER1	1111000010	Access user-defined register 1
USER2	1111000011	Access user-defined register 2
USER3	1111100010	Access user-defined register 3
USER4	1111100011	Access user-defined register 4
CFG_OUT	1111000100	Access the configuration bus for readback
CFG_IN	1111000101	Access the configuration bus for configuration
INTEST	1111000111	Enables Boundary-Scan INTEST operation
USERCODE	1111001000	Enables shifting out user code
IDCODE	1111001001	Enables shifting out of ID code
HIGHZ	1111001010	3-state output pins while enabling Bypass Register
JPROGRAM	1111001011	Equivalent to and has the same affect as PROGRAM
JSTART	1111001100	Clocks the start-up sequence when StartClk is TCK
JSHUTDOWN	1111001101	Clocks the shutdown sequence
ISC_ENABLE	1111010000	Marks the beginning of ISC configuration. Full shutdown is executed
ISC_PROGRAM	1111010001	Enables in-system programming
ISC_PROGRAM_SECURITY	1111010010	Change security status from secure to non-secure mode and vice versa
ISC_ADDRESS_SHIFT	1111010011	For programming, key address is shifted first, before the key
ISC_NOOP	1111010100	No operation
ISC_READ	1111010101	Used to read back BBR
ISC_DISABLE	1111010111	Completes ISC configuration. Startup sequence is executed
BYPASS	1111111111	Enables BYPASS
RESERVED	All other codes	Xilinx reserved instructions

Notes:

- For FX devices with two processors, the instruction codes are MSB extended with 1s. For example, the CFG_IN instruction is 1111 1111 000101.

TDI →	IR[9:6]	IR[5]	IR[4]	IR[3]	IR[2]	IR[1:0]	→ TDO
	Reserved	DONE	INIT	ISC_ENABLED	ISC_DONE	0 1	

Figure 3-4: Virtex-4 Instruction Capture Values Loaded into IR as Part of an Instruction Scan Sequence

BYPASS Register

The other standard data register is the single flip-flop BYPASS register. It passes data serially from the TDI pin to the TDO pin during a bypass instruction. This register is initialized to zero when the TAP controller is in the CAPTURE-DR state.

Identification Register

Virtex devices have a 32-bit identification register called the IDCODE register. The IDCODE is based on the IEEE 1149.1 standard, and is a fixed, vendor-assigned value that is used to identify electrically the manufacturer and the type of device that is being addressed. This register allows easy identification of the part being tested or programmed by Boundary-Scan, and it can be shifted out for examination by using the IDCODE instruction.

The Virtex-4 JTAG ID Code register has the following format:

```
vvvv:ffffff:aaaaaaaa:cccccccc1
```

where

v = the revision code

f = the 7-bit family code (0001011 for Virtex-4 LX family, 0010000 for Virtex-4 SX family, 0001111 for Virtex-4 FX family)

a = the number of array rows plus columns in the part, expressed in 9 bits:

XC4VLX15 columns + rows	=	64 + 24	=	88	=	0x058
XC4VLX25 columns + rows	=	96 + 28	=	124	=	0x07C
XC4VLX40 columns + rows	=	128 + 36	=	164	=	0x0A4
XC4VLX60 columns + rows	=	128 + 52	=	180	=	0x0B4
XC4VLX80 columns + rows	=	160 + 56	=	216	=	0x0D8
XC4VLX100 columns + rows	=	192 + 64	=	256	=	0x100
XC4VLX160 columns + rows	=	192 + 88	=	280	=	0x118
XC4VLX200 columns + rows	=	192 + 116	=	308	=	0x134
XC4VSX25 columns + rows	=	64 + 40	=	104	=	0x068
XC4VSX35 columns + rows	=	96 + 40	=	136	=	0x088
XC4VSX55 columns + rows	=	128 + 48	=	176	=	0x0B0
XC4VFX12 columns + rows	=	64 + 24	=	88	=	0x058
XC4VFX20 columns + rows	=	64 + 36	=	100	=	0x064
XC4VFX40 columns + rows	=	96 + 52	=	148	=	0x094 ⁽¹⁾
XC4VFX60 columns + rows	=	128 + 52	=	180	=	0x0B4
XC4VFX100 columns + rows	=	160 + 68	=	228	=	0x0E4
XC4VFX140 columns + rows	=	192 + 84	=	276	=	0x114

Notes:

1. The actual array size is 148. The JTAG ID code reflects an array size of $96 + 44 = 140$ (0x08C).

c = the company code.

The last bit of the IDCODE is always 1 (based on JTAG IEEE 1149.1). The last three hex digits appear as 0x093. IDCODEs assigned to Virtex-4 FPGAs are shown in [Table 3-4](#). Note the similarity to the device ID codes in [Table 1-6](#).

Table 3-4: Virtex-4 Device JTAG ID Codes

Device	IDCODE	Device	IDCODE	Device	IDCODE
XC4VLX15	01658093			XC4VFX12	01E58093
XC4VLX25	0167C093	XC4VSX25	02068093	XC4VFX20	01E64093
XC4VLX40	016A4093	XC4VSX35	02088093	XC4VFX40	01E8C093 ⁽¹⁾
XC4VLX60	016B4093	XC4VSX55	020B0093	XC4VFX60	01EB4093
XC4VLX80	016D8093				
XC4VLX100	01700093			XC4VFX100	01EE4093
XC4VLX160	01718093			XC4VFX140	01F14093
XC4VLX200	01734093				

Notes:

- Does not reflect the actual device array size.

Examples of how the binary digits translate into hex codes appear in [Table 3-5](#).

Table 3-5: Example JTAG IDCODE Concatenation

		vvvv	ffff	fffa	aaaa	aaaa	cccc	cccc	ccc1
XC4VLX15	bin	<vvvv>	0001	0110	0101	1000	0000	1001	0011
	hex	<v>	1	6	5	8	0	9	3
XC4VLX25	bin	<vvvv>	0001	0110	0111	1100	0000	1001	0011
	hex	<v>	1	6	7	C	0	9	3
XC4VLX40	bin	<vvvv>	0001	0110	1010	0100	0000	1001	0011
	hex	<v>	1	6	A	4	0	9	3
XC4VLX60	bin	<vvvv>	0000	0110	1011	0100	0000	1001	0011
	hex	<v>	1	6	B	4	0	9	3
XC4VLX80	bin	<vvvv>	0001	0110	1101	1000	0000	1001	0011
	hex	<v>	1	6	D	8	0	9	3
XC4VLX100	bin	<vvvv>	0001	0111	0000	0000	0000	1001	0011
	hex	<v>	1	7	0	0	0	9	3
XC4VLX160	bin	<vvvv>	0001	0111	0001	1000	0000	1001	0011
	hex	<v>	1	7	1	8	0	9	3
XC4VLX200	bin	<vvvv>	0001	0111	0011	0100	0000	1001	0011
	hex	<v>	1	7	3	4	0	9	3
XC4VSX25	bin	<vvvv>	0010	0000	0110	1000	0000	1001	0011
	hex	<v>	2	0	6	8	0	9	3
XC4VSX35	bin	<vvvv>	0010	0000	1000	1000	0000	1001	0011
	hex	<v>	2	0	8	8	0	9	3
XC4VSX55	bin	<vvvv>	0010	0000	1011	0000	0000	1001	0011
	hex	<v>	2	0	B	0	0	9	3
XC4VFX12	bin	<vvvv>	0001	1110	0101	1000	0000	1001	0011
	hex	<v>	1	E	5	8	0	9	3
XC4VFX20	bin	<vvvv>	0001	1110	0110	0100	0000	1001	0011

Table 3-5: Example JTAG IDCODE Concatenation (Continued)

		vvvv	ffff	fffa	aaaa	aaaa	cccc	cccc	ccc1
	hex	<v>	1	E	6	4	0	9	3
XC4VFX40 ⁽¹⁾	bin	<vvvv>	0001	1110	1001	0100	0000	1001	0011
	hex	<v>	1	E	8	C	0	9	3
XC4VFX60	bin	<vvvv>	0001	1110	1011	0100	0000	1001	0011
	hex	<v>	1	E	B	4	0	9	3
XC4VFX100	bin	<vvvv>	0001	1110	1110	0100	0000	1001	0011
	hex	<v>	1	E	E	4	0	9	3
XC4VFX140	bin	<vvvv>	0001	1111	0001	0100	0000	1001	0011
	hex	<v>	1	F	1	4	0	9	3

Notes:

1. Does not reflect the actual device array size.

Configuration Register (Boundary-Scan)

The configuration register is a 64-bit register. This register allows access to the configuration bus and readback operations.

USERCODE Register

The USERCODE instruction is supported in the Virtex-4 family. This register allows a user to specify a design-specific identification code. The USERCODE can be programmed into the device and can be read back for verification later. The USERCODE is embedded into the bitstream during bitstream generation (BitGen **-g** UserID option) and is valid only after configuration. If the device is blank or the USERCODE was not programmed, the USERCODE register contains 0xFFFFFFFF.

USER1, USER2, USER3, and USER4 Registers

The USER1, USER2, USER3, and USER4 registers are only available after configuration. These four registers must be defined by the user within the design. These registers can be accessed after they are defined by the TAP pins.

The BSCAN_VIRTEX4 library macro is required when creating these registers. This symbol is only required for driving internal scan chains (USER1, USER2, USER3, and USER4).

A common input pin (TDI) and shared output pins represent the state of the TAP controller (RESET, SHIFT, and UPDATE). Unlike earlier FPGA families that required the BSCAN macro to dedicate TAP pins for Boundary-Scan, Virtex-4 TAP pins are dedicated and do not require the BSCAN_VIRTEX4 macro for normal Boundary-Scan instructions or operations. For HDL, the BSCAN_VIRTEX4 macro must be instantiated in the design.

Using Boundary-Scan in Virtex-4 Devices

Characterization data for some of the most commonly requested timing parameters shown in Figure 3-5 are listed in the *Virtex-4 FPGA Data Sheet* in the Configuration Switching Characteristics table.

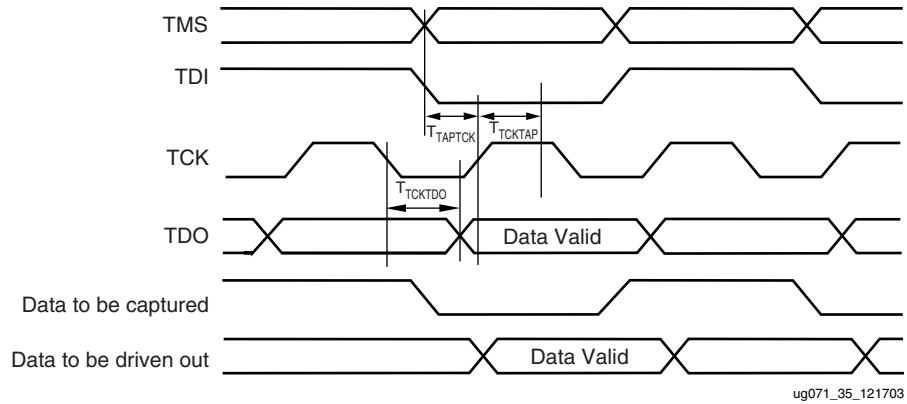


Figure 3-5: Virtex-4 Boundary-Scan Port Timing Waveforms

For further information on the startup sequence, bitstream, and internal configuration registers referenced here, refer to “Setup (Steps 1-3)” in Chapter 1.

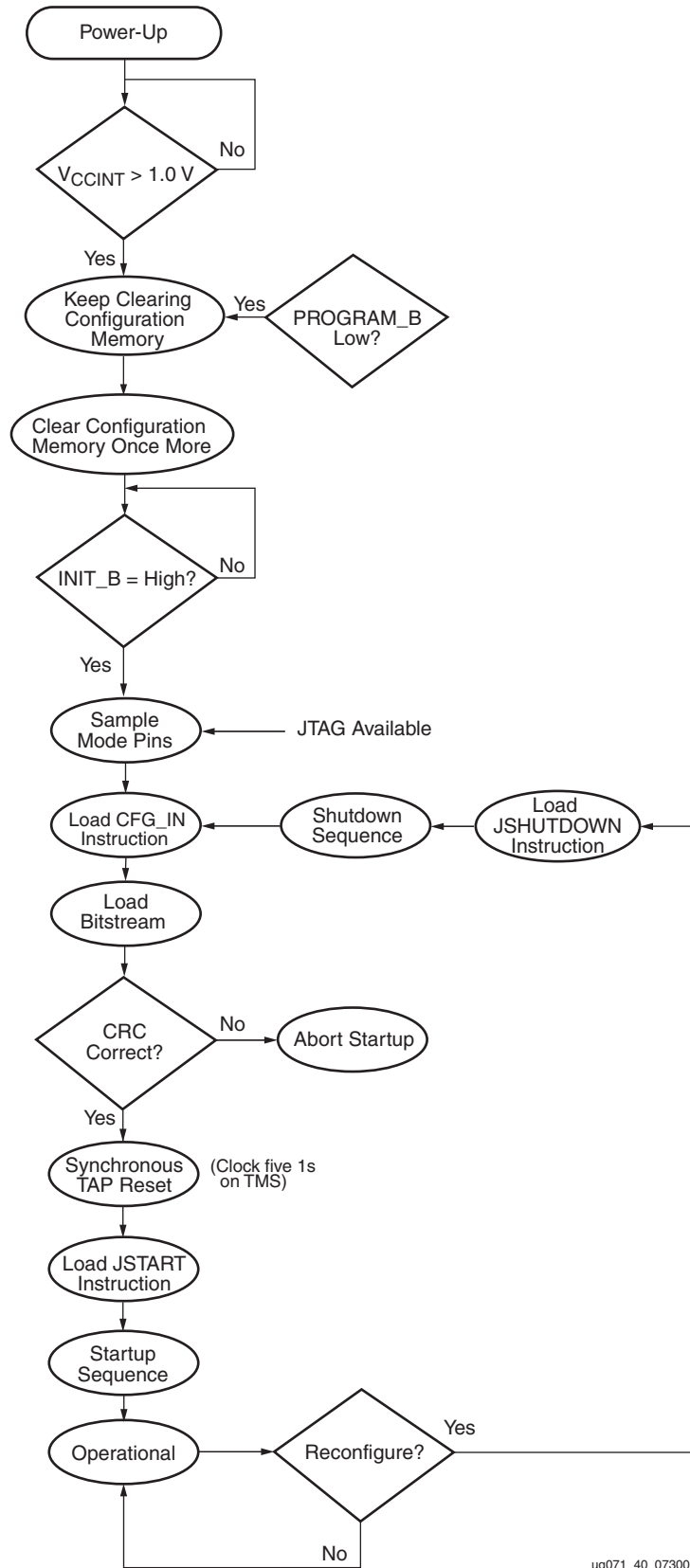
Configuring Through Boundary-Scan

One of the most common Boundary-Scan vendor-specific instructions is the configure instruction. An individual Virtex-4 device can be configured through JTAG on power-up. If the Virtex-4 device is configured on power-up, it is advisable to tie the mode pins to the Boundary-Scan configuration mode settings: 101 (M2 = 1, M1 = 0, M0 = 1).

The configuration flow for Virtex-4 device configuration with JTAG is shown in Figure 3-6. The sections that follow describe how the Virtex-4 device can be configured as a single device through the Boundary-Scan or as part of a multiple-device scan chain.

A configured device can be reconfigured by toggling the TAP and entering a CFG_IN instruction after pulsing the PROGRAM pin or issuing the shut-down sequence. (Refer to Figure 3-6.)

Designers who wish to implement the Virtex-4 JTAG configuration algorithm are encouraged to use the SVF-based flow provided in [Xilinx Application Note XAPP058](http://www.xilinx.com).



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Figure 3-6: Device Configuration Flow Diagram

Single Device Configuration

Table 3-6 describes the TAP controller commands required to configure a Virtex-4 device. Refer to Figure 3-2 for TAP controller states. These TAP controller commands are issued automatically if configuring the part with the iMPACT software.

Table 3-6: Single Device Configuration Sequence

TAP Controller Step and Description		Set & Hold		# of Clocks
		TDI	TMS	TCK
1.	On power-up, place a logic 1 on the TMS, and clock the TCK five times. This ensures starting in the TLR (Test-Logic-Reset) state.	X	1	5
2.	Move into the RTI state.	X	0	1
3.	Move into the SELECT-IR state.	X	1	2
4.	Enter the SHIFT-IR state.	X	0	2
5.	Start loading the CFG_IN instruction, LSB first:	111000101	0	9
6.	Load the MSB of CFG_IN instruction when exiting SHIFT-IR, as defined in the IEEE standard.	1	1	1
7.	Enter the SELECT-DR state.	X	1	2
8.	Enter the SHIFT-DR state.	X	0	2
9.	Shift in the Virtex-4 bitstream. Bit _n (MSB) is the first bit in the bitstream ⁽¹⁾ .	bit ₁ ... bit _n	0	(bits in bitstream) - 1
10.	Shift in the last bit of the bitstream. Bit ₀ (LSB) shifts on the transition to EXIT1-DR.	bit ₀	1	1
11.	Enter UPDATE-DR state.	X	1	1
12.	Reset TAP by clocking five 1s on TMS	X	1	5
13.	Enter the SELECT-IR state.	X	1	2
14.	Move to the SHIFT-IR state.	X	0	2
15.	Start loading the JSTART instruction. The JSTART instruction initializes the startup sequence.	111001100	0	9
16.	Load the last bit of the JSTART instruction.	1	1	1
17.	Move to the UPDATE-IR state.	X	1	1
18.	Move to the RTI state and clock the startup sequence by applying a minimum of 12 clock cycles to the TCK.	X	0	12
19.	Move to the TLR state. The device is now functional.	X	1	3

Notes:

1. In the Configuration Register, data is shifted in from the right (TDI) to the left (TDO), MSB first. (Shifts into the Configuration Register are different from shifts into the other registers in that they are MSB first.)

Multiple Device Configuration

It is possible to configure multiple Virtex-4 devices in a chain. (See [Figure 3-7](#).) The devices in the JTAG chain are configured one at a time. The multiple device configuration steps can be applied to any size chain.

Refer to the state diagram in [Figure 3-2](#) for the following TAP controller steps:

1. On power-up, place a logic 1 on the TMS and clock the TCK five times. This ensures starting in the TLR (Test-Logic-Reset) state.
2. Load the CFG_IN instruction into the target device (and BYPASS in all other devices). Go through the RTI state (RUN-TEST/IDLE).
3. Load in the configuration bitstream per [step 7](#) through [step 11](#) in [Table 3-6](#).
4. Repeat [step 2](#) and [step 3](#) for each device.
5. Reset all TAPs by clocking five 1s on TMS.
6. Load the JSTART command into all devices.
7. Go to the RTI state and clock TCK 12 times.

All devices are active at this point.

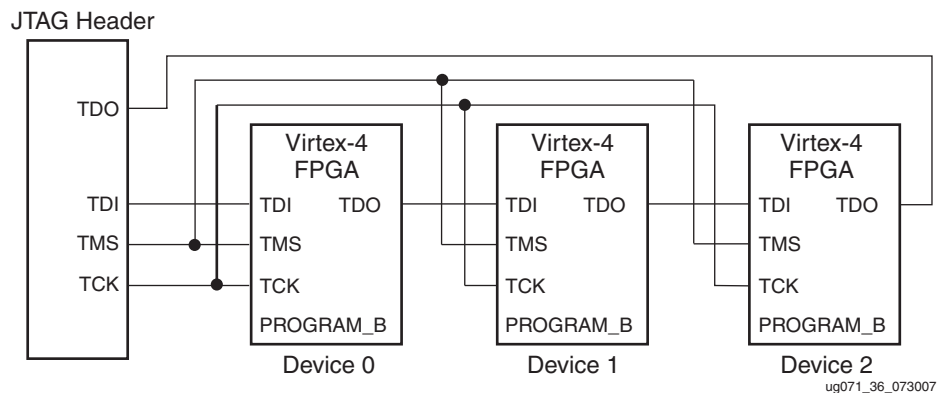


Figure 3-7: Boundary-Scan Chain of Devices

Reconfiguring through Boundary-Scan

The ability of Virtex-4 devices to perform partial reconfiguration is the reason that the configuration memory is not cleared when reconfiguring the device. When reconfiguring a chain of devices, refer to [step 3](#) in [Table 3-6](#). There are two methods to reconfigure Virtex-4 devices without possible internal contention. The first method is to pulse the PROGRAM_B pin, resetting the internal configuration memory. The alternate method is to perform a shutdown sequence, placing the device in a safe state. The following shutdown sequence includes using internal registers. (For details on internal registers, refer to [Chapter 8](#))

1. Load the CFG_IN instruction.
2. In the SHIFT-DR state, load the synchronization word followed by the Reset CRC Register (RCRC) command.

```

1111 1111 1111 1111 1111 1111 1111 1111 → Dummy word
1010 1010 1001 1001 0101 0101 0110 0110 → Synchronization word
0011 0000 0000 0000 1000 0000 0000 0001 → Header: Write to CMD register
0000 0000 0000 0000 0000 0000 0000 0111 → RCRC command
0000 0000 0000 0000 0000 0000 0000 0000 → flush pipe

```

3. Load JSHUTDOWN.
4. Go to the RTI state and clock TCK at least 12 times to clock the shutdown sequence.
5. Proceed to the SHIFT-IR state and load the CFG_IN instruction again.
6. Go to the SHIFT-DR state and load the configuration bits. Make sure the configuration bits contain the AGHIGH command, asserting the global signal GHIGH_B. This prevents contention while writing configuration data.


```
0011 0000 0000 0000 1000 0000 0000 0001→ Header: Write to CMD
0000 0000 0000 0000 0000 0000 0000 1000→ AGHIGH command asserts GHIGH_B
0000 0000 0000 0000 0000 0000 0000 0000→ flush pipe
```
7. When all configuration bits have been loaded, reset the TAP by clocking five 1s on TMS.
8. Go to the SHIFT-IR state and load the JSTART instruction.
9. Go to the RTI state and clock TCK at least 12 times to clock the startup sequence.
10. Go to the TLR state to complete the reconfiguration process.

Boundary-Scan for Virtex-4 Devices Using IEEE Standard 1532

ISC Modal States

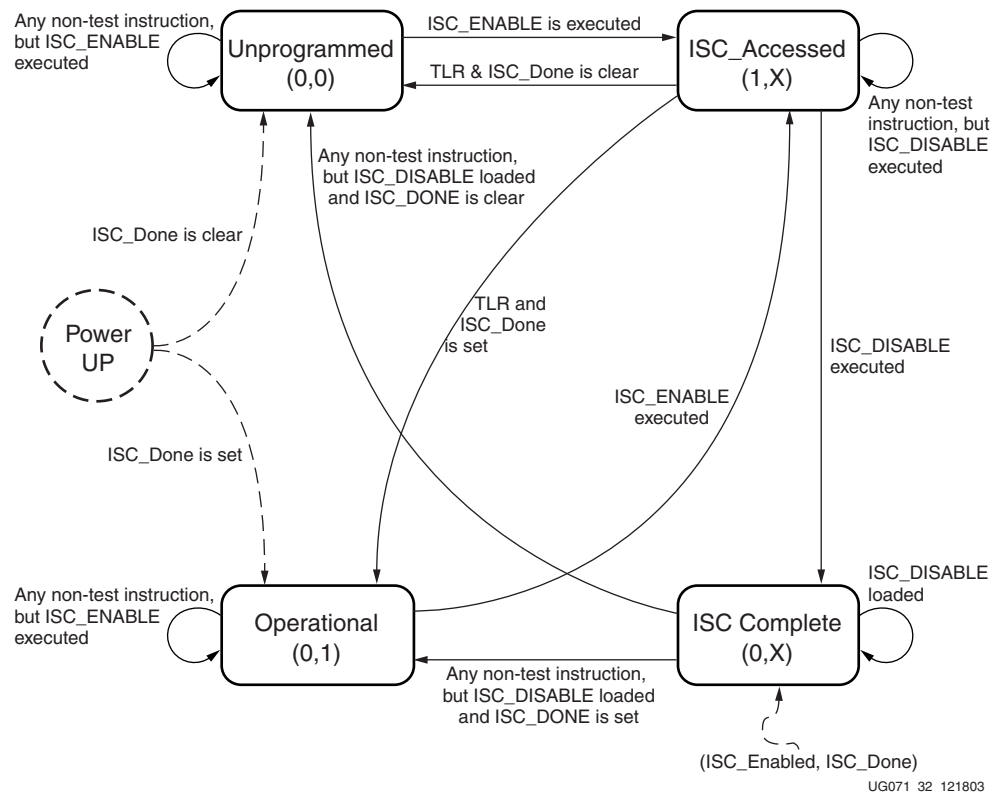


Figure 3-8: ISC Modal States

Once the device is powered up, it goes to the Unprogrammed state. The I/Os are all either 3-stated or pulled up. When ISC_ENABLE is successfully executed, the ISC_Enabled signal is asserted, and the device moves to the ISC_Accessed state. When the device moves

to the ISC_Accessed state from the Operational state, the shutdown sequence is executed. The I/Os are all either 3-stated or pulled up.

The startup sequence is executed when in the ISC_Accessed state. At the end of the startup sequence, ISC_Enabled is cleared and the device moves to ISC_Complete. The minimum clock cycle requirement is the number of clock cycles required to complete the startup sequence. At the completion of the minimum required clock cycles, ISC_Enabled is deasserted.

Whether the startup sequence is successful or not is determined by CRC or configuration error status from the configuration processor. If the startup is completed, ISC_Done is asserted; otherwise, ISC_Done stays Low. The I/Os are either 3-stated or pulled up.

When ISC_Done is set in ISC_Complete state, the device moves to the Operational state. Otherwise, if ISC_Done is clear, the device moves to the Unprogrammed state. However, if the TAP controller goes to the TLR state while the device is in ISC_Accessed state, and if ISC_Done is set, then the device moves to the Operational state.

Though Operational, the I/O is not active yet because the startup sequence has not been performed. The startup sequence has to be performed in the Operational state to bring the I/O active.

Clocking Startup and Shutdown Sequences (JTAG)

There are three clock sources for startup and shutdown sequence: CCLK, UserCLK, and JTAGCLK. Clock selection is set by BitGen. The startup sequence is executed in the ISC_Accessed state. When it is clocked by JTAGCLK, the startup sequence receives the JTAGCLK in TAP Run/Test Idle state while ISC_DISABLE is the current JTAG instruction. The number of clock cycles in Run/Test Idle state for successful completion of ISC_DISABLE is determined by the number of clock cycles needed to complete the startup sequence.

When UserCLK or CCLK is used to clock the startup sequence, the user should know how many JTAGCLK cycles should be spent in Run/Test Idle to complete the startup sequence successfully.

The shutdown sequence is executed when the device transitions from the Operational to the ISC_Accessed state. Shutdown is done while executing the ISC_ENABLE instruction. When the shutdown sequence is clocked using JTAGCLK, the clock is supplied in the Run/Test Idle state of the ISC_ENABLE instruction. The number of clock cycles in Run/Test Idle is determined by the number of clock cycles needed to complete the shutdown sequence.

When the shutdown sequence is clocked by CCLK or UserCLK, the user is responsible for knowing how many JTAGCLK cycles in Run/Test Idle are needed to complete the shutdown sequence.

Note:

When configuring the device through JTAG, the startup and shutdown clock should come from TCK, regardless of the selection in BitGen. In IEEE 1532 configuration mode, the startup and shutdown clock source is always TCK.

Configuration Flows Using JTAG

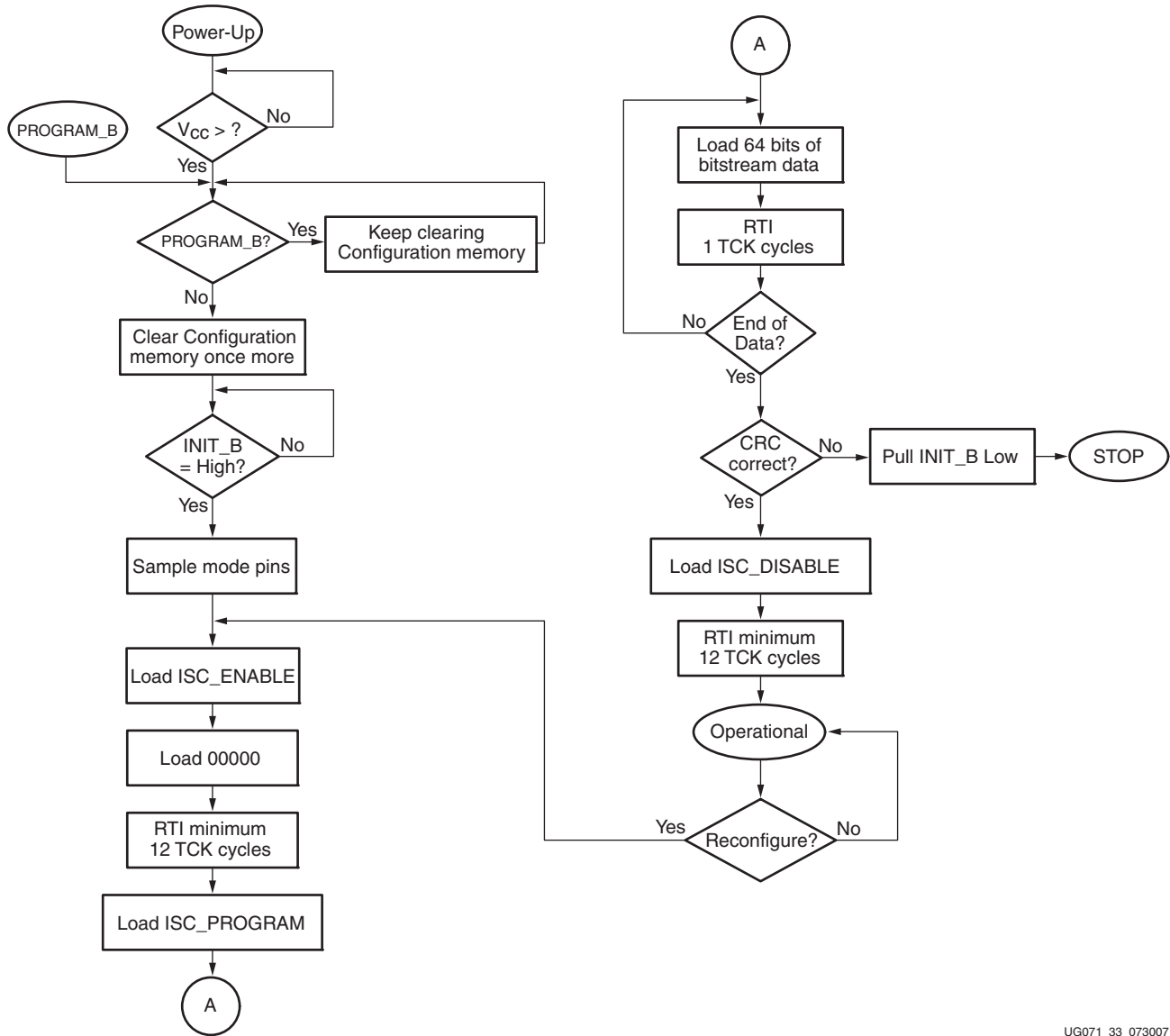


Figure 3-9: IEEE 1532 Configuration Flow

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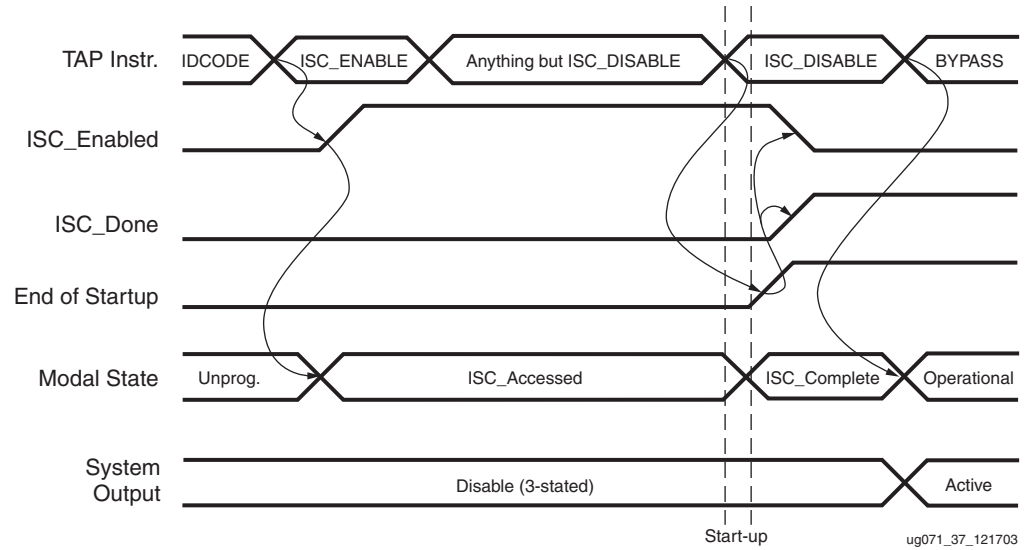


Figure 3-10: Signal Diagram for Successful First Time ISC Configuration

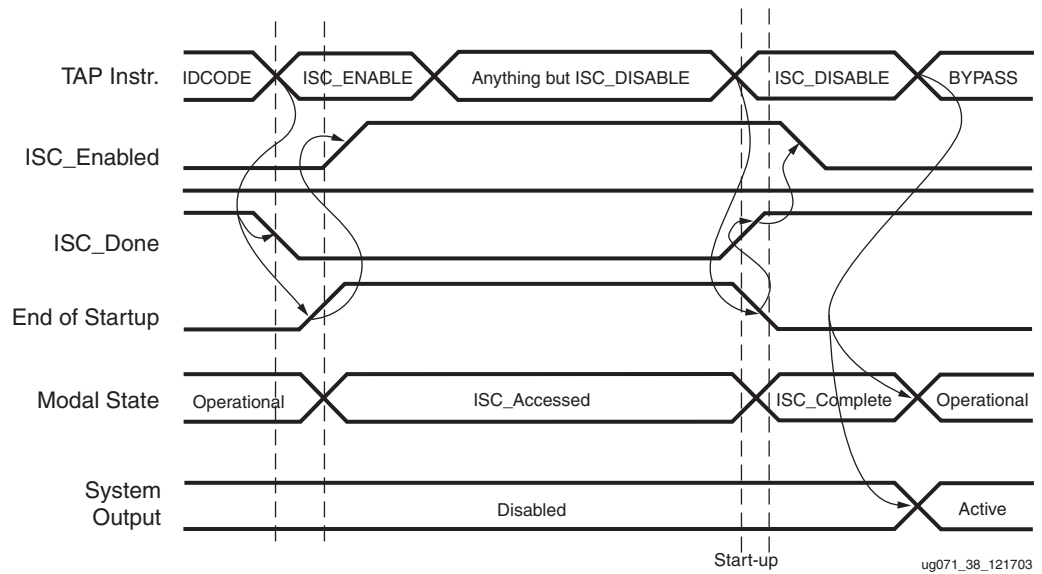


Figure 3-11: Signal Diagram for Successful ISC Partial and Full Reconfiguration

Frame ECC Logic

Using Frame ECC Logic

Configurable memory is highly reliable, however to provide extra reliability, the solution explained in this chapter has been provided.

The Frame error correction code (ECC) logic of the Virtex®-4 FPGA is designed to detect single- or double-bit errors in configuration frame data. It uses SECDED (Hamming code) parity values based on the frame data generated by BitGen. During readback, the Frame ECC logic calculates a *syndrome* value using all the bits in the frame, including the ECC bits. If the bits have not changed from the original programmed values, then the syndrome are all 0s. If a single bit has changed, including any of the ECC bits, then the location of the bit is indicated by syndrome bits 10:0 and syndrome bit 11 is 1. If two bits have changed, then syndrome bit 11 is 0 and the remaining bits is non-zero and meaningless. If more than two bits have changed then the syndrome is indeterminate. The *error* output of the block is asserted if one or two bits have changed, indicating that action needs to be taken.

To use the Frame ECC logic, FRAME_ECC_VIRTEX4 must be instantiated in the user's design, and readback must be performed through SelectMAP, JTAG, or ICAP. At the end of each frame of readback, the *syndrome_valid* signal is asserted for one cycle of the readback clock (CCLK, TCK, or ICAP_CLK). The number of cycles required to read back a frame varies with the interface used. Refer to [Chapter 8, "Readback and Configuration Verification,"](#) for further information.

The FRAME_ECC_VIRTEX4 logic does not repair changed bits; this requires a user design. The design must be able to store at least one frame of data, or be able to fetch original frames of data for reload. A single frame is 1,312 bits. Following is an example of a simple repair implementation:

1. A frame is read out through ICAP and stored in block RAM. The frame address must be generated as each frame is read.
2. If an error is indicated by the *error* output of the FRAME_ECC block, then the readback is halted and the syndrome value saved. If bit 11 is 0, then the whole frame must be restored. If bit 11 is 1, then bits 10:0 are used to locate the error bit in the saved frame, and the bit inverted.
3. The repaired frame is then written back into the frame address generated in step 1.
4. Readback then begins again with the next frame address.

The syndrome bits S[10:0] are derived from the Hamming parity bits, while S[11] is derived from the overall parity bit. The syndrome bit is interpreted as follows:

$S[11] = 0, S[10:0] = 0$: no error.

$S[11] = 1, S[10:0] \neq 0$: single bit (SED) error; S[10:0] denotes location of bit to patch (indirectly).

$S[11] = 1, S[10:0] = 0$: single-bit error; overall parity bit $p[11]$ is in error.

$S[11] = 0, S[10:0] \neq 0$: double-bit error, not correctable.

In case of a single-bit error in the frame data, the syndrome bits $S[10:0]$ points to the flipped bit in the address space from 704 (location of the first bit in the frame) to 2047 (last bit in the frame). To convert the syndrome value $S[10:0]$ to the index of the flipped bit in the range 0 to 1311, subtract 704 decimal (2C0 hexadecimal or 01011000000 binary) if the syndrome is less than 1,024 decimal; otherwise, subtract 736 decimal (2E0 hexadecimal or 01011100000 binary). This is equivalent to subtracting 22 or 23 decimal from $S[10:5]$, and can be calculated as $bit_index = \{S[10:5] - 6'd22 - S[10], S[5:0]\}$.

If $S[10:0]$ is 0 or a power of 2, however, an error in a parity bit has occurred. The Hamming parity bits are stored in locations 640-651. If bit $S[11]$ indicates a single-bit error, then (in the case of a Hamming code parity bit error) a 1 is presented in the appropriate power-of-2 bit position, with the other syndrome bits set to 0:

```

100000000001 -> 640
100000000010 -> 641
100000000100 -> 642
100000001000 -> 643
100000010000 -> 644
100000100000 -> 645
100001000000 -> 646
100010000000 -> 647
100100000000 -> 648
101000000000 -> 649
110000000000 -> 650
100000000000 -> 651

```

User Access Register

Using the User Access Register

The User Access Register (USR_ACCESS_VIRTEX4) is a 32-bit register that allows data from the bitstream to be directly accessible by the FPGA fabric. The register has two outputs: the 32-bit DATA bus and a *data_valid* signal that is asserted for one cycle of the configuration-data source clock whenever a new value is available. The configuration-data source clock can be CCLK or TCK.

The UAR allows data from a bitstream data storage source (e.g., PROM) to be accessed by the fabric after the FPGA has been configured. To accomplish this, the STARTUP_VIRTEX4 block should also be instantiated.

The STARTUP_VIRTEX4 block has inputs that allow the user to take control of the CCLK and DONE pins after the EOS (End-Of-Startup) signal has been asserted. These pins are USR_CCLK_O, USR_CCLK_TS, USR_DONE_O, and USR_DONE_TS. The BitGen option **-g DONE_cycle:KEEP** should be used to prevent the DONE pin from going High, because that can reset or disable the configuration storage source. The USR_CCLK_O pin should be connected to a controlled clock in the fabric. The configuration device should contain data with the USR_ACCESS register as the target. After EOS has been asserted, the data can be loaded by clocking the USR_CCLK_O pin while keeping USR_CCLK_TS Low (it can be tied Low in this usage).

The DATAVALID output indicates that a word is available on the data output port. DATAVALID goes High for one CCLK cycle after the register is updated. A write to the User Bitstream Access Register (AXSS) after configuration is required. Similar to other configuration registers, the AXSS register can be accessed through the configuration interface (e.g., JTAG, SelectMap, ICAP).

The USR_ACCESS register can be used to provide a single 32-bit constant value to the fabric as an alternative to using a block RAM or LUTRAM to hold the constant.

Reconfiguration Techniques

Dynamic Reconfiguration of Functional Blocks (DRP)

Background

In the Virtex® family of FPGAs, the Configuration Memory is used primarily to implement user logic, connectivity and I/Os, but it is also used for other purposes. For example, it is used to specify a variety of static conditions in functional blocks, such as Digital Clock Managers (DCMs) and RocketIO™ Multi-Gigabit Transceivers (MGTs).

Sometimes an application requires a change in these conditions in the functional blocks while the block is operational. This can be accomplished through the global Internal Configuration Access Port (ICAP), or through partial dynamic reconfiguration using JTAG or SelectMAP in the Persist mode. However, the reconfiguration port that is an integral part of each functional block simplifies this process greatly. Such configuration ports exist in the DCMs and RocketIO MGTs.

Overview

This document describes the addressable, parallel write/read configuration memory that is implemented in each functional block that might require reconfiguration. This memory has the following attributes:

- It is directly accessible from the FPGA fabric. Configuration bits can be written to and/or read from depending on their function.
- Each bit of memory is initialized with the value of the corresponding configuration memory bit in the bitstream. Memory bits can also be changed later through the ICAP.
- The output of each memory bit drives the functional block logic, so the content of this memory determines the configuration of the functional block.

The address space can include status (read-only) and function enables (write-only). Note that read-only and write-only operations can share the same address space. [Figure 6-1](#) shows how the configuration bits drive the logic in functional blocks directly in earlier FPGA families, and [Figure 6-2](#) shows how the reconfiguration logic changes the flow to read or write the configuration bits.

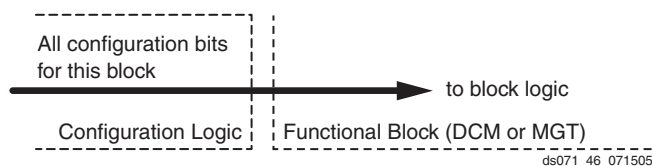


Figure 6-1: Block Configuration Logic without Dynamic Interface

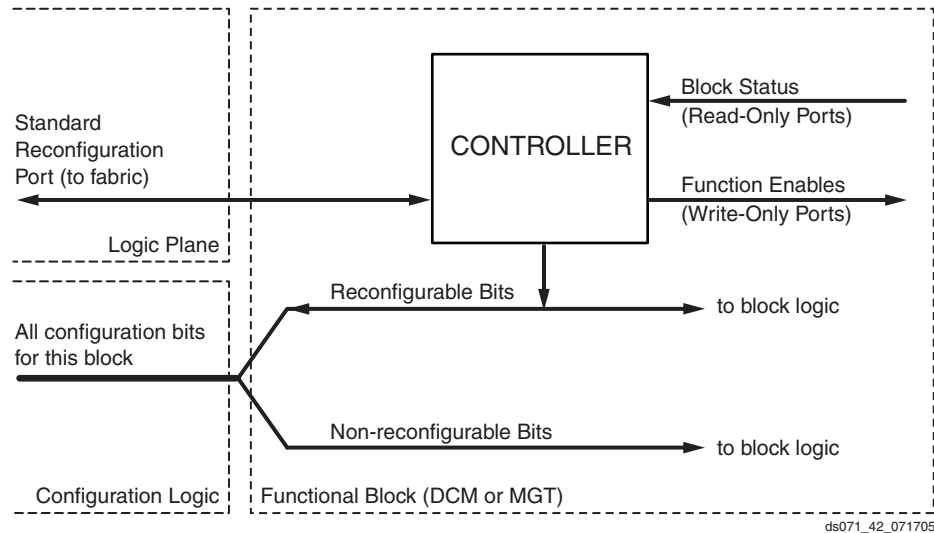


Figure 6-2: Block Configuration Logic with Dynamic Interface

Figure 6-3 is the same as Figure 6-2, except the port between the Logic Plane and Functional Block is expanded to show the actual signal names and directions.

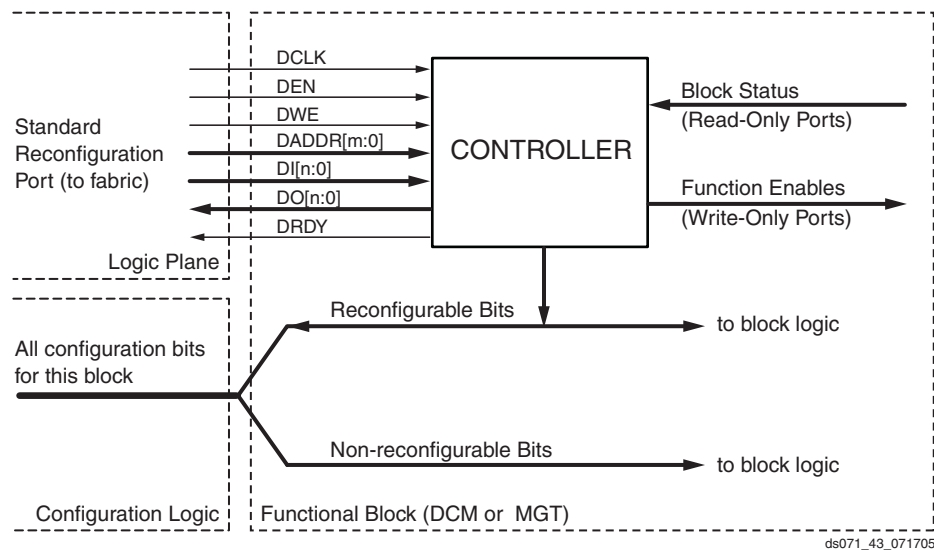


Figure 6-3: Block Configuration Logic Expanded to Show Signal Names

FPGA Fabric Port Definition

Table 6-1, page 82, lists each signal on the FPGA Fabric port. The individual functional blocks can implement all or only a subset of these signals. The DCM chapter in the *Virtex-4 FPGA User Guide* and the *Virtex-4 RocketIO Multi-Gigabit Transceiver User Guide* shows the signals and functions implemented for the specific blocks. In general, the port is a synchronous parallel memory port, with separate read and write buses similar to the block RAM interface. Bus bits are numbered least-significant to most-significant, starting at 0. All signals are active High.

Synchronous timing for the port is provided by the DCLK input, and all the other input signals are registered in the functional block on the rising edge of DCLK. Input (write) data is presented simultaneously with the write address and DWE and DEN signals prior to the next positive edge of DCLK. The port asserts DRDY for one clock cycle when it is ready to accept more data. The timing requirements relative to DCLK for all the other signals are the same. The output data is not registered in the functional blocks. Output (read) data is available after some cycles following the cycle that DEN and DADDR are asserted. The availability of output data is indicated by the assertion of DRDY.

Figure 6-4 and Figure 6-5 show the timing relationships between the port signals for write and read operations. Absolute timing parameters, such as maximum DCLK frequency, setup time, etc., are defined in the *Virtex-4 FPGA Data Sheet*.

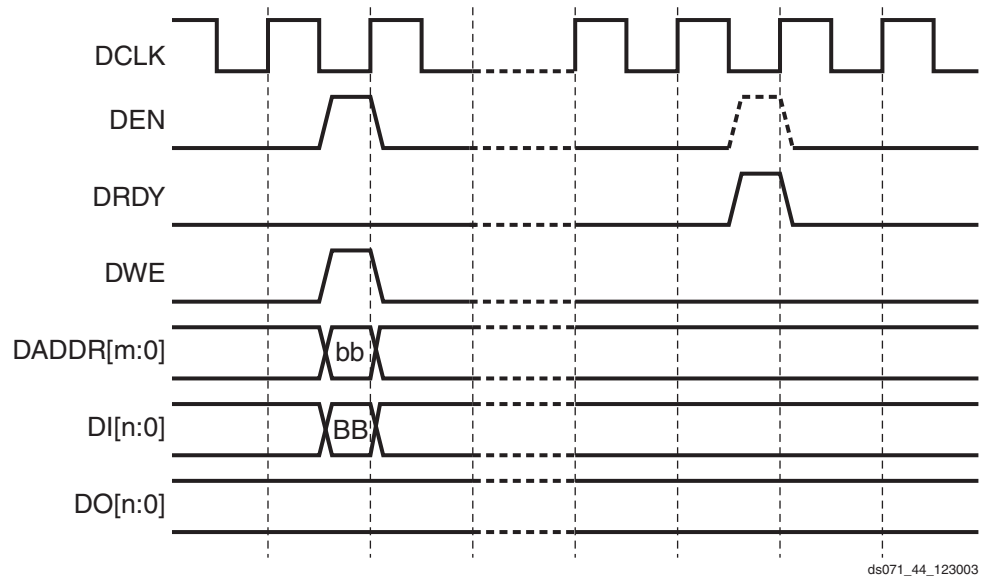


Figure 6-4: Write Timing with Wait States

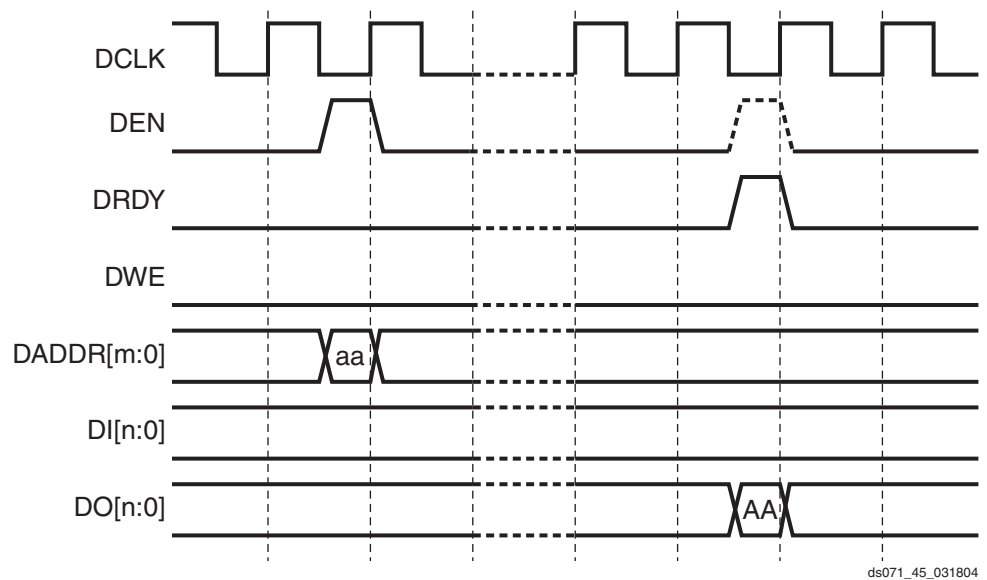


Figure 6-5: Read Timing with Wait States

Table 6-1: Port Signal Definitions

Signal Name	Direction ⁽¹⁾	Description
DCLK	Input	The rising edge of this signal is the timing reference for all the other port signals. The required hold time for the other input signals relative to the rising edge of DCLK is zero (maximum). Normally, DCLK is driven with a global clock buffer.
DEN	Input	This signal enables all port operations. If DWE is FALSE, it is a read operation, otherwise a write operation. For any given DCLK cycle, all other input signals are <i>don't care</i> if DEN is not active.
DWE	Input	When active, this signal enables a write operation to the port (see DEN, above).
DADDR[m:0]	Input	The value on this bus specifies the individual cell that is written or read on the next cycle of DCLK. The address is presented in the cycle that DEN is active.
DI[n:0]	Input	The value on this bus is the data that is written to the addressed cell. The data is presented in the cycle that DEN and DWE are active, and is captured in a register at the end of that cycle, but the actual write occurs at an unspecified time before DRDY is returned.
DO[n:0]	Output	If DWE was inactive when DEN was activated, the value on this bus when DRDY goes active is the data read from the addressed cell. At all other times, the value on DO[n:0] is undefined.
DRDY	Output	This signal is a response to DEN to indicate that the DRP cycle is complete and another DRP cycle can be initiated. In the case of a port read, the DO bus must be captured on the rising edge of DCLK in the cycle that DRDY is active. The earliest that DEN can go active to start the next port cycle is the same clock cycle that DRDY is active.

Notes:

1. Input denotes input (write) to the DRP.

DRP DCM Implementation

The DRP implementation allows dynamic adjustment of M, D, and PS values (direct mode) in the DCM. The following ports are available in DCM_ADV primitive (see Chapter 2 of the *Virtex-4 FPGA User Guide*):

Inputs:

DI[15:0]
 DADDR[6:0]
 DWE
 DEN
 DCLK

Outputs:

DO[15:0]
 DRDY

DADDR[6:0] is latched at DCLK rising edge while DEN is asserted. The DO output reflects the status of that latched address location. After reset, the internal address is reset to 0, and the DCM DRP DO outputs are used to signal the default status Phase Shift Overflow, CLKIN Stopped, CLKFX Stopped, and CLKFB Stopped. However, if the DRP is used to reprogram M, D, or PS value, the DO is no longer showing default status. To access default status, the user must perform a DRP read with DADDR[6:0] = 0.

Changing the Multiply and Divide Values

The Multiply and Divide (M/D) values can be directly programmed in the DCM through the DRP by writing to hex addresses 50h and 52h respectively. The five least-significant data bits represent the multiply-minus-1 and divide-minus-1 values, as shown in [Table 6-2](#) and [Table 6-3](#). DRDY indicates that the new value has been written successfully.

The DCM must be held in reset by activating input RST while changing the M/D values. At some point after RST is released, signal LOCKED goes true, indicating that the clock outputs of the DCM are valid.

Table 6-2: Multiplier Settings

DADDR[15:0]	DEC	DI[15:0]	Function
50h	0000	0000h (0000000000000000)	N/A
50h	0001	0001h (0000000000000001)	Multiply by 2
50h	0002	0002h (0000000000000010)	Multiply by 3
50h	0003	0003h (0000000000000011)	Multiply by 4
50h	0004	0004h (0000000000000100)	Multiply by 5
⋮	⋮	⋮	⋮
50h	0030	001Eh (0000000000011110)	Multiply by 31
50h	0031	001Fh (0000000000011111)	Multiply by 32

Table 6-3: Divider Settings

DADDR[15:0]	DEC	DI[15:0]	Function
52h	0000	0000h (0000000000000000)	N/A
52h	0001	0001h (0000000000000001)	Divide by 2
52h	0002	0002h (0000000000000010)	Divide by 3
52h	0003	0003h (0000000000000011)	Divide by 4
52h	0004	0004h (0000000000000100)	Divide by 5
•	•	•	•
•	•	•	•
•	•	•	•
52h	0030	001Eh (0000000000011110)	Divide by 31
52h	0031	001Fh (0000000000011111)	Divide by 32

If the M or D values are dynamically charged, then in some cases, the frequency mode must also be charged to comply with the specifications in the data sheet. For the DFS_FREQUENCY_MODE DRP address, 41h must be read and bit 6 (DI[5]) is then set to:

- 0 for low frequency mode
- 1 for high frequency mode

All other bits must remain unchanged.

For the DLL_FREQUENCY_MODE DRP address, 58h must be read and bits 7 and 8 (DI[7:6]) are then set to:

- 0 for low frequency mode
- 1 for high frequency mode

Again, all other bits must be left undisturbed.

Dynamic Phase Shifting Through the DRP in Direct Mode

In addition to the phase shift modes already available in Virtex-II and Virtex-II Pro devices, the Virtex-4 FPGA has implemented a Direct Phase Shift Mode (DPSM). This allows the user to control the phase-shift delay line elements (tabs) directly. The DPSM can be accessed through either the standard Phase Shift (PS) interface or the DRP. If the DCM attribute CLKOUT_PHASE_SHIFT is set to DIRECT, then the PS interface is in direct mode and controls individual taps. The initial tap value is 0 delay line elements. All four PS interface signals act identically to the legacy-phase shift mode, thus allowing increment or decrement of the tabs. The delay line element is inserted at the CLKIN path. CLKIN leads CLKFB mode when more delay line elements are inserted until the delay elements are equal to one clock period, at which time the dynamic phase starts over again.

If DLL_PHASE_SHIFT_LOCK_BY1 = 1, each increment/decrement changes one tab. If 0, each increment/decrement changes eight tabs.

The DRP interface allows to the user to directly set an initial phase-shift value to a specified number of taps. After RESET, the phase-shift delay line has no elements inserted. A value between 0 and 3FFh (0-1023 taps) can be written to the DRP, then setting the tap target value in the DCM. A write to a specific address of the DRP then initiates the adjustment cycles necessary to set the proper delay value in the DPS. The DCM requires fewer clock cycles to achieve the final value than in the other modes, where a phase shift is expressed

as a percentage of the clock. Just as in legacy mode, PSDONE indicates completion of the phase shift. If `DLL_PHASE_SHIFT_LOCK_BY1 = 0`, then the lower three bits of phase shift value are ignored, because it works on eight tabs as a unit.

Phase shift overflow does not toggle in the Direct Mode if the end of the delay line is reached.

It is recommended that the same clock be used for DCLK and PSCLK. Although the PSDONE pin is a function of the PSCLK domain, the data written to the DRP is in the DCLK domain. If this cannot be done, then the following two scenarios should be considered:

1. **Connect DCLK, but not PSCLK.** PSDONE is not asserted. The phase shift value is executed, although there is no indication when it is completed.
2. **Connect PSCLK and DCLK to different sources.** PSDONE is in the PSCLK domain and can be asynchronous to DCLK.

Setting a direct phase shift value:

1. If the `CLKOUT_PHASE_SHIFT` was not set to `DIRECT`, then write `00Dh` (DI) to DADDR address `56h`. (DRP should not be used to change configuration memory other than phase shift value.)
2. Write the desired tab value `0-3FFh` (DI) (0-1023 tabs) to DADDR `55h`.
3. Write to DADDR `11h` to start the phase shift. (Data on DI does not matter.)
4. PSDONE asserts for one PSCLK cycle to indicate that the phase shift is done.

ICAP - Internal Configuration Access Port

The Internal Configuration Access Port (ICAP) allows access to configuration data in the same manner as SelectMAP. ICAP has the same interface signaling as SelectMAP other than the data bus, which is separated into read and write data buses. ICAP has a chip-select signal (CS), a read-write control signal (RD), a clock (CLK), a write data bus (DIN), and a read data bus (OUT). ICAP can be configured to two different data bus widths, 8 bits or 32 bits. When the 8-bit ICAP interface is used, the data is byte-reversed like SelectMAP. When the 32-bit interface is used, the data is not reversed, which is the same as SelectMAP32.

The ICAP interface can be used to perform readback operations or partial reconfiguration. When using ICAP for partial reconfiguration, the user must avoid changing the logic or interconnect which the ICAP is itself connected to. ICAP can also be used to read or write to the configuration registers, such as the STAT, CTL, or FAR registers. See [“Accessing Configuration Registers through the SelectMAP Interface”](#) for details.

There are two ICAP sites in Virtex-4 devices: TOP and BOTTOM. The implementation has the two interfaces share the same underlying logic. The only difference between them is their location on the chip and the interconnect to which they can be connected. The two interfaces can never be active at the same time. The default site for a single ICAP is the TOP site, because the TOP site is active after configuration by default. If both sites are used, the TOP site must be activated first before switching to the BOTTOM site. The process of switching between the two sites is as follows:

1. Synchronize the current interface (if it's not already synched).
2. Write bit 30 of the MASK register with a 1.
3. Write bit 30 of the CTL register with a 1 if switching to the BOTTOM site or a 0 if switching to the TOP site.
4. Write the DESYNCH command to the CMD register.
5. Synchronize the new ICAP site.

Configuration Details

All user-programmable features inside Virtex®-4 devices are controlled by volatile memory cells that must be configured at power-up.

These memory cells are collectively known as *configuration memory*. They define the LUT equations, signal routing, IOB voltage standards, and all other aspects of the user design.

To program configuration memory, instructions for the configuration control logic and data for the configuration memory are provided in the form of a bitstream. The bitstream is delivered to the device through one of the configuration interfaces (JTAG, SelectMAP, or Slave/Master Serial).

The composition of the bitstream is largely independent of the configuration method. Certain operations, however, such as readback, can only be performed through the SelectMAP and JTAG interfaces.

Configuration Memory Frames

Virtex-4 configuration memory is arranged in *frames* that are tiled about the device. These frames are the smallest addressable segments of the Virtex-4 configuration memory space, and all operations must therefore act upon whole configuration frames. Virtex-4 frame counts and configuration sizes are shown in [Table 7-1](#). Depending on BitGen options, additional overhead exists in the configuration bitstream. The exact bitstream length is available in the .rbt (rawbits) file created by using the "-b" option with bitgen or selecting "Create ASCII Configuration File" in the Generate Programming File options popup in ISE® software. Bitstream length (words) are roughly equal to the configuration array size (words) plus configuration overhead (words). Bitstream length (bits) are roughly equal to the bitstream length in words times 32.

Table 7-1: Virtex-4 Frame Count, Frame Length, Overhead and Bitstream Size

Device	Non-Configuration Frames ⁽¹⁾	Configuration Frames ⁽²⁾	Device Frames ⁽³⁾	Frame Length (words) ⁽⁴⁾	Configuration Array Size (words) ⁽⁵⁾	Configuration Overhead (words) ⁽⁶⁾
XC4VLX15	140	3,600	3,740	41	147,600	1312
XC4VLX25	234	5,928	6,162	41	243,048	1312
XC4VLX40	376	9,312	9,688	41	381,792	1312
XC4VLX60	536	13,472	14,008	41	552,352	1312
XC4VLX80	710	17,720	18,430	41	726,520	1312
XC4VLX100	948	23,376	24,324	41	958,416	1312
XC4VLX160	1,260	30,720	29,460	41	1,259,520	1312
XC4VLX200	1,620	39,120	37,500	41	1,603,920	1312

Table 7-1: Virtex-4 Frame Count, Frame Length, Overhead and Bitstream Size (Continued)

Device	Non-Configuration Frames ⁽¹⁾	Configuration Frames ⁽²⁾	Device Frames ⁽³⁾	Frame Length (words) ⁽⁴⁾	Configuration Array Size (words) ⁽⁵⁾	Configuration Overhead (words) ⁽⁶⁾
XC4VSX25	440	6,940	7,380	41	284,540	1312
XC4VSX35	660	10,410	11,070	41	426,810	1312
XC4VSX55	1,104	17,304	18,408	41	709,464	1312
XC4VFX12	248	3,600	3,848	41	147,600	1312
XC4VFX20	360	5,488	5,848	41	225,008	1312
XC4VFX40	660	10,296	10,956	41	422,136	1312
XC4VFX60	1,040	15,976	17,016	41	665,016	1312
XC4VFX100	1,660	25,170	26,830	41	1,031,970	1312
XC4VFX140	2,424	36,444	38,868	41	1,494,204	1312

Notes:

1. *Non-configuration frames* should be considered when calculating T_{PL} (Program Latency) but do not contribute to the bitstream size. See Table 41: Configuration Switching Characteristics in the *Virtex-4 FPGA Data Sheet*.
2. *Configuration frames* contribute to both the T_{PL} calculation and the overall bitstream size.
3. The number of *device frames* equals the number of non-configuration plus configuration frames, and is the number of frames to use when calculating T_{PL} .
4. All Virtex-4 configuration frames consist of 41 32-bit words.
5. *Configuration array size* equals the number of configuration frames times the number of words per frame.
6. *Configuration overhead* consists of commands in the bitstream that are needed to perform configuration, but do not themselves program any memory cells. Configuration overhead contributes to the overall bitstream size.

Configuration Control Logic

The Virtex-4 configuration logic consists of a packet processor, a set of registers, and global signals that are controlled by the configuration registers. The packet processor controls the flow of data from the configuration interface (SelectMAP, JTAG, or Serial) to the appropriate register. The registers control all other aspects of configuration.

Packet Types

The FPGA bitstream consists of two packet types: Type 1 and Type 2. These packet types and their usage are described below.

Type 1 Packet

The Type 1 packet is used for register reads and writes. Only 5 out of 14 register address bits are used in Virtex-4 FPGAs. The header section is always a 32-bit word.

Following the Type 1 packet header is the Type 1 Data section, which contains the number of 32-bit words specified by the word count portion of the header. See [Table 7-2](#) and [Table 7-3](#).

Table 7-2: Type 1 Packet Header Format

Header Type	Opcode	Register Address	Reserved	Word Count
[31:29]	[28:27]	[26:13]	[12:11]	[10:0]
001	xx	RRRRRRRRRRxxxxx	RR	xxxxxxxxxxxx

Notes:

- "R" means the bit is not used and reserved for future use.

Table 7-3: Opcode Format

Opcode	Function
00	NOP
01	Read
10	Write
11	Reserved

Type 2 Packet

The Type 2 packet, which must follow a Type 1 packet, is used to write long blocks. No address is presented here because it uses the previous Type 1 packet address. The header section is always a 32-bit word.

Following the Type 2 packet header is the Type 2 Data section, which contains the number of 32-bit words specified by the word count portion of the header. See [Table 7-4](#).

Table 7-4: Type 2 Packet Header

Header Type	Opcode	Word Count
[31:29]	[28:27]	[26:0]
010	RR	xxxxxxxxxxxxxxxxxxxxxxxxxxxx

Configuration Registers

All bitstream commands are executed by reading or writing to the configuration registers. [Table 7-5](#) summarizes these registers. A detailed explanation of selected registers follows.

Table 7-5: Configuration Registers

Reg. Name	Read/Write	Address	Description
CRC	Read/Write	00000	CRC register
FAR	Read/Write	00001	Frame Address Register
FDRI	Write	00010	Frame Data Register, Input (write configuration data)
FDRO	Read	00011	Frame Data Register, Output register (read configuration data)
CMD	Read/Write	00100	Command Register
CTL	Read/Write	00101	Control Register

Table 7-5: Configuration Registers (Continued)

Reg. Name	Read/Write	Address	Description
MASK	Read/Write	00110	Masking Register for CTL
STAT	Read	00111	Status Register
LOUT	Write	01000	Legacy Output Register (DOUT for daisy chain)
COR	Read/Write	01001	Configuration Option Register
MFWR	Write	01010	Multiple Frame Write
CBC	Write	01011	Initial CBC value register
IDCODE	Read/Write	01100	Device ID register
AXSS	Read/Write	01101	User bitstream access register

Command Register (CMD)

The Command Register is used to instruct the configuration control logic to strobe global signals and perform other configuration functions. The command present in the CMD register is executed each time the FAR is loaded with a new value. Table 7-6 gives the Command Register commands and codes.

Table 7-6: Command Register Codes

Command	Code	Description
NULL	0000	Null Command
WCFG	0001	Write Configuration Data: used prior to writing configuration data to the FDRL.
MFWR	0010	Multiple Frame Write: used to perform a write of a single frame data to multiple frame addresses.
LFRM	0011	Last Frame: Deasserts the GHIGH_B signal, activating all interconnect. The GHIGH_B signal is asserted with the AGHIGH command.
RCFG	0100	Read Configuration Data: used prior to reading configuration data from the FDRO.
START	0101	Begin Startup Sequence: initiates the startup sequence. The startup sequence begins after a successful CRC check and a DESYNC command are performed.
RCAP	0110	Reset Capture: resets the CAPTURE signal after performing readback-capture in single-shot mode (see “Readback Capture,” page 113).
RCRC	0111	Reset CRC: resets the CRC register
AGHIGH	1000	Assert GHIGH_B Signal: places all interconnect in a high-Z state to prevent contention when writing new configuration data. This command is only used in shutdown reconfiguration. Interconnect is reactivated with the LFRM command.
SWITCH	1001	Switch CCLK Frequency: updates the frequency of the Master CCLK to the value specified by the OFSEL bits in the COR.
GRESTORE	1010	Pulse the GRESTORE Signal: sets/resets (depending on user configuration) IOB and CLB flip-flops.
SHUTDOWN	1011	Begin Shutdown Sequence: initiates the shutdown sequence, disabling the device when finished. Shutdown activates on the next successful CRC check or RCRC instruction (typically an RCRC instruction).

Table 7-6: Command Register Codes (Continued)

Command	Code	Description
GCAPTURE	1100	Pulse GCAPTURE: loads the capture cells with the current register states (see “Readback Capture,” page 113).
DESYNC	1101	Reset DALIGN Signal: used at the end of configuration to desynchronize the device. After de-synchronization, all values on the configuration data pins are ignored.

Control Register (CTL)

The Control Register is used to set the configuration security level, the persist setting, and to toggle the Global Three-State signal. Writes to the CTL register are masked by the value in the MASK register (this allows the GTS_USR_B signal to be toggled without re-specifying the Security and Persist bits). The default value of the GLUTMASK_B bit in the CTL register is 1, which leads to corruption of SRL16 and distributed RAM (LUTRAM) during active readback of the device. Active readback is defined as readback that occurs while the device is not in the shutdown state. To prevent corruption of SRL16 and distributed RAM during active readback, the user must set the GLUTMASK_B bit to 0. This is accomplished by writing a 1 to bit 8 of the MASK register followed by writing a 0 to bit 8 of the CTL register. The MASK register is cleared after each write to the CTL register, which prevents inadvertent changes to the Control Register.

The fields are illustrated in Figure 7-1 and defined in Table 7-7.

Figure 7-1: Control Register

Description	Reserved	ICAP SEL	Reserved																GLUTMASK_B	Reserved	SBITS	PERSIST	Reserved	GTS_USR_B			
Bit Index	3	3	2	2	2	2	2	2	2	2	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0
Value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	x	x	x	x	x	x	x	x	x	x	x

Table 7-7: Control Register Description

Name	Bit Index	Description
Reserved	Various	Reserved CTL register bits. Always leave these bits set to 0.
ICAP_SEL	30	ICAP Port Select. 0: Top ICAP Port Enabled (default) 1: Bottom ICAP Port Enabled
SBITS	5:4	Security Level. 00: Read/Write OK (default) 01: Readback disabled 1x: Readback disabled, writing disabled except CRC register

Table 7-7: Control Register Description (Continued)

Name	Bit Index	Description
PERSIST	3	The configuration interface defined by M2:M0 remains after configuration. Typically used only with the SelectMAP interface to allow reconfiguration and readback. See also “SelectMAP Reconfiguration” in Chapter 2. 0: No (default) 1: Yes
GLUTMASK	8	GLUTMASK affects how certain memory cells are read back. This applies to SRL16 and distributed RAM (LUTRAM) bits as well as configuration bits that are accessible through a DRP port. 0=Readback all 0s from SRL16 and Distributed RAM. Use with active device readback. 1=Readback dynamic values from SFR16 and Distributed RAM. Use with shutdown readback.
GTS_USER_B	0	Active Low high-Z state for I/Os. 0: I/Os placed in high-Z state 1: I/Os active

Frame Address Register (FAR)

The Virtex-4 devices are divided into two halves, the top, and the bottom. Frames in the bottom half mirror images in the top half with the exception of the vertical HCLK rows that contain the global and regional clocks. The HCLK title bits are in the same order in the both of the top and bottom frames.

All Frames in Virtex-4 have a fixed, identical length of 1312 bits (41 32-bit words). One Frame configures one HCLK with either 4 block RAMS, 32 IOBs or 4 DSPs.

The FAR is divided into five fields: top/bottom bit, block type, row address, column address, and minor address. The address can be written directly or can be auto-incremented at the end of each frame. The typical bitstream starts at address 0 and auto-increment to the final count.

Table 7-8: Frame Address Register Description

Address Type	Bit Index	Description
Top_B Bit	22	Select between top-half rows and bottom-half rows.
Block Type	21:19	Block types are, CLB/IO/CLK (000), block RAM Interconnect (001), block RAM content (010), CFG_CLB (011), and CFG_BRAM (100). A normal bitstream stops at type 010.
Row Address	18:14	Selects a row of frames, for example, a row of 16 CLBs in height, with an HCLK row in the middle. The row addresses increase away from the middle (in both top and bottom).
Column Address	13:6	Selects a major column, such as a column of CLBs. Column addresses start at 0 on the left and increase to the right.
Minor Address	5:0	Selects a memory-cell address line within a major column.

Status Register (STAT)

The Status Register indicates the value of numerous global signals. The register can be read through the SelectMAP or JTAG interfaces. [Figure 7-2](#) gives the name of each bit position in the STAT register; a detailed explanation of each bit position is given in [Table 7-9](#).

Figure 7-2: Status Register

Description	-																Reserved	DEC_ERROR	ID_ERROR	DONE	RELEASE_DONE	INIT	INIT_COMPLETE	MODE			GHIGH_B	GWE	GTS_CFG_B	EOS	DCI_MATCH	DCM_LOCK	PART_SECURED	CRC_ERROR
	Bit Index	3	3	2	2	2	2	2	2	2	2	1	1	1	1	1	1	0	9	8	7	6	5	4	3	2	1	0						
Value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	x	x	x	x	x	x	x	x	x	x	x						

Table 7-9: Status Register Description

Name	Bit Index	Description
DEC_ERROR	16	FDR1 write attempted before or after decrypt operation. 0: No DEC_ERROR 1: DEC_ERROR
ID_ERROR	15	Attempt to write to FDR1 without successful DEVICE_ID check. 0: No ID_ERROR 1: ID_ERROR
DONE	14	Value on DONE pin.
RELEASE_DONE	13	Value of internal DONE signal. 0: DONE signal not released (pin is actively held Low) 1: DONE signal released (can be held Low externally)
INIT	12	Value on INIT pin
INIT_COMPLETE	11	Internal signal indicating initialization has completed. 0: Initialization has not finished 1: Initialization finished
MODE	10:8	Status of the MODE pins (M2:M0).
GHIGH_B	7	Status of GHIGH_B. 0: GHIGH_B asserted 1: GHIGH_B deasserted
GWE	6	Status of GWE. 0: FFs and block RAM are write disabled 1: FFs and block RAM are write enabled
GTS_CFG_B	5	Status of GTS_CFG_B. 0: All I/Os are placed in high-Z state 1: All I/Os behave as configured
EOS	4	End of Startup signal from Startup Block. 0: Startup sequence has not finished 1: Startup sequence has finished

Table 7-9: Status Register Description (Continued)

Name	Bit Index	Description
DCI_MATCH	3	0: DCI not matched 1: DCI is matched This is a logical AND function of all the MATCH signals (one per bank). If no DCI I/Os are in a particular bank, the bank's MATCH signal = 1.
DCM_LOCK	2	0: DCMs not locked 1: DCMs are locked This is a logical AND function of all DCM LOCKED signals. Unused DCM LOCKED signals = 1.
PART_SECURED	1	0: Decryptor security not set 1: Decryptor security set
CRC_ERROR	0	0: No CRC error 1: CRC error

Configuration Options Register (COR)

The Configuration Options Register is used to set certain configuration options for the device. The name of each bit position in the COR is given in Figure 7-3 and described in Table 7-10.

Figure 7-3: Configuration Options Register

Description	Reserved			CRC_BYPASS	Reserved			DONE_PIPE	DRIVE_DONE	SINGLE	OSCFSEL							SSCLKSRC		DONE_CYCLE		MATCH_CYCLE			LOCK_CYCLE			GTS_CYCLE			GWE_CYCLE			
	3	2	1		28	27	26				25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2
Value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x

Table 7-10: Configuration Options Register Description

Name	Bit Index	Description
CRC_BYPASS	28	0: CRC enabled. 1: CRC disabled.
DONE_PIPE	25	0: No pipeline statue for DONEIN 1: Add pipeline stage for DONEIN The FPGA waits on DONE that is delayed by one StartupClk cycle. Use this option when StartupClk is running at high speeds.
DRIVE_DONE	24	0: DONE pin is open drain 1: DONE is actively driven High

Table 7-10: Configuration Options Register Description (Continued)

Name	Bit Index	Description
SINGLE	23	0: Readback is not single-shot New captured values are loaded on each successive CAP assertion on the CAPTURE_VIRTEX4 primitive. Capture can also be performed with the GCAPTURE instruction in the CMD register. 1: Readback is single-shot. The RCAP instruction must be loaded into the CMD register between successive readbacks.
OSCFSEL	22:17	Select CCLK frequency in Master configuration modes.
SSCLKSRC	16:15	Startup-sequence clock source. 00: CCLK 01: UserClk (per connection on the CAPTURE_VIRTEX4 block) 1x: JTAGClk
DONE_CYCLE	14:12	Startup cycle to release the DONE pin. 001: Startup cycle 2 010: Startup cycle 3 011: Startup cycle 4 100: Startup cycle 5 101: Startup cycle 6
MATCH_CYCLE	11:9	Startup cycle to stall in until DCI matches. 000: Startup cycle 1 001: Startup cycle 2 010: Startup cycle 3 011: Startup cycle 4 100: Startup cycle 5 101: Startup cycle 6 111: No Wait
LOCK_CYCLE	8:6	Startup cycle to stall in until DCMs lock. 000: Startup cycle 1 001: Startup cycle 2 010: Startup cycle 3 011: Startup cycle 4 100: Startup cycle 5 101: Startup cycle 6 111: No Wait

Table 7-10: Configuration Options Register Description (Continued)

Name	Bit Index	Description
GTS_CYCLE	5:3	Startup cycle to deassert the Global Three-State (GTS) signal. 001: Startup cycle 2 010: Startup cycle 3 011: Startup cycle 4 100: Startup cycle 5 101: Startup cycle 6
GWE_CYCLE	2:0	Startup phase to deassert the Global Write Enable (GWE) signal. 001: Startup cycle 2 010: Startup cycle 3 011: Startup cycle 4 100: Startup cycle 5 101: Startup cycle 6

Bitstream Composition

Configuration can begin after the device is powered and initialization has finished, as indicated by the INIT pin being released. After initialization, the packet processor ignores all data presented on the configuration interface until it receives the synchronization word. After synchronization, the packet processor waits for a valid packet header to begin the configuration process.

Default Initial Configuration Process

Initial configuration using a *default* bitstream (a bitstream generated using the default BitGen settings) begins by pulsing the PROGRAM_B pin for SelectMAP and Serial configuration modes or by issuing the JPROG_B instruction for JTAG configuration mode. Configuration proceeds as shown in Table 7-11:

Table 7-11: Configuration Sequence

Configuration Data (hex)	Explanation
FFFFFFFF	Dummy word
AA995566	Sync word
30008001	Type 1 write 1 words to CMD
00000007	RCRC command
20000000	NO-OP
20000000	
30012001	Type 1 write 1 words to COR
XXXXXXXX	Data word 0
30018001	Type 1 write 1 words to ID
0167C093	Device_ID
30008001	Type 1 write 1 words to CMD

Table 7-11: Configuration Sequence (Continued)

Configuration Data (hex)	Explanation
00000009	SWITCH command
20000000	NO-OP
30008001	Type 1 write 1 words to CMD
00000000	NULL command
20000000	NO-OP
3000C001	Type 1 write 1 words to MASK
XXXXXXXX	Data word 0
3000A001	Type 1 write 1 words to CTL
XXXXXXXX	Data word 0
20000000	NO-OP
...	1149 more NO-OPs
3000C001	Type 1 write 1 words to MASK
XXXXXXXX	Data word 0
3000A001	Type 1 write 1 words to CTL
XXXXXXXX	Data word 0
30002001	Type 1 write 1 words to FAR
00000000	Data word 0
30008001	Type 1 write 1 words to CMD
00000001	WCFG command
30004000	Type 1 write 0 words to FDRI
5003B568	Type 2 write 243048 words to FDRI
XXXXXXXX	Data word 0
...	...
XXXXXXXX	Data word 243047
30000001	Type 1 write 1 words to CRC
XXXXXXXX	Data word 0
30008001	Type 1 write 1 words to CMD
0000000A	GRESTORE command
20000000	NO-OP
30008001	Type 1 write 1 words to CMD
00000003	LFRM command
20000000	NO-OP
...	99 more NO-Ops
30008001	Type 1 write 1 words to CMD
0000000A	GRESTORE command

Table 7-11: Configuration Sequence (Continued)

Configuration Data (hex)	Explanation
20000000	NO-OP
30008001	Type 1 write 1 words to CMD
00000000	NULL command
20000000	NO-OP
30002001	Type 1 write 1 words to FAR
00000000	Data word 0
30008001	Type 1 write 1 words to CMD
00000005	START command
20000000	NO-OP
3000C001	Type 1 write 1 words to MASK
XXXXXXXX	Data word 0
3000A001	Type 1 write 1 words to CTL
XXXXXXXX	Data word 0
30000001	Type 1 write 1 words to CRC
XXXXXXXX	Data word 0
30008001	Type 1 write 1 words to CMD
0000000D	DESYNC command
20000000	Type 1 NO OP
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	
20000000	

Readback and Configuration Verification

Virtex®-4 devices allow users to read configuration memory through the SelectMAP or JTAG interface. There are two styles of readback: Readback Verify and Readback Capture. During Readback Verify, the user reads all configuration memory cells, including the current values on all user memory elements (LUT RAM, SRL16, and block RAM). Readback Capture is a superset of Readback Verify—in addition to reading all configuration memory cells, the current state of all internal CLB and IOB registers is read, and is useful for design debugging.

Note: Virtex-4QV device configuration memory readback is only supported during design debug. Xilinx does not support or recommend using configuration memory readback in flight applications. The *Correcting Single-Event Upsets in Virtex-4 FPGA Configuration Memory* application note (XAPP1088) describes the recommended solution to correct single event upsets (SEUs) for Virtex-4QV FPGAs in flight. This application note is available on the [High Reliability and Space Developers' Site](#).

To read configuration memory, users must send a sequence of commands to the device to initiate the readback procedure; once initiated the device dumps the contents of its configuration memory to the SelectMAP or JTAG interface. The configuration memory read procedure sections for SelectMAP, IEEE 1149.1 JTAG, and IEEE 1532 JTAG describe the steps for reading configuration memory

Users can send the readback command sequence from a custom microprocessor, CPLD, or FPGA-based system, or use iMPACT to perform JTAG-based readback verify. iMPACT, the device programming software provided with the ISE® tools, can perform all readback and comparison functions for Virtex-4 devices and report to the user whether there were any configuration errors. iMPACT cannot perform capture operations, although Readback Capture is seldom used for design debugging because the Chipscope™ Integrated Logic Analyzer (ILA), sold separately through the Xilinx website, provides superior design debugging functionality in a user-friendly interface.

Once configuration memory has been read from the device, the next step is to determine if there are any errors by comparing the readback bitstream to the configuration bitstream. The “[Verifying Readback Data](#)” section explains how this is done.

Preparing a Design for Readback

There are two mandatory bitstream settings for readback: the BitGen security setting must not prohibit readback (`-g security:none`), and bitstream encryption must not be used. Additionally, if readback is to be performed through the SelectMAP interface, the port must be set to retain its function after configuration by setting the *persist* option in BitGen (`-g Persist:Yes`), otherwise the SelectMAP data pins revert to user I/O, precluding further configuration operations. Beyond these security and encryption requirements, no special considerations are necessary to enable readback through the Boundary-Scan port.

If capture functionality is needed, the CAPTURE_VIRTEX4 primitive can be instantiated in the user design (Figure 8-7, page 113). Alternatively, writing the GCAPTURE command to the CMD register can be used (see [Readback Capture](#)). To capture the state of user registers, the user design triggers the CAP input on this primitive, storing the current register values in configuration memory. The register values are later read out of the device along with all other configuration memory.

Readback Command Sequences

Virtex-4 configuration memory is read from the FDRO (Frame Data Register - Output) configuration register and can be accessed from the JTAG and SelectMAP interfaces. Readback is possible while the FPGA design is active or in a shutdown state, although block RAMs cannot be accessed by the user design while they are being accessed by the configuration logic.

Accessing Configuration Registers through the SelectMAP Interface

To read configuration memory through the SelectMAP interface, users must set the interface for write control to send commands to the FPGA, and then switch the interface to read control to read data from the device. Write and read control for the SelectMAP interface is determined by the RDWR_B input: the SelectMAP data pins (D0:7) are inputs when the interface is set for Write control (RDWR_B = 0); they are outputs when the interface is set for Read control (RDWR_B = 1).

The CS_B signal must be deasserted (CS_B = 1) before toggling the RDWR_B signal, otherwise the user causes an abort (refer to [“SelectMAP ABORT”](#) in Chapter 2 for details).

The procedure for changing the SelectMAP interface from Write to Read Control, or vice versa, is:

1. Deassert CS_B.
2. Toggle RDWR_B.
RDWR_B = 0: Write control
RDWR_B = 1: Read control
3. Assert CS_B.
4. This procedure is illustrated in [Figure 8-1](#).

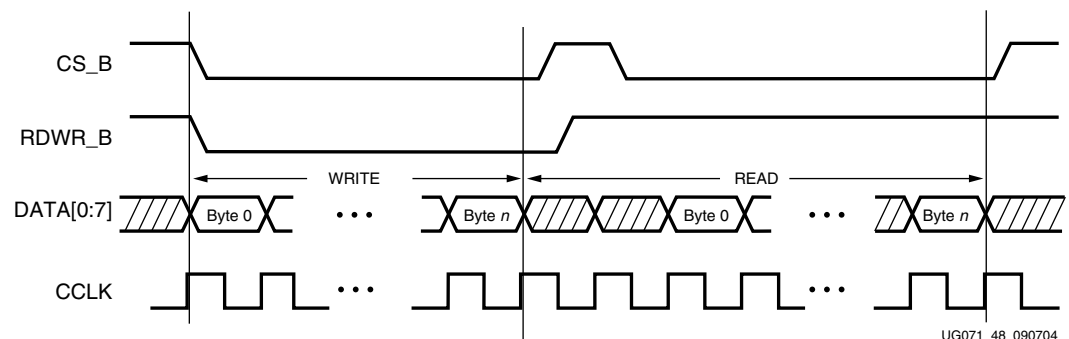


Figure 8-1: Changing the SelectMAP Port from Write to Read Control

Configuration Register Read Procedure (SelectMAP)

The simplest read operation targets a configuration register such as the COR or STAT register. Any configuration register with read access can be read through the SelectMAP or SelectMAP32 interface, although not all registers offer read access. The procedure for reading the STAT register through the SelectMAP interface follows:

1. Write the Synchronization word to the device.
2. Write the *read STAT register* packet header to the device.
3. Write two dummy words to the device to flush the packet buffer.
4. Read four bytes if using SelectMAP or one 32-bit word if using SelectMAP32; this is the Status register value.
5. Write the DESYNC command to the device
6. Write two dummy words to the device to flush the packet buffer.

Table 8-1: Status Register Readback Command Sequence (SelectMAP)

Step	SelectMAP Port Direction	Configuration Data	Explanation
1	Write	AA995566	Sync Word
2	Write	2800E001	Read 1 word from STAT register
3	Write	20000000	NOOP
		20000000	NOOP
4	Read	SSSSSSSS	Device writes 1 word from the STAT register to the configuration interface
5	Write	30008001	Type 1 write 1 word to CMD
		0000000D	Desync command
6	Write	20000000	NOOP
		20000000	NOOP

Notes:

1. In 32-bit readback mode (e.g., ICAP), an extra NOOP should be inserted after the sync word.

The user must change the SelectMAP interface from write to read control between steps 3 and 4, and back to write control after step 4, as illustrated in Figure 8-2.

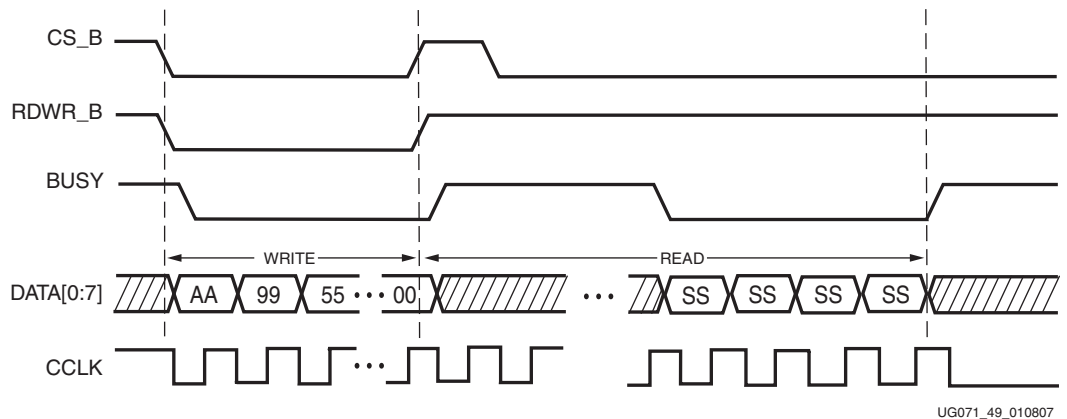


Figure 8-2: SelectMAP Status Register Read

To read registers other than STAT, the address specified in the Type-1 packet header in Step 2 of [Table 8-1](#) should be modified and the word count changed if necessary. Reading from the FDRO register is a special case that is described in [Configuration Memory Read Procedure \(SelectMAP\)](#).

Configuration Memory Read Procedure (SelectMAP)

The process for reading configuration memory from the FDRO register is similar to the process for reading from other registers. Additional steps are needed to accommodate the configuration logic. Configuration data coming from the FDRO register passes through the frame buffer. The first frame of readback data should be discarded.

1. Write the Synchronization word to the device.
2. Write 1 NOOP command.
3. Write the RCRC command to the CMD register.
4. Write 2 NOOP commands.
5. Write the Shutdown command.
6. Write four NOOP instructions to ensure the shutdown sequence has completed. DONE goes Low during the shutdown sequence.
7. Write the RCFG command to the CMD register.
8. Write the Starting Frame Address to the FAR (typically 0x00000000)
9. Write the *read FDRO register* packet header to the device. The FDRO read length is given by:

$$\text{FDRO Read Length} = (\text{words per frame}) \times (\text{frames to read} + 1) + 1$$

One extra frame is read to account for the frame buffer. The frame buffer produces one dummy frame at the beginning of the read and one at the end. Also, one extra word is read in SelectMap8 mode.

10. Write two dummy words to the device to flush the packet buffer.
11. Read the FDRO register from the SelectMAP interface. The FDRO read length is the same as in step 8 above.
12. Write one NOOP instruction.
13. Write the START command.
14. Write the RCRC command.
15. Write the DESYNC command.
16. Write at least 64 bits of NOOP commands to flush the packet buffer. Continue sending CCLK pulses until DONE goes High.

Each of these steps is performed by a single configuration packet except for step 1 and step 8. Synchronization (step 1) and the large FDRO read (step 8) are performed by a Type-1, Type-2 packet combination. [Table 8-2](#) shows the readback command sequence.

Table 8-2: XC4VLX15 Shutdown Readback Command Sequence (SelectMAP)

Step	SelectMAP Port Direction	Configuration Data	Explanation
1	Write	AA995566	Sync word
2	Write	20000000	Type 1 NOOP word 0
3	Write	30008001	Type 1 write 1 word to CMD
		00000007	RCRC command
4	Write	20000000	Type 1 NOOP word 0
		20000000	Type 1 NOOP word 0
5	Write	30008001	Type 1 write 1 word to CMD
		0000000B	SHUTDOWN command
6	Write	20000000	Type 1 NOOP word 0
		20000000	Type 1 NOOP word 1
		20000000	Type 1 NOOP word 2
		20000000	Type 1 NOOP word 3
7	Write	30008001	Type 1 write 1 word to CMD
		00000004	RCFG command
8	Write	30002001	Type 1 write 1 word to FAR
		00000000	FAR Address = 00000000
9	Write	28006000	Type 1 read 0 words from FDRO
		480240B9	Type 2 read 147,641 words from FDRO
10	Write	20000000	Type 1 NOOP word 0
		20000000	Type 1 NOOP word 1
11	Read	00000000	Packet data read FDRO word 0
		...	
		00000000	Packet data read FDRO word 147641
12	Write	20000000	Type 1 NOOP word 0
13	Write	30008001	Type 1 write 1 word to CMD
		00000005	START command
14	Write	30008001	Type 1 write 1 word to CMD
		00000007	RCRC command
15	Write	30008001	Type 1 write 1 word to CMD
		0000000D	DESYNC command
16	Write	20000000	Type 1 NOOP word 0
		20000000	Type 1 NOOP word 1

Accessing Configuration Registers through the JTAG Interface

JTAG access to the Virtex-4 configuration logic is provided through the JTAG CFG_IN and CFG_OUT registers. Note that the CFG_IN and CFG_OUT registers are not configuration registers, rather they are JTAG registers like BYPASS and BOUNDARY_SCAN. Data shifted in to the CFG_IN register go to the configuration packet processor, where they are processed in the same way commands from the SelectMAP interface are processed.

Readback commands are written to the configuration logic by going through the CFG_IN register; configuration memory is read through the CFG_OUT register. The JTAG state transitions for accessing the CFG_IN and CFG_OUT registers are described in [Table 8-3](#).

Table 8-3: Shifting in the JTAG CFG_IN and CFG_OUT Instructions

Step	Description	Set and Hold		# of Clocks (TCK)
		TDI	TMS	
1	Clock five 1s on TMS to bring the device to the TLR state	X	1	5
2	Move into the RTI state	X	0	1
3	Move into the Select-IR state	X	1	2
4	Move into the Shift-IR State	X	0	2
5	Shift the first 9 bits of the CFG_IN or CFG_OUT instruction, LSB first	111000101 (CFG_IN)	0	9
		111000100 (CFG_OUT)		
6	Shift the MSB of the CFG_IN or CFG_OUT instruction while exiting SHIFT-IR	1	1	1
7	Move into the SELECT-DR state	X	1	2
8	Move into the SHIFT-DR state	X	0	2
9	Shift data into the CFG_IN register or out of the CFG_OUT register while in SHIFT_DR, MSB first.	X	0	X
10	Shift the LSB while exiting SHIFT-DR	X	1	1
11	Reset the TAP by clocking five 1s on TMS	X	1	5

Configuration Register Read Procedure - JTAG

The simplest read operation targets a configuration register such as the COR or STAT register. Any configuration register with read access can be read through the JTAG interface, although not all registers offer read access. The procedure for reading the STAT register through the JTAG interface follows:

1. Reset the TAP controller.
2. Shift the CFG_IN instruction into the JTAG Instruction Register through the Shift-IR state. The LSB of the CFG_IN instruction is shifted first; the MSB is shifted while moving the TAP controller out of the SHIFT-IR state.
3. Shift packet write commands into the CFG_IN register through the Shift-DR state:
 - a. Write the Synchronization word to the device.
 - b. Write one NOOP instruction to the device.

- c. Write the *read STAT register* packet header to the device.
- d. Write two dummy words to the device to flush the packet buffer.

The MSB of all configuration packets sent through the CFG_IN register must be sent first. The LSB is shifted while moving the TAP controller out of the SHIFT-DR state.

4. Shift the CFG_OUT instruction into the JTAG Instruction Register through the Shift-IR state. The LSB of the CFG_OUT instruction is shifted first; the MSB is shifted while moving the TAP controller out of the SHIFT-IR state.
5. Shift 32 bits out of the Status register through the Shift-DR state.
6. Reset the TAP controller.

Table 8-4: Status Register Readback Command Sequence (JTAG)

Step	Description	Set and Hold		# of Clocks (TCK)
		TDI	TMS	
1	Clock five 1s on TMS to bring the device to the TLR state.	X	1	5
	Move into the RTI state.	X	0	1
	Move into the Select-IR state.	X	1	2
	Move into the Shift-IR state.	X	0	2
2	Shift the first 9 bits of the CFG_IN instruction, LSB first.	111100101 (CFG_IN)	0	9
	Shift the MSB of the CFG_IN instruction while exiting SHIFT-IR.	1	1	1
	Move into the SELECT-DR state.	X	1	2
	Move into the SHIFT-DR state.	X	0	2
3	Shift configuration packets into the CFG_IN data register, MSB first.	a: 0xAA995566 b: 0x20000000 c: 0x2800E001 d: 0x20000000 0x20000000	0	159
	Shift the LSB of the last configuration packet while exiting SHIFT-DR.	0	1	1
	Move into the SELECT-IR state.	X	1	3
	Move into the SHIFT-IR state.	X	0	2
4	Shift the first 9 bits of the CFG_OUT instruction, LSB first.	1110001101 (CFG_OUT)	0	9
	Shift the MSB of the CFG_OUT instruction while exiting Shift-IR.	1	1	1
	Move into the SELECT-DR state.	X	1	2
	Move into the SHIFT-DR state.	X	0	2

Table 8-4: Status Register Readback Command Sequence (JTAG) (Continued)

Step	Description	Set and Hold		# of Clocks (TCK)
		TDI	TMS	
5	Shift the contents of the STAT register out of the CFG_OUT data register.	0xSSSSSSSS	0	31
	Shift the last bit of the STAT register out of the CFG_OUT data register while exiting SHIFT-DR.	S	1	1
	Move into the Select-IR state.	X	1	3
	Move into the Shift-IR State.	X	0	2
6	Reset the TAP Controller.	X	1	5

The packets shifted in to the JTAG CFG_IN register are identical to the packets shifted in through the SelectMAP interface when reading the STAT register through SelectMAP.

Configuration Memory Read Procedure (1149.1 JTAG)

The process for reading configuration memory from the FDRO register through the JTAG interface is similar to the process for reading from other registers. However, additional steps are needed to accommodate frame logic. Configuration data coming from the FDRO register pass through the frame buffer, therefore the first frame of readback data is *dummy data* and should be discarded (refer to the FDRI and FDRO register description). The 1149.1 JTAG readback flow is recommended for most users.

1. Reset the TAP controller.
2. Shift the CFG_IN instruction into the JTAG Instruction Register. The LSB of the CFG_IN instruction is shifted first; the MSB is shifted while moving the TAP controller out of the SHIFT-IR state.
3. Shift packet write commands into the CFG_IN register through the Shift-DR state:
 - a. Write a dummy word to the device.
 - b. Write the Synchronization word to the device.
 - c. Write a NOOP instruction to the device.
 - d. Write the RCRC command to the device.
 - e. Write two dummy words to flush the packet buffer.
4. Shift the JSHUTDOWN instruction into the JTAG Instruction Register.
5. Move into the RTI state; remain there for 12 TCK cycles to complete the Shutdown sequence. The DONE pin goes Low during the Shutdown sequence.
6. Shift the CFG_IN instruction into the JTAG Instruction Register.
7. Move to the Shift-DR state and shift packet write commands into the CFG_IN register:
 - a. Write a dummy word to the device.
 - b. Write the Synchronization word to the device.
 - c. Write a NOOP instruction to the device.
 - d. Write the *write CMD register* header.
 - e. Write the RCFG command to the device.
 - f. Write the *write FAR register* header.
 - g. Write the starting frame address to the FAR register (typically 0x0000000).

- h. Write the *read FDRO register* Type-1 packet header to the device.
- i. Write a Type-2 packet header to indicate the number of words to read from the device.
- j. Write two dummy words to the device to flush the packet buffer.

The MSB of all configuration packets sent through the CFG_IN register must be sent first. The LSB is shifted while moving the TAP controller out of the SHIFT-DR state.

- 8. Shift the CFG_OUT instruction into the JTAG Instruction Register through the Shift-DR state. The LSB of the CFG_OUT instruction is shifted first; the MSB is shifted while moving the TAP controller out of the SHIFT-IR state.
- 9. Shift frame data from the FDRO register through the Shift-DR state.
- 10. Reset the TAP controller.

Table 8-5: Shutdown Readback Command Sequence (JTAG)

Step	Description	Set and Hold		# of Clocks (TCK)
		TDI	TMS	
1	Clock five 1s on TMS to bring the device to the TLR state.	X	1	5
	Move into the RTI state.	X	0	1
	Move into the Select-IR state.	X	1	2
	Move into the Shift-IR State.	X	0	2
2	Shift the first 9 bits of the CFG_IN instruction, LSB first.	111000101	0	9
	Shift the MSB of the CFG_IN instruction while exiting Shift-IR.	1	1	1
	Move into the SELECT-DR state.	X	1	2
	Move into the SHIFT-DR state.	X	0	2
3	Shift configuration packets into the CFG_IN data register, MSB first.	a: 0xFFFFFFFF b: 0xAA995566 c: 0x20000000 d: 0x30008001 0x00000007 e: 0x20000000 0x20000000	0	223
	Shift the LSB of the last configuration packet while exiting SHIFT-DR.	0	1	1
	Move into the SELECT-IR State.	X	1	3
	Move into the SHIFT-IR State.	X	0	2
4	Shift the first 9 bits of the JSHUTDOWN instruction, LSB first.	111000110	0	9
	Shift the MSB of the JSHUTDOWN instruction while exiting SHIFT-IR.	1	1	1
	Move to RTI.	X	1 0	1 1

Table 8-5: Shutdown Readback Command Sequence (JTAG) (Continued)

Step	Description	Set and Hold		# of Clocks (TCK)
		TDI	TMS	
5	Remain in RTI for 12 TCK cycles.	X	0	12
	Move into the Select-IR state.	X	1	2
	Move into the Shift-IR State.	X	0	2
6	Shift the first 9 bits of the CFG_IN instruction, LSB first.	111000101	0	9
	Shift the MSB of the CFG_IN instruction while exiting SHIFT-IR.	1	1	1
	Move into the SELECT-DR state.	X	1	2
	Move into the SHIFT-DR state.	X	0	2
7	Shift configuration packets into the CFG_IN data register, MSB first.	a: 0xFFFFFFFF b: 0xAA995566 c: 0x20000000 d: 0x30008001 e: 0x00000004 f: 0x30002001 g: 0x00000000 h: 0x28006000 i: 0x48024090 j: 0x20000000 0x20000000	0	351
	Shift the LSB of the last configuration packet while exiting SHIFT-DR.	0	1	1
	Move into the SELECT-IR State.	X	1	3
	Move into the SHIFT-IR State.	X	0	2
8	Shift the first 9 bits of the CFG_OUT instruction, LSB first.	111000100 (CFG_OUT)	0	9
	Shift the MSB of the CFG_OUT instruction while exiting Shift-IR.	1	1	1
	Move into the SELECT-DR state.	X	1	2
	Move into the SHIFT-DR state.	X	0	2
9	Shift the contents of the FDRO register out of the CFG_OUT data register.	...	0	number of readback bits - 1
	Shift the last bit of the FDRO register out of the CFG_OUT data register while exiting SHIFT-DR.	X	1	1
	Move into the Select-IR state.	X	1	3
	Move into the Shift-IR State.	X	0	2
10	End by placing the TAP controller in the TLR state.	X	1	5

Configuration Memory Read Procedure (1532 JTAG)

The IEEE 1532 JTAG readback procedure differs slightly from the IEEE 1149.1 JTAG readback procedure in that readback commands are not sent to the configuration logic through the CFG_IN JTAG register, rather the ISC_READ JTAG register is used to read configuration memory directly.

At the end of 1532 JTAG readback, CRC Error status must be cleared by issuing Reset CRC command or writing the correct CRC value to CRC register. The 1532 JTAG readback procedure is illustrated in Figure 8-3.

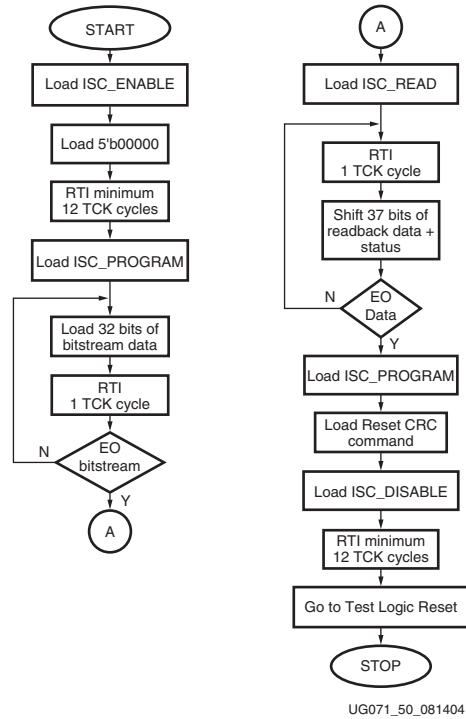


Figure 8-3: IEEE 1532 JTAG Readback Flow

Table 8-6: Readback Files

File Extension	File Type	BitGen Setting	Description
.rba	ASCII	-b and -g Readback	An ASCII file that contains readback commands, rather than configuration commands, and expected readback data where the configuration data normally is. This file must be used with the .msk file
.rbb	Binary	-g Readback	Binary version of .rba file. This file must be used with the .msk file.
.rbd	ASCII	-g Readback	An ASCII file that contains only expected readback data, including the initial pad frame. No commands are included. This file must be used with the .msd file.

Table 8-6: Readback Files (Continued)

File Extension	File Type	BitGen Setting	Description
.msk	Binary	-m	A binary file that contains the same configuration commands as a .bit file, but replaces the contents of the FDRI write packet with mask data that indicate whether the corresponding bits in the .bit file should be compared. If a mask bit is 0, the corresponding bits in the readback data stream should be compared. If a mask bit is 1, the corresponding bit in the readback data stream should be ignored.
.msd	ASCII	-g readback	An ASCII file that contains only mask bits. The first bit in the .msd file corresponds to the first bit in the .rbd file. Pad data in the actual readback stream are accounted for in the .msd and .rbd files. If a mask bit is 0, that bit should be verified against the bit stream data. If a mask bit is 1, that bit should not be verified.
.ll	ASCII	-l	An ASCII file that contains information on each of the nodes in the design that can be captured for readback. The file contains the absolute bit position in the readback stream, frame address, frame offset, logic resource used, and name of the component in the design.

The `design.rba` and `design.rbb` files combine readback commands with expected readback data and the `.rbd` file contains only expected readback data. Systems that use an `.rbd` file for readback must store readback commands elsewhere. The actual readback data must be masked against an `.msk` or `.msd` mask file, as certain bits in the expected readback stream in the `.rba`, `.rbb`, and `.rbd` files should be ignored.

The readback command set files do not indicate when users must change the SelectMAP or JTAG interface from write to read control; the user must handle this based on the Readback Command Sequences described above.

Verifying Readback Data

The readback data stream contains configuration frame data that are preceded by one frame of pad data, as described in the [Configuration Memory Read Procedure \(SelectMAP\)](#). The readback stream does not contain any of the commands or packet information found in the configuration bitstream and no CRC calculation is performed during readback. The readback data stream is shown in [Figure 8-4](#).

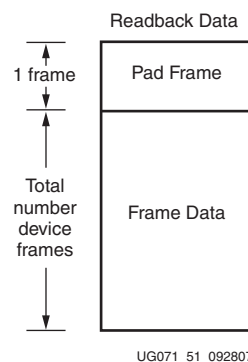


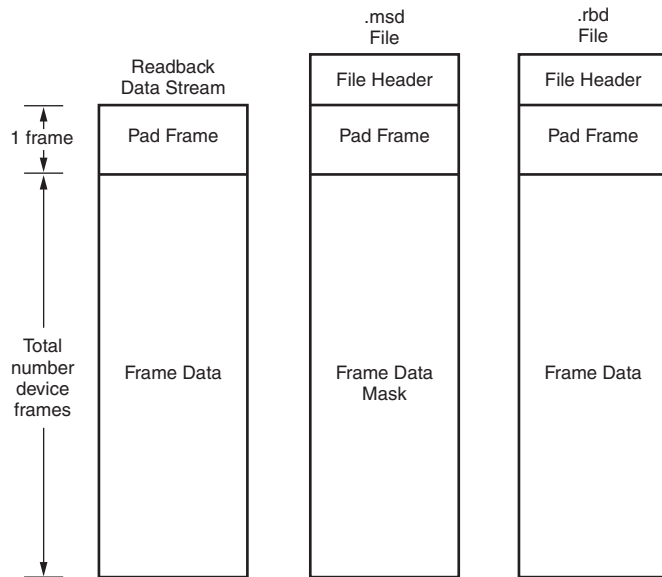
Figure 8-4: Readback Data Stream

The readback data stream is verified by comparing it to the original configuration frame data that were programmed into the device. Certain bits within the readback data stream must not be compared, because these can correspond to user memory or null memory locations. The location of *don't care* bits in the readback data stream is given by the mask files, the .msk and .msd files. These files have different formats although both convey essentially the same information. Once readback data have been obtained from the device, either of the following comparison procedures can be used:

1. Compare readback data to the .rbd golden readback file. Mask by using the .msd file.

The simplest way to verify the readback data stream is to compare it to the .rbd golden readback file, masking readback bits with the .msd file. This approach is simple because there is a 1:1 correspondence between the start of the readback data stream and the start of the .rbd and .msd files, making the task of aligning readback, mask, and expected data easier.

The .rbd and .msd files contain an ASCII representation of the readback and mask data along with a file header that lists the file name, etc. This header information should be ignored or deleted. The ASCII 1s and 0s in the .rbd and .msd files correspond to the binary readback data from the device. Take care to interpret these files as text, not binary sources. Users can convert the .rbd and .msd files to a binary format using a script or text editor, to simplify the verify procedure for some systems and to reduce the size of the files by a factor of eight.



UG071_52_073007

Figure 8-5: Comparing Readback Data Using the .msd and .rbd Files

The drawback to this approach is that in addition to storing the initial configuration bitstream and the .msd file, the golden .rbd file must be stored somewhere, increasing the overall storage requirement.

2. Compare readback data to the configuration .bit file, mask using the .msk file.
Another approach for verifying readback data is to compare the readback data stream to the frame data within the FDRI write in the original configuration bitstream, masking readback bits with the .msk file.

After sending readback commands to the device, comparison begins by aligning the beginning of the readback frame data to the beginning of the FDRI write in the .bit and .msk files. The comparison ends when the end of the FDRI write is reached.

This approach requires the least in-system storage space, because only the .bit, .msk, and readback commands must be stored.

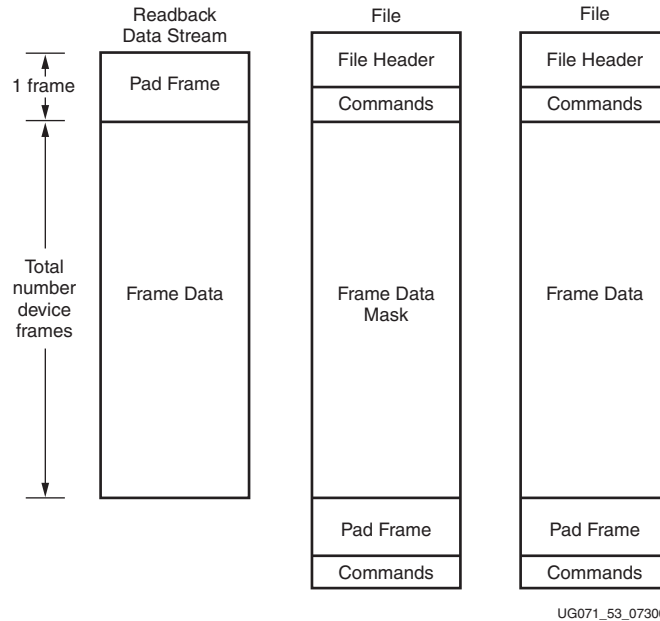


Figure 8-6: Comparing Readback Data Using the .msk and .bit Files

The .rba and .rbb files contain expected readback data along with readback command sets. They are intended for use with the .msk file.

Readback Capture

The configuration memory readback command sequence is identical for both Readback Verify and Readback Capture. However, the Capture sequence requires an additional step to sample internal register values.

Users can sample CLB and IOB registers by instantiating the CAPTURE_VIRTEX4 primitive in their design (Figure 8-7) and asserting the CAP input on that primitive while the design is operating. On the next rising clock edge on the CAPTURE_VIRTEX4 CLK input, the internal GRDBK signal is asserted, storing all CLB and IOB register values into configuration memory cells. These values can then be read out of the device along with the IOB and CLB configuration columns by reading configuration memory through the readback process. Register values are stored in the same memory cell that programs the register's init state configuration, thus sending the GRESTORE command to the Virtex-4 configuration logic after the Capture sequence can cause registers to return to an unintended state.

Alternatively, the GRDBK signal can be asserted by writing the GCAPTURE command to the CMD register. This command asserts the GRDBK signal for two CCLK or TCK cycles, depending on the startup clock setting.

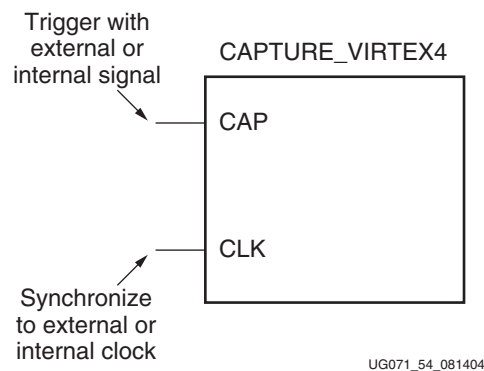


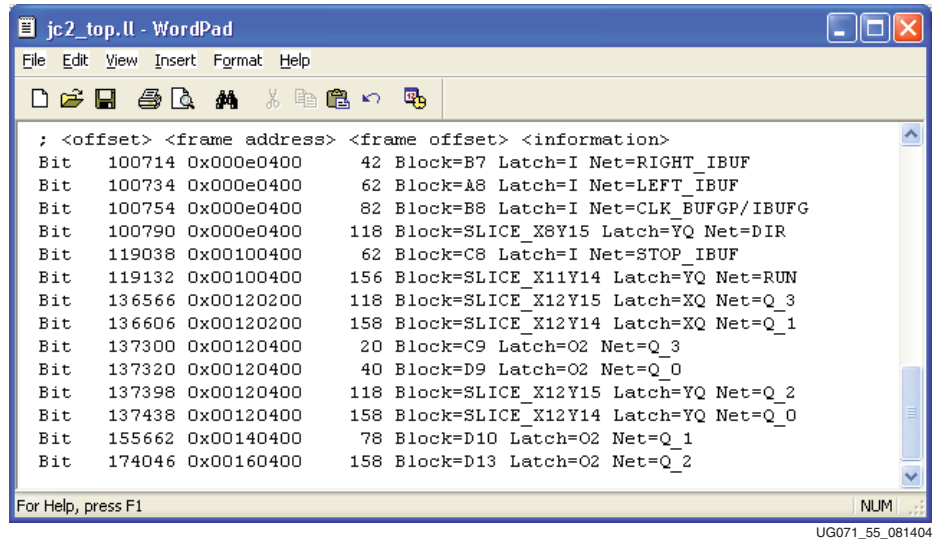
Figure 8-7: Virtex-4 Library Primitive

Table 8-7: Capture Signals

Signal	Description	Access
GCAPTURE	Captures the state of all slice and IOB registers. Complement of GRESTORE.	GCAPTURE command through the CMD register or CAP input on capture block, user controlled.
GRESTORE	Initializes all registers as configured.	CMD register and STARTUP_VIRTEX4 block.

If the CAP signal is left asserted over multiple clock cycles, the Capture cell is updated with the new register value on each rising clock edge. To limit the capture operation to the first rising clock edge, the user can add the ONESHOT attribute to the CAPTURE_VIRTEX4 primitive. More information on the ONESHOT attribute can be found in the Constraints Guide.

Once the configuration memory frames have been read out of the device, the user can pick the captured register values out of the readback data stream. The capture bit locations are given in the logic allocation file (design.ll) as described in Figure 8-8.



```

; <offset> <frame address> <frame offset> <information>
Bit 100714 0x000e0400 42 Block=B7 Latch=I Net=RIGHT_IBUF
Bit 100734 0x000e0400 62 Block=A8 Latch=I Net=LEFT_IBUF
Bit 100754 0x000e0400 82 Block=B8 Latch=I Net=CLK_BUFGP/IBUFG
Bit 100790 0x000e0400 118 Block=SLICE_X8Y15 Latch=YQ Net=DIR
Bit 119038 0x00100400 62 Block=C8 Latch=I Net=STOP_IBUF
Bit 119132 0x00100400 156 Block=SLICE_X11Y14 Latch=YQ Net=RUN
Bit 136566 0x00120200 118 Block=SLICE_X12Y15 Latch=XQ Net=Q_3
Bit 136606 0x00120200 158 Block=SLICE_X12Y14 Latch=XQ Net=Q_1
Bit 137300 0x00120400 20 Block=C9 Latch=O2 Net=Q_3
Bit 137320 0x00120400 40 Block=D9 Latch=O2 Net=Q_0
Bit 137398 0x00120400 118 Block=SLICE_X12Y15 Latch=YQ Net=Q_2
Bit 137438 0x00120400 158 Block=SLICE_X12Y14 Latch=YQ Net=Q_0
Bit 155662 0x00140400 78 Block=D10 Latch=O2 Net=Q_1
Bit 174046 0x00160400 158 Block=D13 Latch=O2 Net=Q_2

```

NUM

UG071_55_081404

Figure 8-8: Logic Allocation File Format

Figure 8-8 shows a snippet from a logic allocation file for the ISE *jc2_top* example design. The line from the header comments explaining the line format has been moved to the start of the bit offset data for clarity. The <offset> field gives the absolute bit offset from the beginning of the readback frame data. The <frame address> field gives the frame address that the capture bit is located in, and the <frame offset> field gives the bit offset from the start of the frame. The <information> field gives the mapping between the bit and the user design—for example, the *DIR* register (Figure 8-8) that is located in Slice X8Y15 is located at bit offset 100790.

Note that captured DFF values, along with LUTRAM and SRL16 values, are stored in their inverted sense.